

### Features

#### ■ Core

- ARM7TDMI 32-bit RISC CPU
- 59 MIPS @ 66 MHz from SRAM
- 45 MIPS @ 50 MHz from Flash

#### ■ Memories

- Up to 256 Kbytes Flash program memory (10 kcycles endurance, 20 years retention @ 85 ° C)
- 16 Kbytes Flash data memory (100 kcycles endurance, 20 years retention @ 85 ° C)
- Up to 64 Kbytes RAM
- External Memory Interface (EMI) for up to 4 banks of SRAM, Flash, ROM
- Multi-boot capability

#### ■ Clock, reset and supply management

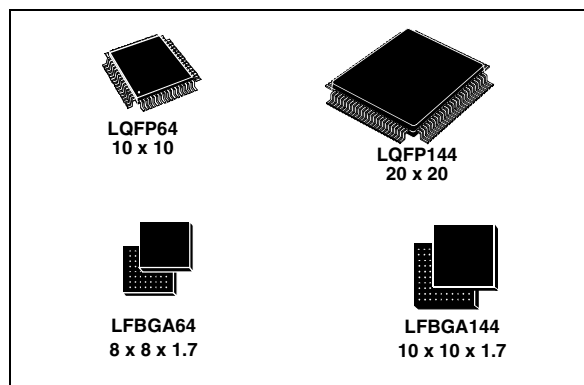
- 3.0 to 3.6 V application supply and I/Os
- Internal 1.8 V regulator for core supply
- Clock input from 0 to 16.5 MHz
- Embedded RTC osc. running from external 32 kHz crystal
- Embedded PLL for CPU clock
- Realtime Clock for clock-calendar function
- 5 power saving modes: SLOW, WAIT, LPWAIT, STOP and STANDBY modes

#### ■ Nested interrupt controller

- Fast interrupt handling with multiple vectors
- 32 vectors with 16 IRQ priority levels
- 2 maskable FIQ sources

#### ■ Up to 48 I/O ports

- 30/32/48 multifunctional bidirectional I/Os
- Up to 14 ports with interrupt capability



#### ■ 5 timers

- 16-bit watchdog timer
- 3 16-bit timers with 2 input captures, 2 output compares, PWM and pulse counter
- 16-bit timer for timebase functions

#### ■ 10 communication interfaces

- 2 I<sup>2</sup>C interfaces (1 multiplexed with SPI)
- 4 UART asynchronous serial interfaces
- Smartcard ISO7816-3 interface on UART1
- 2 BSPI synchronous serial interfaces
- CAN interface (2.0B Active)
- USB Full Speed (12 Mbit/s) Device Function with Suspend and Resume
- HDLC synchronous communications

#### ■ 4-channel 12-bit A/D converter

- Sampling frequency up to 1 kHz
- Conversion range: 0 to 2.5 V

#### ■ Development tools support

- Atomic bit SET and RES operations

**Table 1. Device summary**

| Reference | Root part number                                                                                          |
|-----------|-----------------------------------------------------------------------------------------------------------|
| STR71xFxx | STR710FZ1, STR710FZ2<br>STR711FR0, STR711FR1, STR711FR2,<br>STR712FR0, STR712FR1, STR712FR2,<br>STR715FR0 |
| STR710RZ  | STR710RZ                                                                                                  |

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# 1 Introduction

This datasheet provides the STR71x pinout, ordering information, mechanical and electrical device characteristics.

For complete information on the STR71x microcontroller memory, registers and peripherals, please refer to the STR71x reference manual.

For information on programming, erasing and protection of the internal Flash memory please refer to the STR7 Flash programming reference manual.

For information on the ARM7TDMI core please refer to the ARM7TDMI technical reference manual.

**Table 2. Device overview**

| Features              | STR710<br>FZ1                          | STR710<br>FZ2 | STR710<br>RZ | STR711<br>FR0   | STR711<br>FR1 | STR711<br>FR2 | STR712<br>FR0 | STR712<br>FR1 | STR712<br>FR2 | STR715<br>FRx |
|-----------------------|----------------------------------------|---------------|--------------|-----------------|---------------|---------------|---------------|---------------|---------------|---------------|
| Flash - Kbytes        | 128+16                                 | 256+16        | 0            | 64+16           | 128+16        | 256+16        | 64+16         | 128+16        | 256+16        | 64+16         |
| RAM - Kbytes          | 32                                     | 64            | 64           | 16              | 32            | 64            | 16            | 32            | 64            | 16            |
| Peripheral Functions  | CAN, EMI, USB, 48 I/Os                 |               |              | USB, 30 I/Os    |               |               | CAN, 32 I/Os  |               |               | 32 I/Os       |
| Operating Voltage     | 3.0 to 3.6 V                           |               |              |                 |               |               |               |               |               |               |
| Operating Temperature | -40 to +85°C or 0 to 70° C             |               |              |                 |               |               |               |               |               |               |
| Packages              | T=LQFP144 20 x 20<br>H=LFBGA144 10 x10 |               |              | T=LQFP64 10 x10 |               |               |               |               |               |               |



## 2 Description

### **ARM® core with embedded Flash and RAM**

The STR71x series is a family of ARM-powered 32-bit microcontrollers with embedded Flash and RAM. It combines the high performance ARM7TDMI CPU with an extensive range of peripheral functions and enhanced I/O capabilities. STR71xF devices have on-chip high-speed single voltage FLASH memory and high-speed RAM. STR710R devices have high-speed RAM but no internal Flash. The STR71x family has an embedded ARM core and is therefore compatible with all ARM tools and software.

### **Extensive tools support**

STMicroelectronics' 32-bit, ARM core-based microcontrollers are supported by a complete range of high-end and low-cost development tools to meet the needs of application developers. This extensive line of hardware/software tools includes starter kits and complete development packages all tailored for ST's ARM core-based MCUs. The range of development packages includes third-party solutions that come complete with a graphical development environment and an in-circuit emulator/programmer featuring a JTAG application interface. These support a range of embedded operating systems (OS), while several royalty-free OSs are also available.

For more information, please refer to ST MCU site <http://www.st.com/mcu>

### 3 System architecture

#### Package choice: low pin-count 64-pin or feature-rich 144-pin LQFP or BGA

The STR71x family is available in 5 main versions.

The 144-pin versions have the full set of all features including CAN, USB and External Memory Interface (EMI).

- **STR710F:** 144-pin BGA or LQFP with CAN, USB and EMI
- **STR710R:** Flashless 144-pin BGA or LQFP with CAN, USB and EMI (no internal Flash memory)

The three 64-pin versions (LQFP) do not include External Memory Interface.

- **STR715F:** 64-pin LQFP without CAN or USB
- **STR711F:** 64-pin LQFP with USB
- **STR712F:** 64-pin LQFP with CAN

#### High speed Flash memory (STR71xF)

The Flash program memory is organized in two banks of 32-bit wide Burst Flash memories enabling true read-while-write (RWW) operation. Device Bank 0 is up to 256 Kbytes in size, typically for the application program code. Bank 1 is 16 Kbytes, typically used for storing data constants. Both banks are accessed by the CPU with zero wait states @ 33 MHz

Bank 0 memory endurance is 10K write/erase cycles and Bank 1 endurance is 100K write/erase cycles. Data retention is 20 years at 85°C on both banks. The two banks can be accessed independently in read or write. Flash memory can be accessed in two modes:

- Burst mode: 64-bit wide memory access at up to 50 MHz.
- Direct 32-bit wide memory access for deterministic operation at up to 33 MHz.

The STR7 embedded Flash memory can be programmed using In-Circuit Programming or In-Application programming.

**IAP (in-application programming):** The IAP is the ability to re-program the Flash memory of a microcontroller while the user program is running.

**ICP (in-circuit programming):** The ICP is the ability to program the Flash memory of a microcontroller using JTAG protocol while the device is mounted on the user application board.

The Flash memory can be protected against different types of unwanted access (read/write/erase). There are two types of protection:

- Sector Write Protection
- Flash Debug Protection (locks JTAG access)

Refer to the STR7 Flash Programming Reference manual for details.

#### Optional external memory (STR710)

The non-multiplexed 16-bit data/24-bit address bus available on the STR710 (144-pin) supports four 16-Mbyte banks of external memory. Wait states are programmable individually for each bank allowing different memory types (Flash, EPROM, ROM, SRAM etc.) to be used to store programs or data.

*Figure 1* shows the general block diagram of the device family.



**Flexible power management**

To minimize power consumption, you can program the STR71x to switch to SLOW, WAIT, LPWAIT (low power wait), STOP or STANDBY mode depending on the current system activity in the application.

**Flexible clock control**

Two external clock sources can be used, a main clock and a 32 kHz backup clock. The embedded PLL allows the internal system clock (up to 66 MHz) to be generated from a main clock frequency of 16 MHz or less. The PLL output frequency can be programmed using a wide selection of multipliers and dividers. The microcontroller core, APB1 and APB2 peripherals are in separate clock domains and can be programmed to run at different frequencies during application runtime. The clock to each peripheral is gated with an individual control bit to optimize power usage by turning off peripherals any time they are not required.

**Voltage regulators**

The STR71x requires an external 3.0-3.6V power supply. There are two internal Voltage Regulators for generating the 1.8V power supply for the core and peripherals. The main VR is switched off during low power operation.

**Low voltage detectors**

Both the Main Voltage Regulator and the Low Power Voltage Regulator contain each a low voltage detection circuitry which keep the device under reset when the corresponding controlled voltage value ( $V_{18}$  or  $V_{18BKP}$ ) falls below 1.35V (+/- 10%). This enhances the security of the system by preventing the MCU from going into an unpredictable state.

An external reset circuit must be used to provide the RESET at  $V_{33}$  power-up. It is not sufficient to rely on the RESET generated by the LVD in this case. This is because LVD operation is guaranteed only when  $V_{33}$  is within the specification.

## 3.1 On-chip peripherals

**CAN interface (STR710 and STR712)**

The CAN module is compliant with the CAN specification V2.0 part B (active). The bit rate can be programmed up to 1 Mbaud.

**USB interface (STR710 and STR711)**

The full-speed USB interface is USB V2.0 compliant and provides up to 16 bidirectional/32 unidirectional endpoints, up to 12 Mb/s (full-speed), support for bulk transfer, isochronous transfers and USB Suspend/Resume functions.

**Standard timers**

Each of the four timers have a 16-bit free-running counter with 7-bit prescaler

Three timers each provide up to two input capture/output compare functions, a pulse counter function, and a PWM channel with selectable frequency.

The fourth timer is not connected to the I/O ports. It can be used by the application software for general timing functions.

**Realtime clock (RTC)**

The RTC provides a set of continuously running counters driven by the 32 kHz external crystal. The RTC can be used as a general timebase or clock/calendar/alarm function. When the STR71x is in Standby mode the RTC can be kept running, powered by the low power voltage regulator and driven by the 32 kHz external crystal.

**UARTs**

The 4 UARTs allow full duplex, asynchronous, communications with external devices with independently programmable TX and RX baud rates up to 1.25 Mb/s.

**Smartcard interface**

UART1 is configurable to function either as a general purpose UART or as an asynchronous Smartcard interface as defined by ISO 7816-3. It includes Smartcard clock generation and provides support features for synchronous cards.

**Buffered serial peripheral interfaces (BSPI)**

Each of the two SPIs allow full duplex, synchronous communications with external devices, master or slave communication at up to 5.5 Mb/s in Master mode and 4 Mb/s in Slave mode.

**I<sup>2</sup>C interfaces**

The two I<sup>2</sup>C Interfaces provide multi-master and slave functions, support normal and fast I<sup>2</sup>C mode (400 kHz) and 7 or 10-bit addressing modes.

One I<sup>2</sup>C Interface is multiplexed with one SPI, so either 2xSPI+1x I<sup>2</sup>C or 1xSPI+2x I<sup>2</sup>C may be used at a time.

**HDLC interface**

The High Level Data Link Controller (HDLC) unit supports full duplex operation and NRZ, NRZI, FM0 or MANCHESTER protocols. It has an internal 8-bit baud rate generator.

**A/D converter**

The Analog to Digital Converter, converts in single channel or up to 4 channels in single-shot or round robin mode. Resolution is 12-bit with a sampling frequency of up to 1 kHz. The input voltage range is 0-2.5V.

**Watchdog**

The 16-bit Watchdog Timer protects the application against hardware or software failures and ensures recovery by generating a reset.

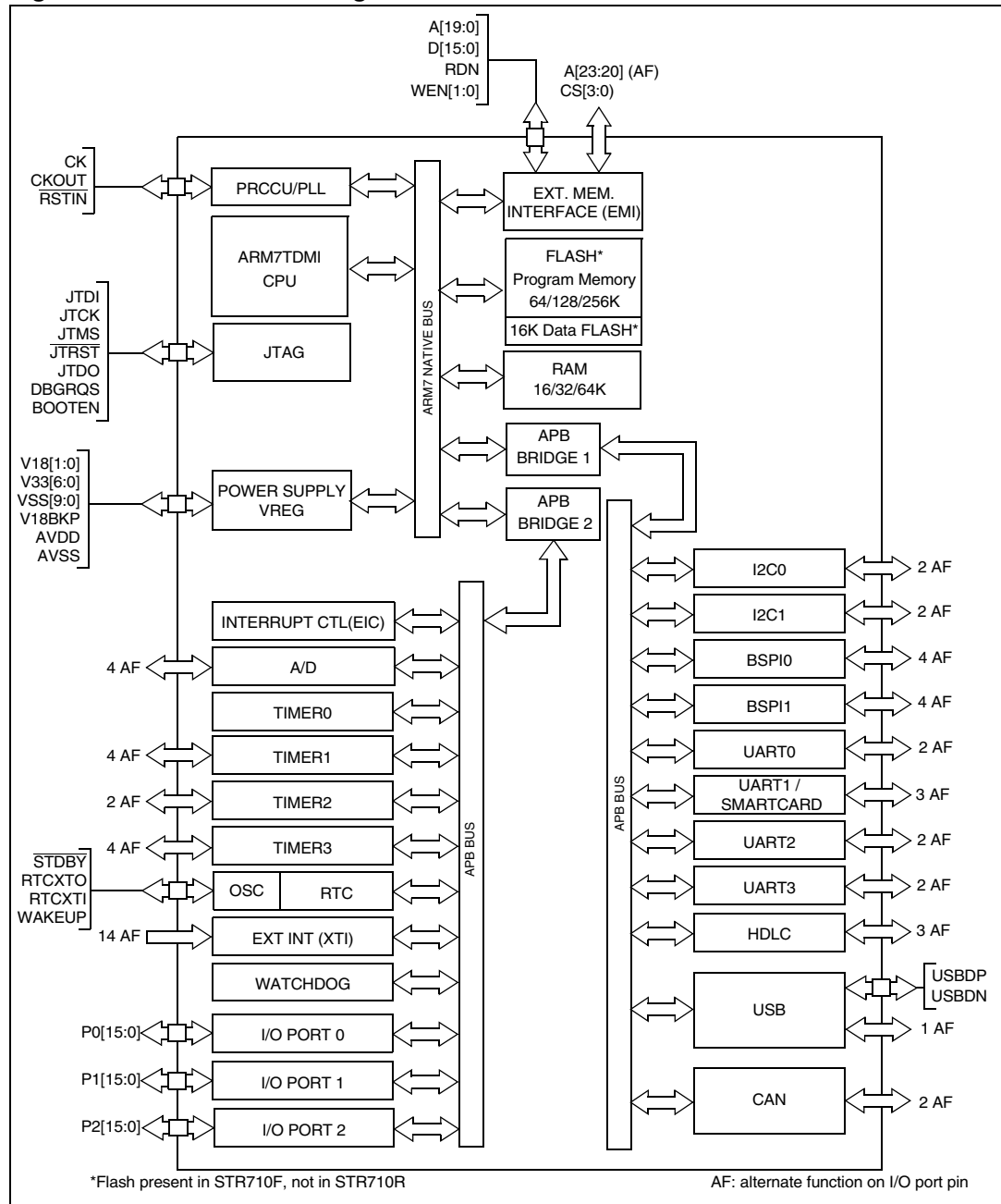
**I/O ports**

The 48 I/O ports are programmable as Inputs or Outputs.

**External interrupts**

Up to 14 external interrupts are available for application use or to wake up the application from STOP mode.

Figure 1. STR71x block diagram



## 3.2 Related documentation

Available from [www.arm.com](http://www.arm.com):

ARM7TDMI Technical reference manual

Available from <http://www.st.com>:

STR71x Reference manual

STR7 Flash programming manual

AN1774 - STR71x Software development getting started

AN1775 - STR71x Hardware development getting started

AN1776 - STR71x Enhanced interrupt controller

AN1777 - STR71x memory mapping

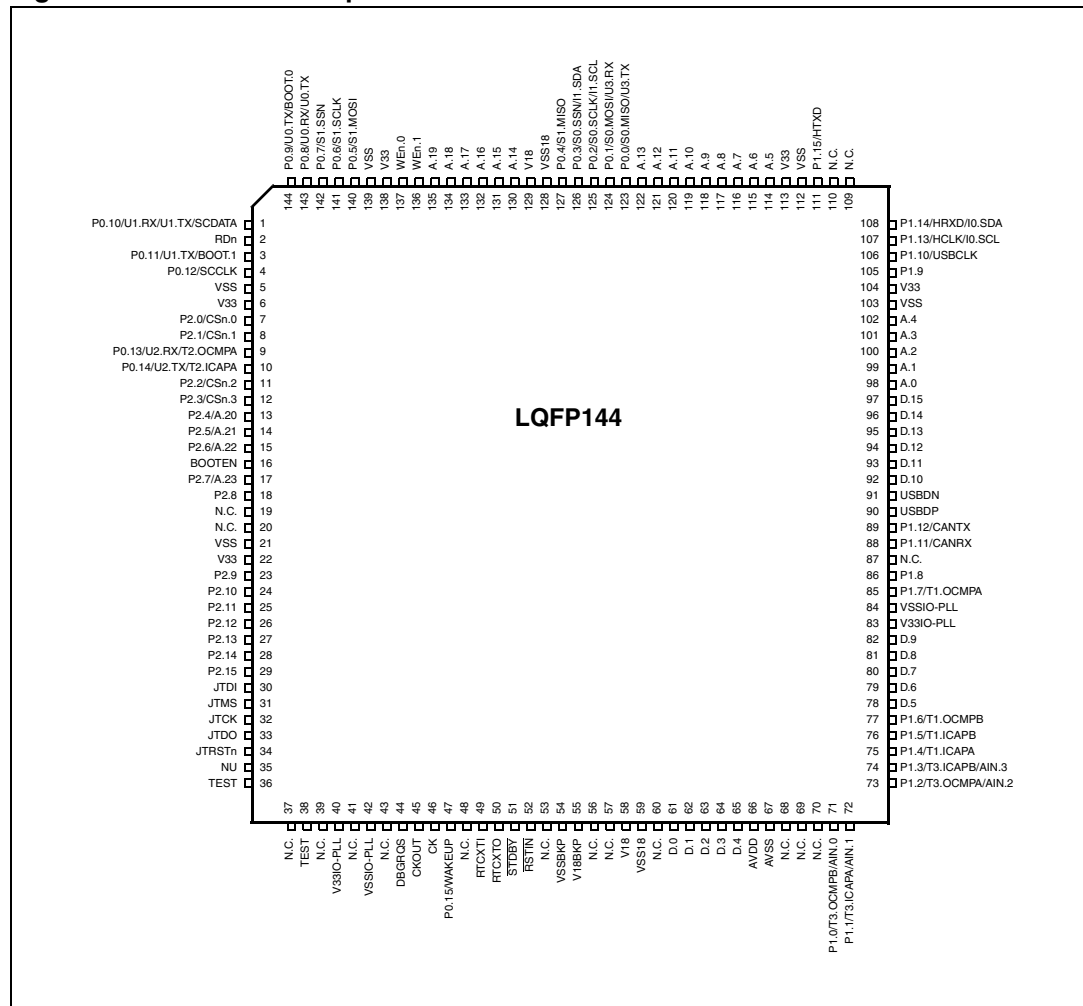
AN1780 - Real time clock with STR71x

AN1781 - Four 7 segment display drive using the STR71x

The above is a selected list only, a full list STR71x application notes can be viewed at <http://www.st.com>.

### 3.3 Pin description for 144-pin packages

Figure 2. STR710 LQFP pinout



**Table 3. STR710 BGA ball connections**

|    | A     | B     | C     | D     | E    | F               | G          | H               | J           | K          | L             | M          |
|----|-------|-------|-------|-------|------|-----------------|------------|-----------------|-------------|------------|---------------|------------|
| 1  | P0.10 | P2.0  | P2.1  | VSS   | P2.2 | P2.6            | BOOT<br>EN | P2.12           | P2.13       | P2.15      | JTDI          | N.C.       |
| 2  | VSS   | RDn   | P0.11 | V33   | P2.3 | P2.8            | P2.9       | JTMS            | JTRSTn      | TEST       | TEST          | N.C.       |
| 3  | V33   | P0.9  | P0.12 | P0.13 | P2.4 | N.C.            | P2.10      | JTCK            | NU          | V33        | N.C.          | DBG<br>RQS |
| 4  | P0.6  | P0.7  | P0.8  | P0.14 | P2.5 | N.C.            | P2.11      | JTDO            | CK          | CKOUT      | VSSIO-<br>PLL | N.C.       |
| 5  | A.19  | WEn.1 | WEn.0 | P0.5  | P2.7 | VSS             | P2.14      | N.C.            | RTCX-<br>TO | RTCXTI     | N.C.          | P0.15      |
| 6  | P0.3  | A.15  | A.16  | A.17  | A.18 | V33             | V18        | N.C.            | N.C.        | V18BK<br>P | VSS<br>BKP    | STDBY      |
| 7  | P0.2  | P0.1  | P0.4  | VSS18 | V18  | A.14            | D.12       | D.1             | D.0         | nc         | VSS18         | RSTIN      |
| 8  | A.9   | A.10  | A.11  | A.13  | P0.0 | A.0             | D.11       | P1.12/<br>CANTX | N.C.        | AVSS       | D.3           | D.2        |
| 9  | VSS   | V33   | A.5   | A.6   | V33  | D.15            | D.10       | P1.8            | D.9         | P1.0       | N.C.          | N.C.       |
| 10 | A.8   | N.C.  | P1.15 | P1.13 | VSS  | D.14            | USBDN      | P1.7            | D.8         | P1.5       | P1.1          | D.4        |
| 11 | A.7   | N.C.  | P1.14 | P1.10 | A.2  | D.13            | USBDP      | VSS             | D.5         | P1.4       | P1.3          | AVDD       |
| 12 | A.12  | A.4   | A.3   | P1.9  | A.1  | P1.11/<br>CANRX | N.C.       | V33IO-<br>PLL   | P1.6        | D.7        | D.6           | P1.2       |

**Legend / abbreviations for Table 4:**

Type: I = input, O = output, S = supply, HiZ= high impedance,

In/Output level: C = CMOS  $0.3V_{DD}/0.7V_{DD}$

$C_T$  = CMOS  $0.3V_{DD}/0.7V_{DD}$  with input trigger

$T_T$  = TTL 0.8 V/2 V with input trigger

C/T = Programmable levels: CMOS  $0.3V_{DD}/0.7V_{DD}$  or TTL 0.8 V / 2 V

Port and control configuration:

Input: pu/pd= software enabled internal pull-up or pull down  
 pu= in reset state, the internal 100k $\Omega$  weak pull-up is enabled.  
 pd = in reset state, the internal 100k $\Omega$  weak pull-down is enabled.

Output: OD = open drain (logic level)  
 PP = push-pull  
 T = true OD, (P-Buffer and protection diode to  $V_{DD}$  not implemented),  
 5 V tolerant.

Table 4. STR710 pin description

| Pin n°  |        | Pin name                          | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)                                                                                                  | Alternate function                                                                                                                                                                                                   |                                 |
|---------|--------|-----------------------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|
| LQFP144 | BGA144 |                                   |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                                                                                                              |                                                                                                                                                                                                                      |                                 |
| 1       | A1     | P0.10/U1.RX/<br>U1.TX/<br>SC.DATA | I/O  | pd                        | C <sub>T</sub> | X         | 4mA        | T  |    |                 | Port 0.10                                                                                                                    | UART1: Receive Data input                                                                                                                                                                                            | UART1: Transmit data output.    |
|         |        |                                   |      |                           |                |           |            |    |    |                 |                                                                                                                              | <b>Note:</b> This pin may be used for Smartcard DataIn/DataOut or single wire UART (half duplex) if programmed as Alternate Function Output. The pin will be tri-stated except when UART transmission is in progress |                                 |
| 2       | B2     | $\overline{RD}$                   | O    | 5)                        |                |           |            |    | X  |                 | External Memory Interface: Active low read signal for external memory. It maps to the OE_N input of the external components. |                                                                                                                                                                                                                      |                                 |
| 3       | C2     | P0.11/BOOT.1<br>/U1.TX            | I/O  | pd                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.11                                                                                                                    | Select Boot Configuration input                                                                                                                                                                                      | UART1: Transmit data output.    |
| 4       | C3     | P0.12/SC.CLK                      | I/O  | pd                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.12                                                                                                                    | Smartcard reference clock output                                                                                                                                                                                     |                                 |
| 5       | D1     | V <sub>SS</sub>                   | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/Os <sup>4)</sup>                                                                                |                                                                                                                                                                                                                      |                                 |
| 6       | D2     | V <sub>33</sub>                   | S    |                           |                |           |            |    |    |                 | Supply voltage for digital I/Os <sup>4)</sup>                                                                                |                                                                                                                                                                                                                      |                                 |
| 7       | B1     | P2.0/ $\overline{CS.0}$           | I/O  | 8)                        | C <sub>T</sub> |           | 8mA        | X  | X  |                 | Port 2.0                                                                                                                     | External Memory Interface: Select Memory Bank 0 output<br><b>Note:</b> This pin is forced to output push-pull 1 mode at reset to allow boot from external memory                                                     |                                 |
| 8       | C1     | P2.1/ $\overline{CS.1}$           | I/O  | pu <sub>2)</sub>          | C <sub>T</sub> |           | 8mA        | X  | X  |                 | Port 2.1                                                                                                                     | External Memory Interface: Select Memory Bank 1 output                                                                                                                                                               |                                 |
| 9       | D3     | P0.13/U2.RX/<br>T2.OCMPA          | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 0.13                                                                                                                    | UART2: Receive Data input                                                                                                                                                                                            | Timer2: Output Compare A output |
| 10      | D4     | P0.14/U2.TX/<br>T2.ICAPA          | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.14                                                                                                                    | UART2: Transmit data output                                                                                                                                                                                          | Timer2: Input Capture A input   |
| 11      | E1     | P2.2/ $\overline{CS.2}$           | I/O  | pu <sub>2)</sub>          | C <sub>T</sub> |           | 8mA        | X  | X  |                 | Port 2.2                                                                                                                     | External Memory Interface: Select Memory Bank 2 output                                                                                                                                                               |                                 |
| 12      | E2     | P2.3/ $\overline{CS.3}$           | I/O  | pu <sub>2)</sub>          | C <sub>T</sub> |           | 8mA        | X  | X  |                 | Port 2.3                                                                                                                     | External Memory Interface: Select Memory Bank 3 output                                                                                                                                                               |                                 |

Table 4. STR710 pin description

| Pin n°  |        | Pin name        | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdbby | Main function (after reset)                               | Alternate function                     |
|---------|--------|-----------------|------|---------------------------|----------------|-----------|------------|----|----|------------------|-----------------------------------------------------------|----------------------------------------|
| LQFP144 | BGA144 |                 |      |                           | Input level    | interrupt | Capability | OD | PP |                  |                                                           |                                        |
| 13      | E3     | P2.4/A.20       | I/O  | pd <sub>3)</sub>          | C <sub>T</sub> |           | 8mA        | X  | X  |                  | Port 2.4                                                  | External Memory Interface: address bus |
| 14      | E4     | P2.5/A.21       | I/O  | pd <sub>3)</sub>          | C <sub>T</sub> |           | 8mA        | X  | X  |                  | Port 2.5                                                  |                                        |
| 15      | F1     | P2.6/A.22       | I/O  | pd <sub>3)</sub>          | C <sub>T</sub> |           | 8mA        | X  | X  |                  | Port 2.6                                                  |                                        |
| 16      | G1     | BOOTEN          | I    |                           | C <sub>T</sub> |           |            |    |    |                  | Boot control input. Enables sampling of BOOT[1:0] pins    |                                        |
| 17      | E5     | P2.7/A.23       | I/O  | pd <sub>3)</sub>          | C <sub>T</sub> |           | 8mA        | X  | X  |                  | Port 2.7                                                  | External Memory Interface: address bus |
| 18      | F2     | P2.8            | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                  | Port 2.8                                                  | External interrupt INT2                |
| 19      | F3     | N.C.            |      |                           |                |           |            |    |    |                  | Not connected (not bonded)                                |                                        |
| 20      | F4     | N.C.            |      |                           |                |           |            |    |    |                  | Not connected (not bonded)                                |                                        |
| 21      | F5     | V <sub>SS</sub> | S    |                           |                |           |            |    |    |                  | Ground voltage for digital I/Os <sup>4)</sup>             |                                        |
| 22      | F6     | V <sub>33</sub> | S    |                           |                |           |            |    |    |                  | Supply voltage for digital I/Os <sup>4)</sup>             |                                        |
| 23      | G2     | P2.9            | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                  | Port 2.9                                                  | External interrupt INT3                |
| 24      | G3     | P2.10           | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                  | Port 2.10                                                 | External interrupt INT4                |
| 25      | G4     | P2.11           | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                  | Port 2.11                                                 | External interrupt INT5                |
| 26      | H1     | P2.12           | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                  | Port 2.12                                                 |                                        |
| 27      | J1     | P2.13           | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                  | Port 2.13                                                 |                                        |
| 28      | G5     | P2.14           | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                  | Port 2.14                                                 |                                        |
| 29      | K1     | P2.15           | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                  | Port 2.15                                                 |                                        |
| 30      | L1     | JTDI            | I    |                           | T <sub>T</sub> |           |            |    |    |                  | JTAG Data input. External pull-up required.               |                                        |
| 31      | H2     | JTMS            | I    |                           | T <sub>T</sub> |           |            |    |    |                  | JTAG Mode Selection Input. External pull-up required.     |                                        |
| 32      | H3     | JTCK            | I    |                           | C              |           |            |    |    |                  | JTAG Clock Input. External pull-up or pull-down required. |                                        |
| 33      | H4     | JTDO            | O    |                           |                |           | 8mA        |    | X  |                  | JTAG Data output. <b>Note:</b> Reset state = HiZ.         |                                        |
| 34      | J2     | JTRST           | I    |                           | T <sub>T</sub> |           |            |    |    |                  | JTAG Reset Input. External pull-up required.              |                                        |
| 35      | J3     | NU              |      |                           |                |           |            |    |    |                  | Reserved, must be forced to ground.                       |                                        |
| 36      | K2     | TEST            |      |                           |                |           |            |    |    |                  | Reserved, must be forced to ground.                       |                                        |
| 37      | M1     | N.C.            |      |                           |                |           |            |    |    |                  | Not connected (not bonded)                                |                                        |
| 38      | L2     | TEST            |      |                           |                |           |            |    |    |                  | Reserved, must be forced to ground.                       |                                        |
| 39      | L3     | N.C.            |      |                           |                |           |            |    |    |                  | Not connected (not bonded)                                |                                        |



Table 4. STR710 pin description

| Pin n°  |        | Pin name                  | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)                                                                                                                                                                                                                                                                                                  | Alternate function |
|---------|--------|---------------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|
| LQFP144 | BGA144 |                           |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                                                                                                                                                                                                                                                                                                              |                    |
| 40      | K3     | V <sub>33IO-PLL</sub>     | S    |                           |                |           |            |    |    |                 | Supply voltage for digital I/O circuitry and for PLL reference                                                                                                                                                                                                                                                               |                    |
| 41      | M4     | N.C.                      |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                                                                                                                                                                                                                                                                                                   |                    |
| 42      | L4     | V <sub>SSIO-PLL</sub>     | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/O circuitry and for PLL reference <sup>4)</sup>                                                                                                                                                                                                                                                 |                    |
| 43      | M2     | N.C.                      |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                                                                                                                                                                                                                                                                                                   |                    |
| 44      | M3     | DBG RQS                   | I    |                           | C <sub>T</sub> |           |            |    |    |                 | Debug Mode request input (active high)                                                                                                                                                                                                                                                                                       |                    |
| 45      | K4     | CKOUT                     | O    |                           |                |           | 8mA        |    | X  |                 | Clock output (f <sub>PCLK2</sub> ) <b>Note:</b> Enabled by CKDIS register in APB Bridge 2                                                                                                                                                                                                                                    |                    |
| 46      | J4     | CK                        | I    |                           | C              |           |            |    |    |                 | Reference clock input                                                                                                                                                                                                                                                                                                        |                    |
| 47      | M5     | P0.15/<br>WAKEUP          | I    |                           | T <sub>T</sub> | X         |            |    |    | X               | Port 0.15 Wakeup from Standby mode input.<br><b>Note:</b> This port is input only.                                                                                                                                                                                                                                           |                    |
| 48      | L5     | N.C.                      |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                                                                                                                                                                                                                                                                                                   |                    |
| 49      | K5     | RTCXTI                    |      |                           |                |           |            |    |    |                 | Realtime Clock input and input of 32 kHz oscillator amplifier circuit                                                                                                                                                                                                                                                        |                    |
| 50      | J5     | RTCXTO                    |      |                           |                |           |            |    |    |                 | Output of 32 kHz oscillator amplifier circuit                                                                                                                                                                                                                                                                                |                    |
| 51      | M6     | $\overline{\text{STDBY}}$ | I/O  |                           | C <sub>T</sub> |           | 4mA        | X  |    | X               | Input: Hardware Standby mode entry input active low. <b>Caution:</b> External pull-up to V <sub>33</sub> required to select normal mode.<br>Output: Standby mode active low output following Software Standby mode entry.<br><b>Note:</b> In Standby mode all pins are in high impedance except those marked Active in Stdby |                    |
| 52      | M7     | $\overline{\text{RSTIN}}$ | I    |                           | C <sub>T</sub> |           |            |    |    | X               | Reset input                                                                                                                                                                                                                                                                                                                  |                    |
| 53      | H5     | N.C.                      |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                                                                                                                                                                                                                                                                                                   |                    |
| 54      | L6     | V <sub>SSBKP</sub>        |      |                           | S              |           |            |    |    | X               | Stabilization for low power voltage regulator.                                                                                                                                                                                                                                                                               |                    |
| 55      | K6     | V <sub>18BKP</sub>        |      |                           | S              |           |            |    |    | X               | Stabilization for low power voltage regulator. Requires external capacitors of at least 1μF between V <sub>18BKP</sub> and V <sub>SS18BKP</sub> . See <a href="#">Figure 5</a> .<br><b>Note:</b> If the low power voltage regulator is bypassed, this pin can be connected to an external 1.8V supply.                       |                    |
| 56      | J6     | N.C.                      |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                                                                                                                                                                                                                                                                                                   |                    |
| 57      | H6     | N.C.                      |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                                                                                                                                                                                                                                                                                                   |                    |
| 58      | G6     | V <sub>18</sub>           | S    |                           |                |           |            |    |    |                 | Stabilization for main voltage regulator. Requires external capacitors of at least 10μF + 33nF between V <sub>18</sub> and V <sub>SS18</sub> . See <a href="#">Figure 5</a> .                                                                                                                                                |                    |

Table 4. STR710 pin description

| Pin n°  |        | Pin name                              | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)               | Alternate function                                        |                                  |
|---------|--------|---------------------------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|-------------------------------------------|-----------------------------------------------------------|----------------------------------|
| LQFP144 | BGA144 |                                       |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                           |                                                           |                                  |
| 59      | L7     | V <sub>SS18</sub>                     | S    |                           |                |           |            |    |    |                 | Stabilization for main voltage regulator. |                                                           |                                  |
| 60      | K7     | N.C.                                  |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                |                                                           |                                  |
| 61      | J7     | D.0                                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 | External Memory Interface: data bus       |                                                           |                                  |
| 62      | H7     | D.1                                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                           |                                                           |                                  |
| 63      | M8     | D.2                                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                           |                                                           |                                  |
| 64      | L8     | D.3                                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                           |                                                           |                                  |
| 65      | M10    | D.4                                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                           |                                                           |                                  |
| 66      | M11    | V <sub>DDA</sub>                      | S    |                           |                |           |            |    |    |                 | Supply voltage for A/D Converter          |                                                           |                                  |
| 67      | K8     | V <sub>SSA</sub>                      | S    |                           |                |           |            |    |    |                 | Ground voltage for A/D Converter          |                                                           |                                  |
| 68      | J8     | N.C.                                  |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                |                                                           |                                  |
| 69      | M9     | N.C.                                  |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                |                                                           |                                  |
| 70      | L9     | N.C.                                  |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                |                                                           |                                  |
| 71      | K9     | P1.0/T3.OCM<br>PB/AIN.0               | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.0                                  | Timer 3:<br>Output<br>Compare B                           | ADC: Analog input 0              |
| 72      | L10    | P1.1/T3.ICAP<br>A/T3.EXTCLK/<br>AIN.1 | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.1                                  | Timer 3: Input<br>Capture A or<br>External Clock<br>input | ADC: Analog input 1              |
| 73      | M12    | P1.2/T3.OCM<br>PA/AIN.2               | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.2                                  | Timer 3:<br>Output<br>Compare A                           | ADC: Analog input 2              |
| 74      | L11    | P1.3/T3.ICAP<br>B/AIN.3               | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.3                                  | Timer 3: Input<br>Capture B                               | ADC: Analog input 3              |
| 75      | K11    | P1.4/T1.ICAP<br>A/T1.EXTCLK           | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.4                                  | Timer 1: Input<br>Capture A                               | Timer 1: External<br>Clock input |
| 76      | K10    | P1.5/T1.ICAP<br>B                     | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.5                                  | Timer 1: Input<br>Capture B                               |                                  |
| 77      | J12    | P1.6/T1.OCM<br>PB                     | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.6                                  | Timer 1:<br>Output<br>Compare B                           |                                  |
| 78      | J11    | D.5                                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 | External Memory Interface: data bus       |                                                           |                                  |
| 79      | L12    | D.6                                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                           |                                                           |                                  |
| 80      | K12    | D.7                                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                           |                                                           |                                  |
| 81      | J10    | D.8                                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                           |                                                           |                                  |
| 82      | J9     | D.9                                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                           |                                                           |                                  |

Table 4. STR710 pin description

| Pin n°  |        | Pin name               | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)                                                                                                                                                        | Alternate function                                                  |  |
|---------|--------|------------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------|--|
| LQFP144 | BGA144 |                        |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                                                                                                                                                                    |                                                                     |  |
| 83      | H12    | V <sub>33IO</sub> -PLL | S    |                           |                |           |            |    |    |                 | Supply voltage for digital I/O circuitry and for PLL reference <sup>4)</sup>                                                                                                       |                                                                     |  |
| 84      | H11    | V <sub>SSIO</sub> -PLL | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/O circuitry and for PLL reference <sup>4)</sup>                                                                                                       |                                                                     |  |
| 85      | H10    | P1.7/T1.OCM PA         | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.7                                                                                                                                                                           | Timer 1: Output Compare A                                           |  |
| 86      | H9     | P1.8                   | I/O  | pd                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.8                                                                                                                                                                           |                                                                     |  |
| 87      | G12    | N.C.                   |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                                                                                                                                                         |                                                                     |  |
| 88      | F12    | P1.11/CANRX            | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 1.11                                                                                                                                                                          | CAN: receive data input<br><b>Note:</b> On STR710 and STR712 only   |  |
| 89      | H8     | P1.12/CANTX            | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.12                                                                                                                                                                          | CAN: Transmit data output<br><b>Note:</b> On STR710 and STR712 only |  |
| 90      | G11    | USBDP                  | I/O  |                           | C <sub>T</sub> |           |            |    |    |                 | USB bidirectional data (data +). Reset state = HiZ<br><b>Note:</b> On STR710 and STR711 only<br>This pin requires an external pull-up to V <sub>33</sub> to maintain a high level. |                                                                     |  |
| 91      | G10    | USBDN                  | I/O  |                           | C <sub>T</sub> |           |            |    |    |                 | USB bidirectional data (data -). Reset state = HiZ<br><b>Note:</b> On STR710 and STR711 only.                                                                                      |                                                                     |  |
| 92      | G9     | D.10                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 | External Memory Interface: data bus                                                                                                                                                |                                                                     |  |
| 93      | G8     | D.11                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                                                                                                                                                                    |                                                                     |  |
| 94      | G7     | D.12                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                                                                                                                                                                    |                                                                     |  |
| 95      | F11    | D.13                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                                                                                                                                                                    |                                                                     |  |
| 96      | F10    | D.14                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                                                                                                                                                                    |                                                                     |  |
| 97      | F9     | D.15                   | I/O  | <sup>6)</sup>             |                |           | 8mA        |    |    |                 |                                                                                                                                                                                    |                                                                     |  |
| 98      | F8     | A.0                    | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 | External Memory Interface: address bus                                                                                                                                             |                                                                     |  |
| 99      | E12    | A.1                    | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                                                                                                                                                    |                                                                     |  |
| 100     | E11    | A.2                    | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                                                                                                                                                    |                                                                     |  |
| 101     | C12    | A.3                    | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                                                                                                                                                    |                                                                     |  |
| 102     | B12    | A.4                    | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                                                                                                                                                    |                                                                     |  |
| 103     | E10    | V <sub>SS</sub>        | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/O circuitry <sup>4)</sup>                                                                                                                             |                                                                     |  |
| 104     | E9     | V <sub>33</sub>        | S    |                           |                |           |            |    |    |                 | Supply voltage for digital I/O circuitry <sup>4)</sup>                                                                                                                             |                                                                     |  |
| 105     | D12    | P1.9                   | I/O  | pd                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.9                                                                                                                                                                           |                                                                     |  |
| 106     | D11    | P1.10/USBCLK           | I/O  | pd                        | C/ T           |           | 4mA        | X  | X  |                 | Port 1.10                                                                                                                                                                          | USB: 48 MHZ clock input                                             |  |

Table 4. STR710 pin description

| Pin n°  |        | Pin name           | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)                            | Alternate function                                                                                                       |                            |
|---------|--------|--------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|--------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------|----------------------------|
| LQFP144 | BGA144 |                    |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                                        |                                                                                                                          |                            |
| 107     | D10    | P1.13/HCLK/I0.SCL  | I/O  | pd                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 1.13                                              | HDLC: reference clock input                                                                                              | I2C clock                  |
| 108     | C11    | P1.14/HRXD/I0.SDA  | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 1.14                                              | HDLC: Receive data input                                                                                                 | I2C serial data            |
| 109     | B11    | N.C.               |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                             |                                                                                                                          |                            |
| 110     | B10    | N.C.               |      |                           |                |           |            |    |    |                 | Not connected (not bonded)                             |                                                                                                                          |                            |
| 111     | C10    | P1.15/HTXD         | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.15                                              | HDLC: Transmit data output                                                                                               |                            |
| 112     | A9     | V <sub>SS</sub>    | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/O circuitry <sup>4)</sup> |                                                                                                                          |                            |
| 113     | B9     | V <sub>33</sub>    | S    |                           |                |           |            |    |    |                 | Supply voltage for digital I/O circuitry <sup>4)</sup> |                                                                                                                          |                            |
| 114     | C9     | A.5                | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 | External Memory Interface: address bus                 |                                                                                                                          |                            |
| 115     | D9     | A.6                | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                        |                                                                                                                          |                            |
| 116     | A11    | A.7                | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                        |                                                                                                                          |                            |
| 117     | A10    | A.8                | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                        |                                                                                                                          |                            |
| 118     | A8     | A.9                | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                        |                                                                                                                          |                            |
| 119     | B8     | A.10               | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                        |                                                                                                                          |                            |
| 120     | C8     | A.11               | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                        |                                                                                                                          |                            |
| 121     | A12    | A.12               | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                        |                                                                                                                          |                            |
| 122     | D8     | A.13               | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                        |                                                                                                                          |                            |
| 123     | E8     | P0.0/S0.MISO/U3.TX | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.0                                               | SPI0 Master in/Slave out data                                                                                            | UART3 Transmit data output |
|         |        |                    |      |                           |                |           |            |    |    |                 |                                                        | <b>Note:</b> Programming AF function selects UART by default. BSPI must be enabled by SPI_EN bit in the BOOTCR register. |                            |
| 124     | B7     | P0.1/S0.MOSI/U3.RX | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 0.1                                               | BSPI0: Master out/Slave in data                                                                                          | UART3: Receive Data input  |
|         |        |                    |      |                           |                |           |            |    |    |                 |                                                        | <b>Note:</b> Programming AF function selects UART by default. BSPI must be enabled by SPI_EN bit in the BOOTCR register. |                            |

Table 4. STR710 pin description

| Pin n°  |        | Pin name             | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)                                                                                                                                          | Alternate function                                        |                                                                                                                         |
|---------|--------|----------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------|
| LQFP144 | BGA144 |                      |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                                                                                                                                                      |                                                           |                                                                                                                         |
| 125     | A7     | P0.2/S0.SCLK /I1.SCL | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 0.2                                                                                                                                                             | BSPI0: Serial Clock<br>I2C1: Serial clock                 | <b>Note:</b> Programming AF function selects I2C by default. BSPI must be enabled by SPI_EN bit in the BOOTCR register. |
| 126     | A6     | P0.3/S0.SS̄/I1.SDA   | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.3                                                                                                                                                             | SPI0: Slave Select input active low.<br>I2C1: Serial Data | <b>Note:</b> Programming AF function selects I2C by default. BSPI must be enabled by SPI_EN bit in the BOOTCR register. |
| 127     | C7     | P0.4/S1.MISO         | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.4                                                                                                                                                             | SPI1: Master in/Slave out data                            |                                                                                                                         |
| 128     | D7     | V <sub>SS18</sub>    | S    |                           |                |           |            |    |    |                 | Stabilization for main voltage regulator.                                                                                                                            |                                                           |                                                                                                                         |
| 129     | E7     | V <sub>18</sub>      | S    |                           |                |           |            |    |    |                 | Stabilization for main voltage regulator. Requires external capacitors of at least 10µF + 33nF between V <sub>18</sub> and V <sub>SS18</sub> . See <i>Figure 5</i> . |                                                           |                                                                                                                         |
| 130     | F7     | A.14                 | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 | External Memory Interface: address bus                                                                                                                               |                                                           |                                                                                                                         |
| 131     | B6     | A.15                 | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                                                                                                                                      |                                                           |                                                                                                                         |
| 132     | C6     | A.16                 | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                                                                                                                                      |                                                           |                                                                                                                         |
| 133     | D6     | A.17                 | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                                                                                                                                      |                                                           |                                                                                                                         |
| 134     | E6     | A.18                 | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                                                                                                                                      |                                                           |                                                                                                                         |
| 135     | A5     | A.19                 | O    | <sup>7)</sup>             |                |           | 8mA        |    | X  |                 |                                                                                                                                                                      |                                                           |                                                                                                                         |
| 136     | B5     | WE.1                 | O    | <sup>5)</sup>             |                |           | 8mA        |    | X  |                 | External Memory Interface: active low MSB write enable output                                                                                                        |                                                           |                                                                                                                         |
| 137     | C5     | WE.0                 | O    | <sup>5)</sup>             |                |           | 8mA        |    | X  |                 | External Memory Interface: active low LSB write enable output                                                                                                        |                                                           |                                                                                                                         |
| 138     | A3     | V <sub>33</sub>      | S    |                           |                |           |            |    |    |                 | Supply voltage for digital I/Os <sup>4)</sup>                                                                                                                        |                                                           |                                                                                                                         |
| 139     | A2     | V <sub>SS</sub>      | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/Os <sup>4)</sup>                                                                                                                        |                                                           |                                                                                                                         |
| 140     | D5     | P0.5/S1.MOSI         | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.5                                                                                                                                                             | SPI1: Master out/Slave In data                            |                                                                                                                         |
| 141     | A4     | P0.6/S1.SCLK         | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 0.6                                                                                                                                                             | SPI1: Serial Clock                                        |                                                                                                                         |
| 142     | B4     | P0.7/S1.SS̄          | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.7                                                                                                                                                             | SPI1: Slave Select input active low                       |                                                                                                                         |

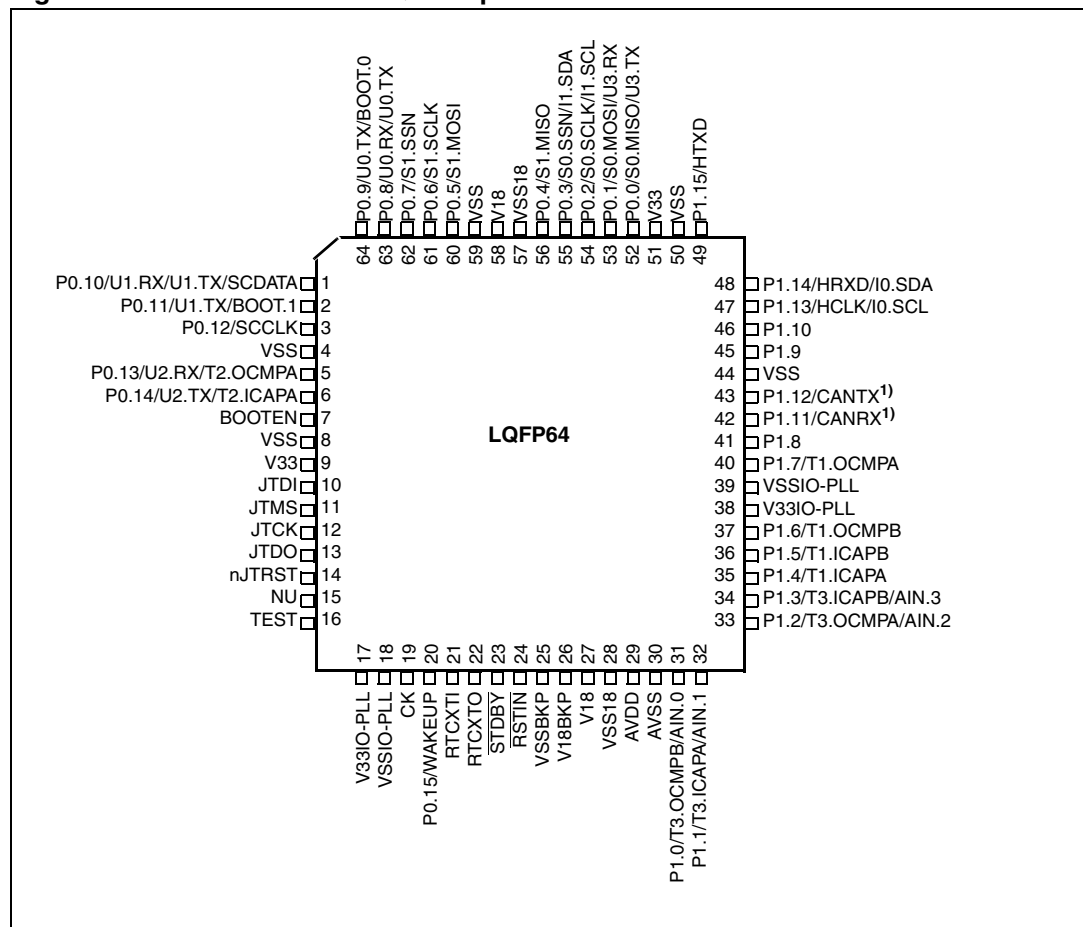
Table 4. STR710 pin description

| Pin n°  |        | Pin name              | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdbby | Main function (after reset)                                                                                                                                                              | Alternate function              |                              |
|---------|--------|-----------------------|------|---------------------------|----------------|-----------|------------|----|----|------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|------------------------------|
| LQFP144 | BGA144 |                       |      |                           | Input level    | Interrupt | Capability | OD | PP |                  |                                                                                                                                                                                          |                                 |                              |
| 143     | C4     | P0.8/U0.RX/<br>U0.TX  | I/O  | pd                        | C <sub>T</sub> | X         | 4mA        | T  |    |                  | Port 0.8                                                                                                                                                                                 | UART0: Receive Data input       | UART0: Transmit data output. |
|         |        |                       |      |                           |                |           |            |    |    |                  | <b>Note:</b> This pin may be used for single wire UART (half duplex) if programmed as Alternate Function Output. The pin will be tri-stated except when UART transmission is in progress |                                 |                              |
| 144     | B3     | P0.9/U0.TX/<br>BOOT.0 | I/O  | pd                        | C <sub>T</sub> |           | 4mA        | X  | X  |                  | Port 0.9                                                                                                                                                                                 | Select Boot Configuration input | UART0: Transmit data output  |

1. The Reset configuration of the I/O Ports is IPUPD (input pull-up/pull down). Refer to [Table 6 on page 30](#). The Port bit configuration at reset is PC0=1, PC1=1, PC2=0. The port data register bit (PD) value depends on the pu/pd column which specifies whether the pull-up or pull-down is enabled at reset
2. In reset state, these pins configured as Input PU/PD with weak pull-up enabled. They must be configured by software as Alternate Function (see [Table 6: Port bit configuration table on page 30](#)) to be used by the External Memory Interface.
3. In reset state, these pins configured as Input PU/PD with weak pull-down enabled to output Address 0x0000 0000 using the External Memory Interface. To access memory banks greater than 1Mbyte, they need to be configured by software as Alternate Function (see [Table 6: Port bit configuration table on page 30](#)).
4. V<sub>33IO-PLL</sub> and V<sub>33</sub> are internally connected. V<sub>SSIO-PLL</sub> and V<sub>SS</sub> are internally connected.
5. During the reset phase, these pins are in input pull-up state. When reset is released, they are configured as Output Push-Pull.
6. During the reset phase, these pins are in input pull-up state. When reset is released, they are configured as Hi-Z.
7. During the reset phase, these pins are in input pull-down state. When reset is released, they are configured as Output Push-Pull.
8. During the reset phase, this pin is in input floating state. When reset is released, it is configured as Output Push-Pull.

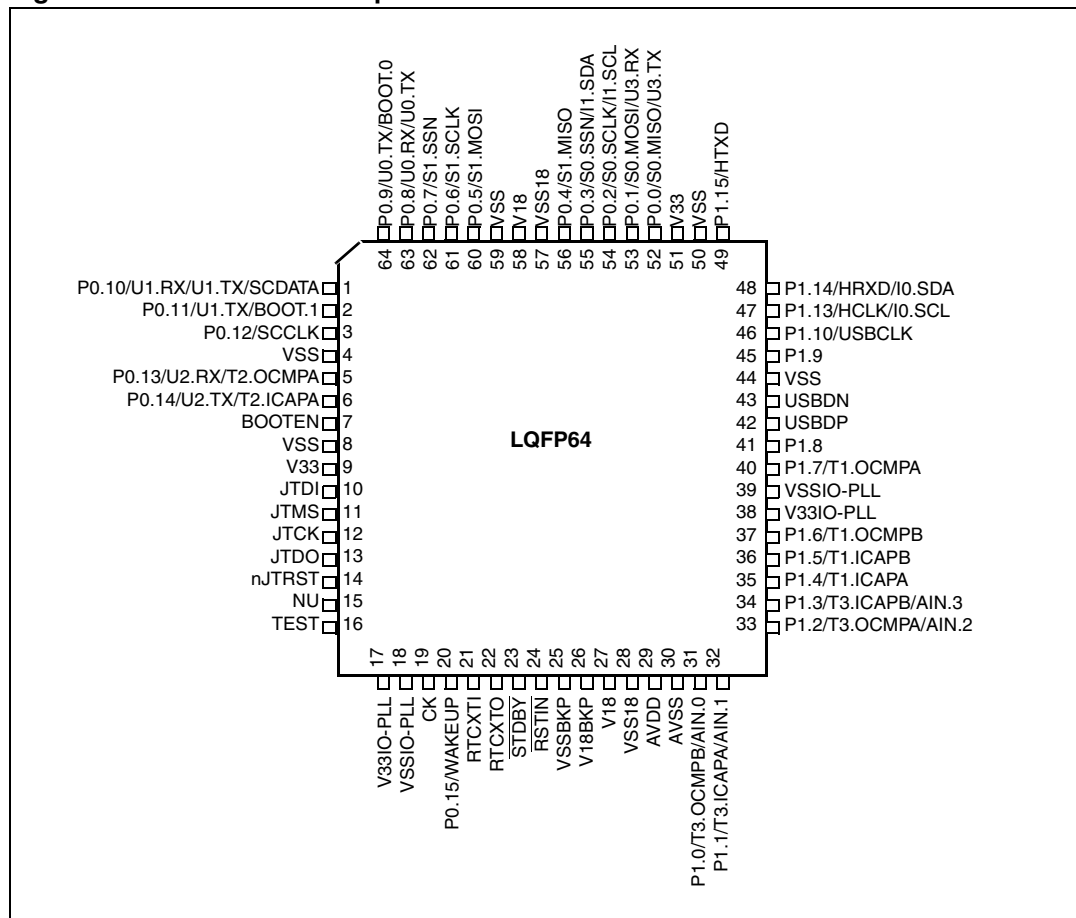
### 3.4 Pin description for 64-pin packages

Figure 3. STR712/STR715 LQFP64 pinout



1. CANTX and CANRX in STR712F only, in STR715F they are general purpose I/Os.

Figure 4. STR711 LQFP64 pinout

**Legend / abbreviations for Table 5:**

Type: I = input, O = output, S = supply, HiZ= high impedance,

In/Output level: C = CMOS 0.3V<sub>DD</sub>/0.7V<sub>DD</sub>

C<sub>T</sub>= CMOS 0.3V<sub>DD</sub>/0.7V<sub>DD</sub> with input trigger

T<sub>T</sub>= TTL 0.8V / 2V with input trigger

C/T = Programmable levels: CMOS 0.3V<sub>DD</sub>/0.7V<sub>DD</sub> or TTL 0.8V / 2V

Port and control configuration:

Input: pu/pd= software enabled internal pull-up or pull down

pu= in reset state, the internal 100kΩ weak pull-up is enabled.

pd = in reset state, the internal 100kΩ weak pull-down is enabled.

Output: OD = open drain (logic level)

PP = push-pull

T = true OD, (P-Buffer and protection diode to V<sub>DD</sub> not implemented),

5V tolerant.



Table 5. STR711/STR712/STR715 pin description

| Pin n° | Pin name                          | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)                                                  | Alternate function                                                                                                                                                                                                   |                                 |
|--------|-----------------------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|
| LQFP64 |                                   |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                                                              |                                                                                                                                                                                                                      |                                 |
| 1      | P0.10/U1.RX/<br>U1.TX/<br>SC.DATA | I/O  | pd                        | C <sub>T</sub> | X         | 4mA        | T  |    |                 | Port 0.10                                                                    | UART1: Receive Data input                                                                                                                                                                                            | UART1: Transmit data output.    |
|        |                                   |      |                           |                |           |            |    |    |                 |                                                                              | <b>Note:</b> This pin may be used for Smartcard DataIn/DataOut or single wire UART (half duplex) if programmed as Alternate Function Output. The pin will be tri-stated except when UART transmission is in progress |                                 |
| 2      | P0.11/BOOT.1<br>/U1.TX            | I/O  | pd                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.11                                                                    | Select Boot Configuration input                                                                                                                                                                                      | UART1: Transmit data output.    |
| 3      | P0.12/SC.CLK                      | I/O  | pd                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.12                                                                    | Smartcard reference clock output                                                                                                                                                                                     |                                 |
| 4      | V <sub>SS</sub>                   | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/Os <sup>2)</sup>                                |                                                                                                                                                                                                                      |                                 |
| 5      | P0.13/U2.RX/<br>T2.OCMPA          | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 0.13                                                                    | UART2: Receive Data input                                                                                                                                                                                            | Timer2: Output Compare A output |
| 6      | P0.14/U2.TX/<br>T2.ICAPA          | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.14                                                                    | UART2: Transmit data output                                                                                                                                                                                          | Timer2: Input Capture A input   |
| 7      | BOOTEN                            | I    |                           | C <sub>T</sub> |           |            |    |    |                 | Boot control input. Enables sampling of BOOT[1:0] pins                       |                                                                                                                                                                                                                      |                                 |
| 8      | V <sub>SS</sub>                   | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/Os <sup>2)</sup>                                |                                                                                                                                                                                                                      |                                 |
| 9      | V <sub>33</sub>                   | S    |                           |                |           |            |    |    |                 | Supply voltage for digital I/Os <sup>2)</sup>                                |                                                                                                                                                                                                                      |                                 |
| 10     | JTDI                              | I    |                           | T <sub>T</sub> |           |            |    |    |                 | JTAG Data input. External pull-up required.                                  |                                                                                                                                                                                                                      |                                 |
| 11     | JTMS                              | I    |                           | T <sub>T</sub> |           |            |    |    |                 | JTAG Mode Selection Input. External pull-up required.                        |                                                                                                                                                                                                                      |                                 |
| 12     | JTCK                              | I    |                           | C              |           |            |    |    |                 | JTAG Clock Input. External pull-up or pull-down required.                    |                                                                                                                                                                                                                      |                                 |
| 13     | JTDO                              | O    |                           |                |           | 8mA        |    | X  |                 | JTAG Data output. <b>Note:</b> Reset state = HiZ.                            |                                                                                                                                                                                                                      |                                 |
| 14     | JTRST                             | I    |                           | T <sub>T</sub> |           |            |    |    |                 | JTAG Reset Input. External pull-up required.                                 |                                                                                                                                                                                                                      |                                 |
| 15     | NU                                |      |                           |                |           |            |    |    |                 | Reserved, must be forced to ground.                                          |                                                                                                                                                                                                                      |                                 |
| 16     | TEST                              |      |                           |                |           |            |    |    |                 | Reserved, must be forced to ground.                                          |                                                                                                                                                                                                                      |                                 |
| 17     | V <sub>33IO-PLL</sub>             | S    |                           |                |           |            |    |    |                 | Supply voltage for digital I/O circuitry and for PLL reference <sup>2)</sup> |                                                                                                                                                                                                                      |                                 |
| 18     | V <sub>SSIO-PLL</sub>             | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/O circuitry and for PLL reference <sup>2)</sup> |                                                                                                                                                                                                                      |                                 |
| 19     | CK                                | I    |                           | C              |           |            |    |    |                 | Reference clock input                                                        |                                                                                                                                                                                                                      |                                 |

Table 5. STR711/STR712/STR715 pin description (continued)

| Pin n° | Pin name                              | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)                                                                                                                                                                                                                                                                                                      | Alternate function                               |                               |
|--------|---------------------------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------|-------------------------------|
| LQFP64 |                                       |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                                                                                                                                                                                                                                                                                                                  |                                                  |                               |
| 20     | P0.15/<br>WAKEUP                      | I    |                           | T <sub>T</sub> | X         |            |    |    | X               | Port 0.15                                                                                                                                                                                                                                                                                                                        | Wakeup from Standby mode input.                  |                               |
|        |                                       |      |                           |                |           |            |    |    |                 | <b>Note:</b> This port is input only.                                                                                                                                                                                                                                                                                            |                                                  |                               |
| 21     | RTCXTI                                |      |                           |                |           |            |    |    |                 | Realtime Clock input and input of 32 kHz oscillator amplifier circuit                                                                                                                                                                                                                                                            |                                                  |                               |
| 22     | RTCXTO                                |      |                           |                |           |            |    |    |                 | Output of 32 kHz oscillator amplifier circuit                                                                                                                                                                                                                                                                                    |                                                  |                               |
| 23     | <u>STDBY</u>                          | I/O  |                           | C <sub>T</sub> |           | 4mA        | X  |    | X               | Input: Hardware Standby mode entry input active low.<br><b>Caution:</b> External pull-up to V <sub>33</sub> required to select normal mode.<br>Output: Standby mode active low output following Software Standby mode entry.<br><b>Note:</b> In Standby mode all pins are in high impedance except those marked Active in Stdby. |                                                  |                               |
| 24     | <u>RSTIN</u>                          | I    |                           | C <sub>T</sub> |           |            |    |    | X               | Reset input                                                                                                                                                                                                                                                                                                                      |                                                  |                               |
| 25     | V <sub>SSBKP</sub>                    |      |                           | S              |           |            |    |    | X               | Stabilization for low power voltage regulator.                                                                                                                                                                                                                                                                                   |                                                  |                               |
| 26     | V <sub>18BKP</sub>                    |      |                           | S              |           |            |    |    | X               | Stabilization for low power voltage regulator. Requires external capacitors of at least 1μF between V <sub>18BKP</sub> and V <sub>SS18BKP</sub> . See <a href="#">Figure 5</a> .<br><b>Note:</b> If the low power voltage regulator is bypassed, this pin can be connected to an external 1.8V supply.                           |                                                  |                               |
| 27     | V <sub>18</sub>                       | S    |                           |                |           |            |    |    |                 | Stabilization for main voltage regulator. Requires external capacitors of at least 10μF + 33nF between V <sub>18</sub> and V <sub>SS18</sub> . See <a href="#">Figure 5</a> .                                                                                                                                                    |                                                  |                               |
| 28     | V <sub>SS18</sub>                     | S    |                           |                |           |            |    |    |                 | Stabilization for main voltage regulator.                                                                                                                                                                                                                                                                                        |                                                  |                               |
| 29     | V <sub>DDA</sub>                      | S    |                           |                |           |            |    |    |                 | Supply voltage for A/D Converter                                                                                                                                                                                                                                                                                                 |                                                  |                               |
| 30     | V <sub>SSA</sub>                      | S    |                           |                |           |            |    |    |                 | Ground voltage for A/D Converter                                                                                                                                                                                                                                                                                                 |                                                  |                               |
| 31     | P1.0/T3.OCM<br>PB/AIN.0               | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.0                                                                                                                                                                                                                                                                                                                         | Timer 3: Output Compare B                        | ADC: Analog input 0           |
| 32     | P1.1/T3.ICAP<br>A/T3.EXTCLK<br>/AIN.1 | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.1                                                                                                                                                                                                                                                                                                                         | Timer 3: Input Capture A or External Clock input | ADC: Analog input 1           |
| 33     | P1.2/T3.OCM<br>PA/AIN.2               | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.2                                                                                                                                                                                                                                                                                                                         | Timer 3: Output Compare A                        | ADC: Analog input 2           |
| 34     | P1.3/T3.ICAP<br>B/AIN.3               | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.3                                                                                                                                                                                                                                                                                                                         | Timer 3: Input Capture B                         | ADC: Analog input 3           |
| 35     | P1.4/T1.ICAP<br>A/T1.EXTCLK           | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.4                                                                                                                                                                                                                                                                                                                         | Timer 1: Input Capture A                         | Timer 1: External Clock input |

Table 5. STR711/STR712/STR715 pin description (continued)

| Pin n° | Pin name                        | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)                                                                                                                                                        | Alternate function                                                  |                              |
|--------|---------------------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------|------------------------------|
| LQFP64 |                                 |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                                                                                                                                                                    |                                                                     |                              |
| 36     | P1.5/T1.ICAP B                  | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.5                                                                                                                                                                           | Timer 1: Input Capture B                                            |                              |
| 37     | P1.6/T1.OCM PB                  | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.6                                                                                                                                                                           | Timer 1: Output Compare B                                           |                              |
| 38     | V <sub>33</sub> IO-PLL          | S    |                           |                |           |            |    |    |                 | Supply voltage for digital I/O circuitry and for PLL reference <sup>2)</sup>                                                                                                       |                                                                     |                              |
| 39     | V <sub>SS</sub> IO-PLL          | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/O circuitry and for PLL reference <sup>2)</sup>                                                                                                       |                                                                     |                              |
| 40     | P1.7/T1.OCM PA                  | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.7                                                                                                                                                                           | Timer 1: Output Compare A                                           |                              |
| 41     | P1.8                            | I/O  | pd                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.8                                                                                                                                                                           |                                                                     |                              |
| 42     | P1.11/CANRX                     | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 1.11                                                                                                                                                                          | CAN: receive data input<br><b>Note:</b> On STR710 and STR712 only   |                              |
| 43     | P1.12/CANTX                     | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.12                                                                                                                                                                          | CAN: Transmit data output<br><b>Note:</b> On STR710 and STR712 only |                              |
| 42     | USBDP                           | I/O  |                           | C <sub>T</sub> |           |            |    |    |                 | USB bidirectional data (data +). Reset state = HiZ<br><b>Note:</b> On STR710 and STR711 only<br>This pin requires an external pull-up to V <sub>33</sub> to maintain a high level. |                                                                     |                              |
| 43     | USBDN                           | I/O  |                           | C <sub>T</sub> |           |            |    |    |                 | USB bidirectional data (data -). Reset state = HiZ<br><b>Note:</b> On STR710 and STR711 only.                                                                                      |                                                                     |                              |
| 44     | V <sub>SS</sub>                 | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/O circuitry <sup>2)</sup>                                                                                                                             |                                                                     |                              |
| 45     | P1.9                            | I/O  | pd                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.9                                                                                                                                                                           |                                                                     |                              |
| 46     | P1.10/USBCLK                    | I/O  | pd                        | C/T            |           | 4mA        | X  | X  |                 | Port 1.10                                                                                                                                                                          | USB: 48 MHZ clock input                                             |                              |
| 47     | P1.13/HCLK/I <sup>2</sup> C.SCL | I/O  | pd                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 1.13                                                                                                                                                                          | HDLC: reference clock input                                         | I <sup>2</sup> C clock       |
| 48     | P1.14/HRXD/I <sup>2</sup> C.SDA | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 1.14                                                                                                                                                                          | HDLC: Receive data input                                            | I <sup>2</sup> C serial data |
| 49     | P1.15/HTXD                      | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 1.15                                                                                                                                                                          | HDLC: Transmit data output                                          |                              |
| 50     | V <sub>SS</sub>                 | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/O circuitry <sup>2)</sup>                                                                                                                             |                                                                     |                              |
| 51     | V <sub>33</sub>                 | S    |                           |                |           |            |    |    |                 | Supply voltage for digital I/O circuitry <sup>2)</sup>                                                                                                                             |                                                                     |                              |

Table 5. STR711/STR712/STR715 pin description (continued)

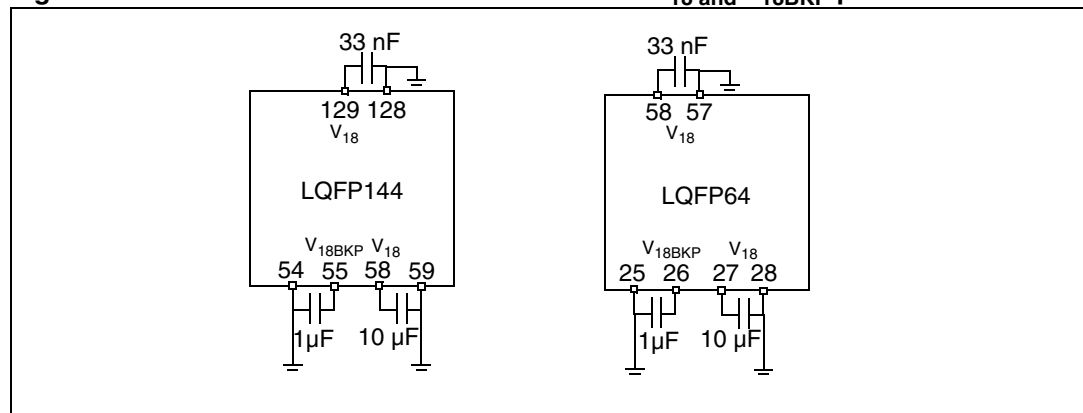
| Pin n° | Pin name             | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)                                                                                                                                                   | Alternate function                                                                                                       |                            |
|--------|----------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------|----------------------------|
| LQFP64 |                      |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                                                                                                                                                               |                                                                                                                          |                            |
| 52     | P0.0/S0.MISO /U3.TX  | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.0                                                                                                                                                                      | SPI0 Master in/Slave out data                                                                                            | UART3 Transmit data output |
|        |                      |      |                           |                |           |            |    |    |                 |                                                                                                                                                                               | <b>Note:</b> Programming AF function selects UART by default. BSPI must be enabled by SPI_EN bit in the BOOTCR register. |                            |
| 53     | P0.1/S0.MOSI /U3.RX  | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 0.1                                                                                                                                                                      | BSPi0: Master out/Slave in data                                                                                          | UART3: Receive Data input  |
|        |                      |      |                           |                |           |            |    |    |                 |                                                                                                                                                                               | <b>Note:</b> Programming AF function selects UART by default. BSPI must be enabled by SPI_EN bit in the BOOTCR register. |                            |
| 54     | P0.2/S0.SCLK /I1.SCL | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 0.2                                                                                                                                                                      | BSPi0: Serial Clock                                                                                                      | I2C1: Serial clock         |
|        |                      |      |                           |                |           |            |    |    |                 |                                                                                                                                                                               | <b>Note:</b> Programming AF function selects I2C by default. BSPI must be enabled by SPI_EN bit in the BOOTCR register.  |                            |
| 55     | P0.3/S0.SS/I1.SDA    | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.3                                                                                                                                                                      | SPI0: Slave Select input active low.                                                                                     | I2C1: Serial Data          |
|        |                      |      |                           |                |           |            |    |    |                 |                                                                                                                                                                               | <b>Note:</b> Programming AF function selects I2C by default. BSPI must be enabled by SPI_EN bit in the BOOTCR register.  |                            |
| 56     | P0.4/S1.MISO         | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.4                                                                                                                                                                      | SPI1: Master in/Slave out data                                                                                           |                            |
| 57     | V <sub>SS18</sub>    | S    |                           |                |           |            |    |    |                 | Stabilization for main voltage regulator.                                                                                                                                     |                                                                                                                          |                            |
| 58     | V <sub>18</sub>      | S    |                           |                |           |            |    |    |                 | Stabilization for main voltage regulator. Requires external capacitors of at least 10µF + 33nF between V <sub>18</sub> and V <sub>SS18</sub> . See <a href="#">Figure 5</a> . |                                                                                                                          |                            |
| 59     | V <sub>SS</sub>      | S    |                           |                |           |            |    |    |                 | Ground voltage for digital I/Os                                                                                                                                               |                                                                                                                          |                            |
| 60     | P0.5/S1.MOSI         | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.5                                                                                                                                                                      | SPI1: Master out/Slave In data                                                                                           |                            |
| 61     | P0.6/S1.SCLK         | I/O  | pu                        | C <sub>T</sub> | X         | 4mA        | X  | X  |                 | Port 0.6                                                                                                                                                                      | SPI1: Serial Clock                                                                                                       |                            |
| 62     | P0.7/S1.SS           | I/O  | pu                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.7                                                                                                                                                                      | SPI1: Slave Select input active low                                                                                      |                            |

Table 5. STR711/STR712/STR715 pin description (continued)

| Pin n° | Pin name          | Type | Reset state <sup>1)</sup> | Input          |           | Output     |    |    | Active in Stdby | Main function (after reset)                                                                                                                                                              | Alternate function              |                              |
|--------|-------------------|------|---------------------------|----------------|-----------|------------|----|----|-----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|------------------------------|
| LQFP64 |                   |      |                           | Input level    | interrupt | Capability | OD | PP |                 |                                                                                                                                                                                          |                                 |                              |
| 63     | P0.8/U0.RX/U0.TX  | I/O  | pd                        | C <sub>T</sub> | X         | 4mA        | T  |    |                 | Port 0.8                                                                                                                                                                                 | UART0: Receive Data input       | UART0: Transmit data output. |
|        |                   |      |                           |                |           |            |    |    |                 | <b>Note:</b> This pin may be used for single wire UART (half duplex) if programmed as Alternate Function Output. The pin will be tri-stated except when UART transmission is in progress |                                 |                              |
| 64     | P0.9/U0.TX/B0OT.0 | I/O  | pd                        | C <sub>T</sub> |           | 4mA        | X  | X  |                 | Port 0.9                                                                                                                                                                                 | Select Boot Configuration input | UART0: Transmit data output  |

1. The Reset configuration of the I/O Ports is IPUPD (input pull-up/pull down). Refer to [Table 6 on page 30](#). The Port bit configuration at reset is PC0=1, PC1=1, PC2=0. The port data register bit (PD) value depends on the pu/pd column which specifies whether the pull-up or pull-down is enabled at reset
2. V<sub>33IO-PLL</sub> and V<sub>33</sub> are internally connected. V<sub>SSIO-PLL</sub> and V<sub>SS</sub> are internally connected.

### 3.5 External connections

Figure 5. Recommended external connection of V<sub>18</sub> and V<sub>18BKP</sub> pins

### 3.6 I/O port configuration

Table 6. Port bit configuration table

| Configuration mode |                               | Input buffer   | PxD register       |              | PxC2 register | PxC1 register | PxC0 register |
|--------------------|-------------------------------|----------------|--------------------|--------------|---------------|---------------|---------------|
|                    |                               |                | Read access        | Write access |               |               |               |
| INPUT              | TTL Input Floating            | TTL floating   | I/O pin            | don't care   | 0             | 0             | 1             |
|                    | CMOS Input Floating           | CMOS floating  | I/O pin            | don't care   | 0             | 1             | 0             |
|                    | CMOS Input Pull-Down (IPUPD)  | CMOS Pull-Down | I/O pin            | 0            | 0             | 1             | 1             |
|                    | CMOS Input Pull-Up (IPUPD)    | CMOS Pull-Up   | I/O pin            | 1            | 0             | 1             | 1             |
|                    | Analog input                  | AIN            | 0                  | don't care   | 0             | 0             | 0             |
| OUTPUT             | Output Open-Drain             | N.A.           | I/O pin            | 0 or 1       | 1             | 0             | 0             |
|                    | Output Push-Pull              | N.A.           | last value written | 0 or 1       | 1             | 0             | 1             |
|                    | Alternate Function Open-Drain | CMOS floating  | I/O pin            | don't care   | 1             | 1             | 0             |
|                    | Alternate Function Push-Pull  | CMOS floating  | I/O pin            | don't care   | 1             | 1             | 1             |

**Legend:**

AIN: Analog Input

CMOS: CMOS Input levels

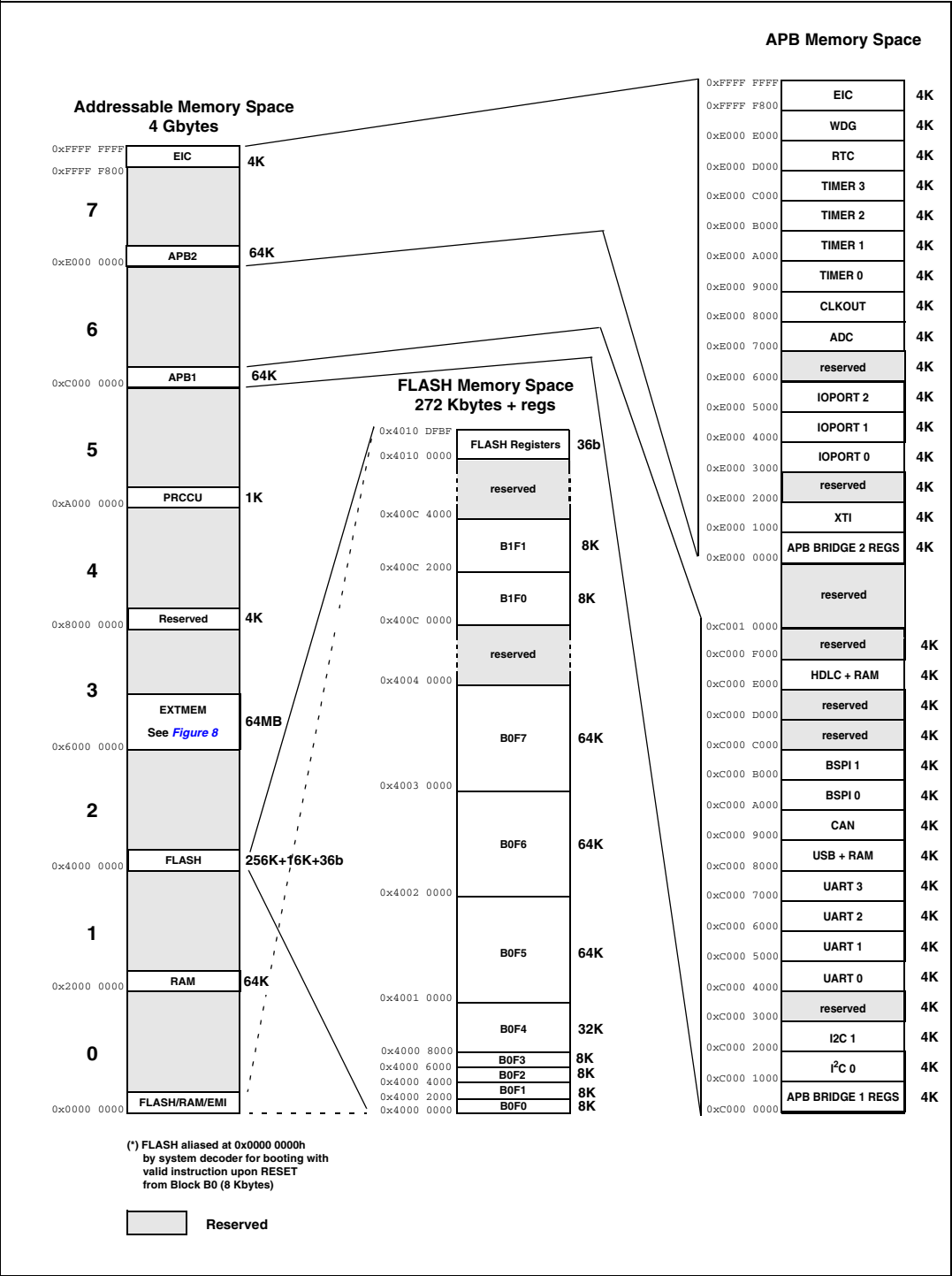
IPUPD: Input Pull Up /Pull Down

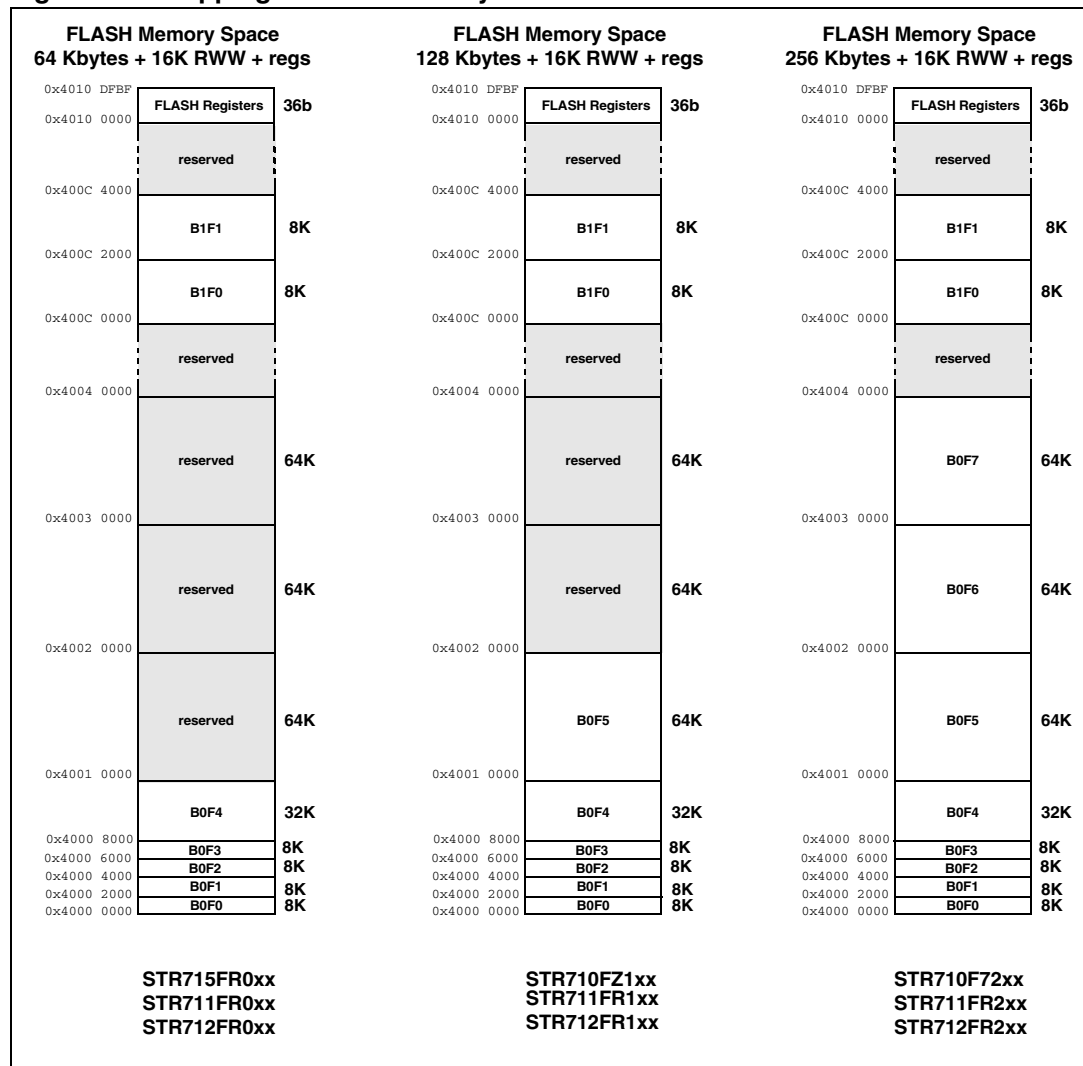
TTL: TTL Input levels

N.A.: not applicable. In Output mode, a read access to the port gets the output latch value.

3.7 Memory mapping

Figure 6. Memory map

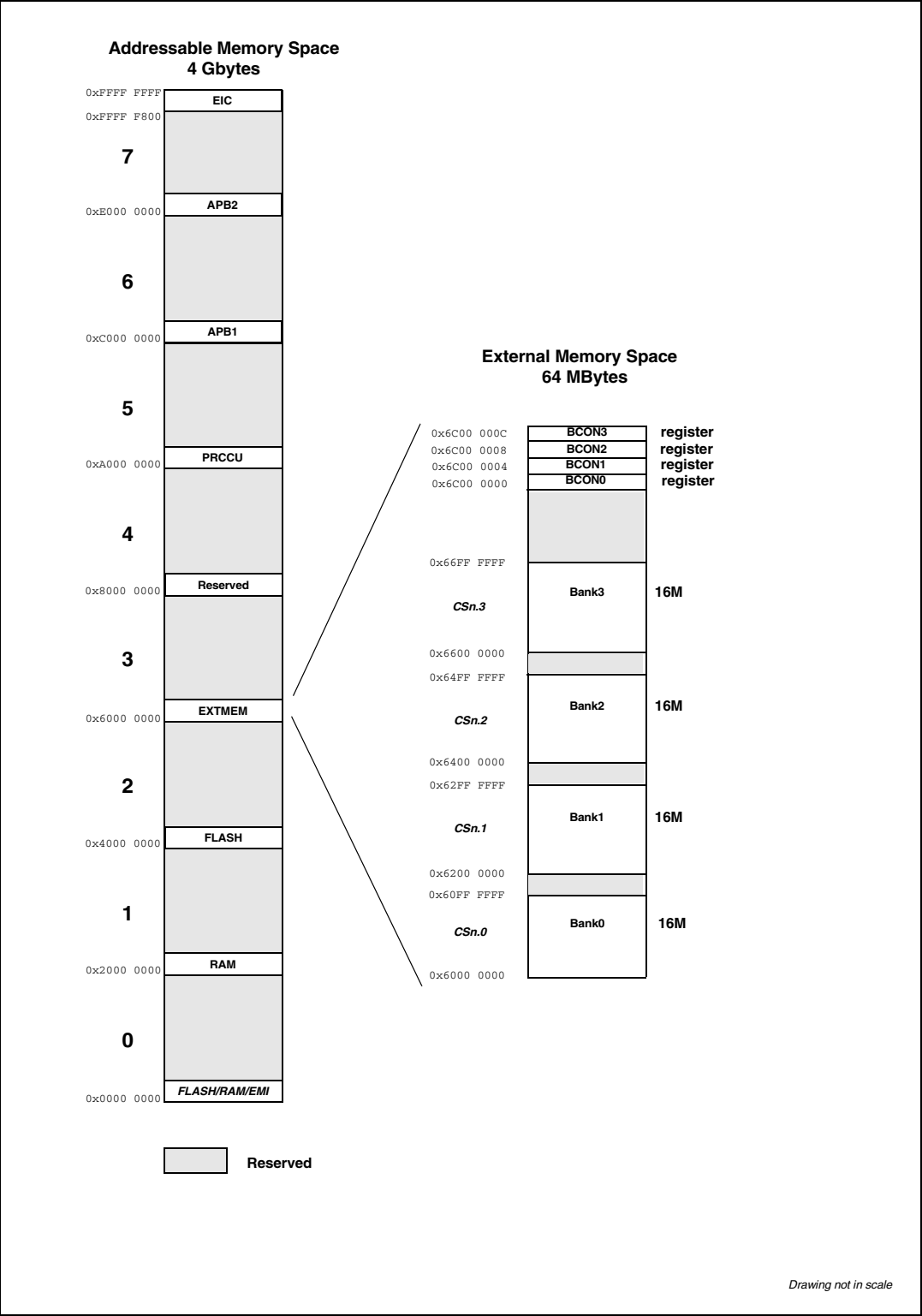


**Figure 7. Mapping of Flash memory versions****Table 7. RAM memory mapping**

| Part number                                            | RAM size  | Start address | End address |
|--------------------------------------------------------|-----------|---------------|-------------|
| STR715FR0xx<br>STR711FR0xx<br>STR712FR0xx              | 16 Kbytes | 0x2000 0000   | 0x2000 3FFF |
| STR710FZ1xx<br>STR711FR1xx<br>STR712FR1xx              | 32 Kbytes | 0x2000 0000   | 0x2000 7FFF |
| STR710FR2xx<br>STR710Rxx<br>STR711FR2xx<br>STR712FR2xx | 64 Kbytes | 0x2000 0000   | 0x2000 FFFF |



Figure 8. External memory map



## 4 Electrical parameters

### 4.1 Parameter conditions

Unless otherwise specified, all voltages are referred to  $V_{SS}$ .

#### 4.1.1 Minimum and maximum values

Unless otherwise specified the minimum and maximum values are guaranteed in the worst conditions of ambient temperature, supply voltage and frequencies by tests in production on 100% of the devices with an ambient temperature at  $T_A=25^{\circ}\text{C}$  and  $T_A=T_{A\text{max}}$  (given by the selected temperature range).

Data based on characterization results, design simulation and/or technology characteristics are indicated in the table footnotes and are not tested in production. Based on characterization, the minimum and maximum values refer to sample tests and represent the mean value plus or minus three times the standard deviation ( $\text{mean} \pm 3\Sigma$ ).

#### 4.1.2 Typical values

Unless otherwise specified, typical data are based on  $T_A=25^{\circ}\text{C}$ ,  $V_{33}=3.3\text{V}$  (for the  $3.0\text{V} \leq V_{33} \leq 3.6\text{V}$  voltage range) and  $V_{18}=1.8\text{V}$ . They are given only as design guidelines and are not tested.

Typical ADC accuracy values are determined by characterization of a batch of samples from a standard diffusion lot over the full temperature range, where 95% of the devices have an error less than or equal to the value indicated ( $\text{mean} \pm 2\Sigma$ ).

#### 4.1.3 Typical curves

Unless otherwise specified, all typical curves are given only as design guidelines and are not tested.

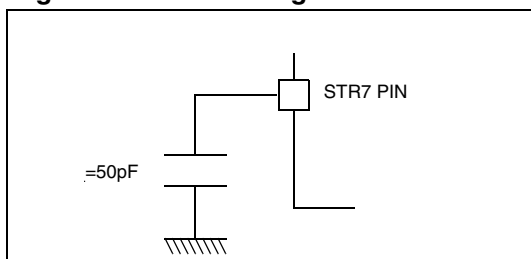
#### 4.1.4 Loading capacitor

The loading conditions used for pin parameter measurement are shown in [Figure 9](#).

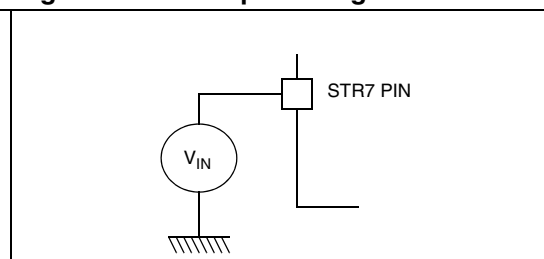
#### 4.1.5 Pin input voltage

The input voltage measurement on a pin of the device is described in [Figure 10](#).

**Figure 9. Pin loading conditions**



**Figure 10. Pin input voltage**



## 4.2 Absolute maximum ratings

Stresses above those listed as “absolute maximum ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

**Table 8. Voltage characteristics**

| Symbol                  | Ratings                                                                              | Min                                                                                | Max          | Unit |
|-------------------------|--------------------------------------------------------------------------------------|------------------------------------------------------------------------------------|--------------|------|
| $V_{33} - V_{SS}$       | External 3.3V Supply voltage (including $AV_{DD}$ and $V_{33IO-PLL}$ ) <sup>2)</sup> | -0.3                                                                               | 4.0          | V    |
| $V_{18BKP} - V_{SSBKP}$ | Digital 1.8V Supply voltage on $V_{18BKP}$ backup supply <sup>2)</sup>               | -0.3                                                                               | 2.0          |      |
| $V_{IN}$                | Input voltage on true open drain pin (P0.10) <sup>1)</sup>                           | $V_{SS}-0.3$                                                                       | +5.5         |      |
|                         | Input voltage on any other pin <sup>1)</sup>                                         | $V_{SS}-0.3$                                                                       | $V_{33}+0.3$ |      |
| $ \Delta V_{33x} $      | Variations between different 3.3V power pins                                         | 50                                                                                 | 50           | mV   |
| $ \Delta V_{18x} $      | Variations between different 1.8V power pins <sup>5)</sup>                           | 25                                                                                 | 25           |      |
| $ V_{SSx} - V_{SS} $    | Variations between all the different ground pins                                     | 50                                                                                 | 50           |      |
| $V_{ESD(HBM)}$          | Electro-static discharge voltage (Human Body Model)                                  | see : <a href="#">Absolute maximum ratings (electrical sensitivity) on page 49</a> |              |      |
| $V_{ESD(MM)}$           | Electro-static discharge voltage (Machine Model)                                     |                                                                                    |              |      |

**Table 9. Current characteristics**

| Symbol                     | Ratings                                                                      | Max.     | Unit |
|----------------------------|------------------------------------------------------------------------------|----------|------|
| $I_{V33}$                  | Total current into $V_{33}/V_{33IO-PLL}$ power lines (source) <sup>2)</sup>  | 150      | mA   |
| $I_{VSS}$                  | Total current out of $V_{SS}/V_{SSIO-PLL}$ ground lines (sink) <sup>2)</sup> | 150      |      |
| $I_{IO}$                   | Output current sunk by any I/O and control pin                               | 25       |      |
|                            | Output current source by any I/Os and control pin                            | - 25     |      |
| $I_{INJ(PIN)}^{1) 3)}$     | Injected current on $\overline{RSTIN}$ pin                                   | $\pm 5$  |      |
|                            | Injected current on CK pin                                                   | $\pm 5$  |      |
|                            | Injected current on any other pin <sup>4)</sup>                              | $\pm 5$  |      |
| $\Sigma I_{INJ(PIN)}^{1)}$ | Total injected current (sum of all I/O and control pins) <sup>4)</sup>       | $\pm 25$ |      |

The  $I_{INJ(PIN)}$  must never be exceeded. This is implicitly insured if  $V_{IN}$  maximum is respected. If  $V_{IN}$  maximum cannot be respected, the injection current must be limited externally to the  $I_{INJ(PIN)}$  value. A positive injection is induced by  $V_{IN} > V_{33}$  while a negative injection is induced by  $V_{IN} < V_{SS}$ . For true open-drain pads, there is no positive injection current, and the corresponding  $V_{IN}$  maximum must always be respected. Data based on  $T_A = 25^\circ\text{C}$ .

All 3.3V power ( $V_{33}$ ,  $AV_{DD}$ ,  $V_{33IO-PLL}$ ) and ground ( $V_{SS}$ ,  $AV_{SS}$ ,  $V_{SSIO-PLL}$ ) pins must always be connected to the external 3.3V supply.

Negative injection disturbs the analog performance of the device. See note in [Section 4.3.11: ADC characteristics on page 66](#).

When several inputs are submitted to a current injection, the maximum  $\Sigma I_{INJ(PIN)}$  is the absolute sum of the positive and negative injected currents (instantaneous values). These results are based on characterization with  $\Sigma I_{INJ(PIN)}$  maximum current injection on four I/O port pins of the device.

Only when using external 1.8V power supply. All the power ( $V_{18}$ ,  $V_{18BKP}$ ) and ground ( $V_{SS18}$ ,  $V_{SSBKP}$ ) pins must always be connected to the external 1.8V supply.

**Table 10. Thermal characteristics**

| Symbol    | Ratings                                                                                             | Value       | Unit             |
|-----------|-----------------------------------------------------------------------------------------------------|-------------|------------------|
| $T_{STG}$ | Storage temperature range                                                                           | -65 to +150 | $^\circ\text{C}$ |
| $T_J$     | Maximum junction temperature (see <a href="#">Section 5.2: Thermal characteristics on page 73</a> ) |             |                  |

## 4.3 Operating conditions

Subject to general operating conditions for  $V_{33}$ , and  $T_A$ .

**Table 11. General operating conditions**

| Symbol      | Parameter                                              | Conditions                                           | Min | Max              | Unit |
|-------------|--------------------------------------------------------|------------------------------------------------------|-----|------------------|------|
| $f_{MCLK}$  | Internal CPU Clock frequency                           | Accessing SRAM or external memory with 0 wait states | 0   | 66               | MHz  |
|             |                                                        | Accessing FLASH in burst mode                        | 0   | 50               |      |
|             |                                                        | Executing from FLASH with RWW                        | 0   | 45 <sup>1)</sup> |      |
|             |                                                        | Accessing FLASH with 0 wait states                   | 0   | 33               |      |
| $f_{PCLK}$  | Internal APB Clock frequency                           |                                                      | 0   | 33               | MHz  |
| $V_{33}$    | Standard Operating Voltage (includes $V_{33IO\_PLL}$ ) |                                                      | 3.0 | 3.6              | V    |
| $V_{18BKP}$ | Backup Operating Voltage                               |                                                      | 1.4 | 1.8              | V    |
| $T_A$       | Ambient temperature range                              | 6 Partnumber Suffix                                  | -40 | 85               | °C   |

1. Data guaranteed by characterization, not tested in production

**Table 12. Operating conditions at power-up / power-down**

| Symbol    | Parameter               | Conditions                                          | Min | Typ | Max | Unit |
|-----------|-------------------------|-----------------------------------------------------|-----|-----|-----|------|
| $t_{V33}$ | $V_{33}$ rise time rate | Subject to general operating conditions for $T_A$ . | 20  |     |     | μs/V |
|           |                         |                                                     |     |     | 20  | ms/V |

### 4.3.1 Supply current characteristics

The current consumption is measured as described in [Figure 9 on page 34](#) and [Figure 10 on page 34](#).

#### Total current consumption

The MCU is placed under the following conditions:

- All I/O pins in input mode with a static value at  $V_{33}$  or  $V_{SS}$  (no load)
- All peripherals are disabled except if explicitly mentioned.
- Embedded Regulators are used to provide 1.8V (except if explicitly mentioned)

Subject to general operating conditions for  $V_{33}$ , and  $T_A$ .

**Table 13. Total current consumption**

| Symbol        | Parameter                      | Conditions                                   | Typ <sup>1)</sup> | Max <sup>2)</sup> | Unit          |
|---------------|--------------------------------|----------------------------------------------|-------------------|-------------------|---------------|
| $I_{DD}^{4)}$ | Supply current in RUN mode     | $f_{MCLK}=66$ MHz, RAM execution             | 73.6              | 100               | mA            |
|               |                                | $f_{MCLK}=32$ MHz, Flash non-burst execution | 49.3              |                   |               |
|               | Supply current in STOP mode    | $T_A=25^{\circ}\text{C}$                     | 10                | 50 <sup>3)</sup>  | $\mu\text{A}$ |
|               | Supply current in STANDBY mode | OSC32K bypassed                              | 12                | 30                | $\mu\text{A}$ |

**Notes:**

1. Typical data are based on  $T_A=25^{\circ}\text{C}$ ,  $V_{33}=3.3\text{V}$ .
2. Data based on characterization results, tested in production at  $V_{33}$ ,  $f_{MCLK}$  max. and  $T_A$  max.
3. Based on device characterisation, device power consumption in STOP mode at  $T_A$  25°C is predicted to be 30 $\mu\text{A}$  or less in 99.730020% of parts.
4. The conditions for these consumption measurements are described in application note AN2100.

Table 14. Typical power consumption data

| Symbol               | Parameter                          |                 | Conditions                                         | Typical current on V33 | Unit |  |
|----------------------|------------------------------------|-----------------|----------------------------------------------------|------------------------|------|--|
| I <sub>DDRUN</sub>   | RUN mode current from RAM          | All periphs ON  | MCLK = 16 MHz, PCLK1 = PCLK2 = 16 MHz              | 23                     | mA   |  |
|                      |                                    |                 | MCLK = 32 MHz, PCLK1 = PCLK2 = 32 MHz              | 40                     |      |  |
|                      |                                    |                 | MCLK = 48 MHz, PCLK1 = PCLK2 = 24 MHz              | 50                     |      |  |
|                      |                                    |                 | MCLK = 64 MHz, PCLK1 = PCLK2 = 32 MHz              | 63                     |      |  |
|                      |                                    | All periphs OFF | MCLK = 16 MHz                                      | 16                     |      |  |
|                      |                                    |                 | MCLK = 32 MHz                                      | 26                     |      |  |
|                      |                                    |                 | MCLK = 48 MHz                                      | 39                     |      |  |
|                      |                                    |                 | MCLK = 64 MHz                                      | 48                     |      |  |
|                      | RUN mode current from FLASH        | All periphs ON  | MCLK = 16 MHz, PCLK1 = PCLK2 = 16 MHz              | 27                     |      |  |
|                      |                                    |                 | MCLK = 32 MHz, PCLK1 = PCLK2 = 32 MHz              | 47                     |      |  |
|                      |                                    |                 | MCLK = 48 MHz, PCLK1 = PCLK2 = 24 MHz              | 62                     |      |  |
|                      |                                    | All periphs OFF | MCLK = 16 MHz                                      | 21                     |      |  |
|                      |                                    |                 | MCLK = 32 MHz                                      | 36                     |      |  |
|                      |                                    |                 | MCLK = 48 MHz                                      | 53                     |      |  |
| I <sub>DDSLow</sub>  | SLOW mode current                  |                 | MCLK = CK_AF (32 kHz), MVR off                     | 1.7                    |      |  |
| I <sub>DDWAIT</sub>  | WAIT mode current (all periphs ON) |                 | PCLK1 = PCLK2 = 1 MHz                              | 13                     |      |  |
| I <sub>DDLWAIT</sub> | LPWAIT mode current                |                 | CK_AF (32 kHz), Main VReg off, FLASH in power-down | 37                     |      |  |
| I <sub>DDSTOP</sub>  | STOP mode current                  |                 | Main VReg off, FLASH in power down, RTC on         | 18                     | μA   |  |
|                      |                                    |                 | Main VReg off, FLASH in power down, RTC off        | 10                     |      |  |
| I <sub>DDSB</sub>    | STANDBY mode current               |                 | LP VReg on, LVD on, RTC on                         | 10                     |      |  |
|                      |                                    |                 | LP VReg off (ext 1.8V on V18BKP), LVD on, RTC on   | 9                      |      |  |
|                      |                                    |                 | LP VReg off (ext1.8V on V18BKP), LVD off, RTC on   | 5                      |      |  |
|                      |                                    |                 | LP VReg off (ext 1.8V on V18BKP), LVD off, RTC off | 1                      |      |  |

Figure 11. STOP  $I_{DD}$  vs.  $V_{33}$

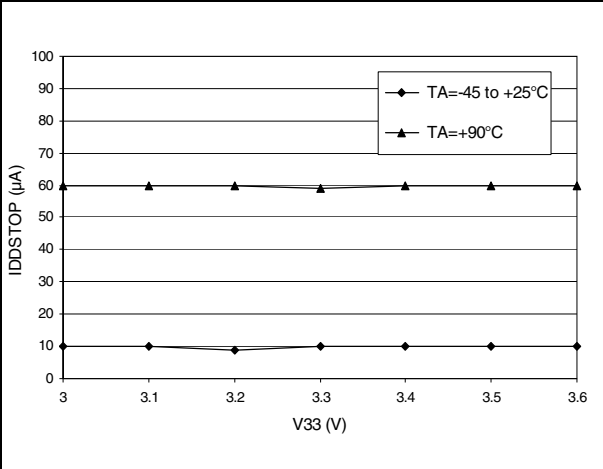


Figure 12. STANDBY  $I_{DD}$  vs.  $V_{33}$

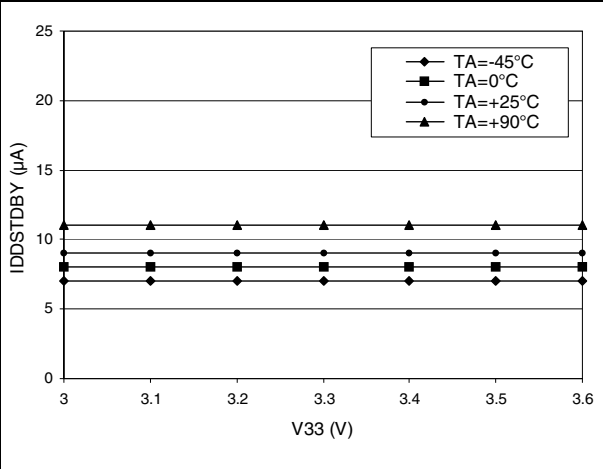
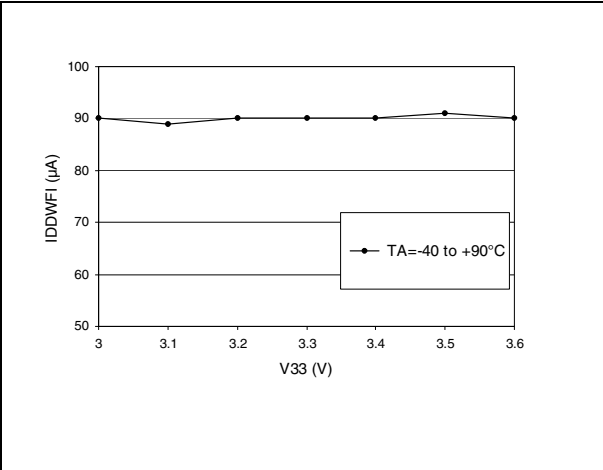


Figure 13. WFI  $I_{DD}$  vs.  $V_{33}$





## On-chip peripherals

Table 15. Peripheral current consumption

| Symbol         | Parameter                                        | Conditions                                                           | Typ  | Unit |
|----------------|--------------------------------------------------|----------------------------------------------------------------------|------|------|
| $I_{DD}(PLL1)$ | PLL1 supply current                              | $T_A = 25^\circ\text{C}$                                             | 3.42 | mA   |
| $I_{DD}(PLL2)$ | PLL2 supply current                              |                                                                      | 5.81 |      |
| $I_{DD}(TIM)$  | TIM Timer supply current <sup>1)</sup>           | $T_A = 25^\circ\text{C},$<br>$f_{PCLK1} = f_{PCLK2} = 33\text{ MHz}$ | 0.88 |      |
| $I_{DD}(BSPi)$ | BSPi supply current <sup>2)</sup>                |                                                                      | 1.1  |      |
| $I_{DD}(UART)$ | UART supply current <sup>2)</sup>                |                                                                      | 1.05 |      |
| $I_{DD}(I2C)$  | I2C supply current <sup>2)</sup>                 |                                                                      | 0.45 |      |
| $I_{DD}(ADC)$  | ADC supply current when converting <sup>5)</sup> |                                                                      | 1.89 |      |
| $I_{DD}(HDLC)$ | HDLC supply current <sup>2)</sup>                |                                                                      | 1.82 |      |
| $I_{DD}(USB)$  | USB supply current <sup>2)</sup>                 |                                                                      | 2.08 |      |
| $I_{DD}(CAN)$  | CAN supply current <sup>2)</sup>                 |                                                                      | 1.11 |      |

## Notes:

1. Data based on a differential  $I_{DD}$  measurement between reset configuration and timer counter running at 16MHz. No IC/OC programmed (no I/O pads toggling).
2. Data based on a differential  $I_{DD}$  measurement between the on-chip peripheral when kept under reset and not clocked and the on-chip peripheral when clocked and not kept under reset. No I/O pads toggling.
3. Data based on a differential  $I_{DD}$  measurement between reset configuration and continuous A/D conversions.

### 4.3.2 Clock and timing characteristics

#### External clock sources

Subject to general operating conditions for  $V_{33}$ , and  $T_A$ .

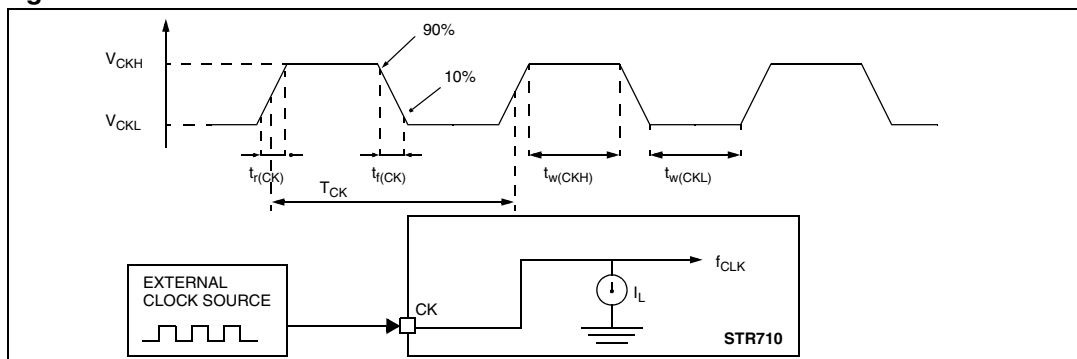
**Table 16. CK external clock characteristics**

| Symbol                     | Parameter                          | Conditions                                     | Min                 | Typ | Max                 | Unit    |
|----------------------------|------------------------------------|------------------------------------------------|---------------------|-----|---------------------|---------|
| $f_{CK}$                   | External clock source frequency    |                                                | 0                   |     | 16.5                | MHz     |
| $V_{CKH}$                  | CK input pin high level voltage    |                                                | $0.7 \times V_{33}$ |     | $V_{33}$            | V       |
| $V_{CKL}$                  | CK input pin low level voltage     |                                                | $V_{SS}$            |     | $0.3 \times V_{33}$ |         |
| $t_{w(CK)}$<br>$t_{w(CK)}$ | CK high or low time <sup>1)</sup>  |                                                | 25                  |     |                     | ns      |
| $t_{r(CK)}$<br>$t_{f(CK)}$ | CK rise or fall time <sup>1)</sup> |                                                |                     |     | 20                  |         |
| $C_{IN(CK)}$               | CK input capacitance <sup>1)</sup> |                                                |                     | 5   |                     | pF      |
| DuCy(XT1)                  | Duty cycle                         |                                                | 40                  |     | 60                  | %       |
| $I_L$                      | CK Input leakage current           | $V_{SS} \rightarrow V_{IN} \rightarrow V_{33}$ |                     |     | $\pm 1$             | $\mu A$ |

**Notes:**

1. Data based on design simulation and/or technology characteristics, not tested in production.

**Figure 14. CK external clock source**



**Table 17. RTCXT1 external clock characteristics**

| Symbol                                                         | Parameter                              | Conditions                                     | Min                 | Typ | Max                 | Unit          |
|----------------------------------------------------------------|----------------------------------------|------------------------------------------------|---------------------|-----|---------------------|---------------|
| $f_{\text{RTCXT1}}$                                            | External clock source frequency        |                                                | 0                   |     | 500                 | kHz           |
| $V_{\text{RTCXT1H}}$                                           | RTCXT1 input pin high level voltage    |                                                | $0.7 \times V_{33}$ |     | $V_{33}$            | V             |
| $V_{\text{RTCXT1L}}$                                           | RTCXT1 input pin low level voltage     |                                                | $V_{\text{SS}}$     |     | $0.3 \times V_{33}$ |               |
| $t_{\text{w}}(\text{RTCXT1})$<br>$t_{\text{w}}(\text{RTCXT1})$ | RTCXT1 high or low time <sup>1)</sup>  |                                                | 100                 |     |                     | ns            |
| $t_{\text{r}}(\text{RTCXT1})$<br>$t_{\text{f}}(\text{RTCXT1})$ | RTCXT1 rise or fall time <sup>1)</sup> |                                                |                     |     | 5                   |               |
| $C_{\text{IN}}(\text{RTCXT1})$                                 | RTCXT1 input capacitance <sup>1)</sup> |                                                |                     | 5   |                     | pF            |
| $\text{DuCy}(\text{RTCXT1})$                                   | Duty cycle                             |                                                | 30                  |     | 70                  | %             |
| $I_{\text{L}}$                                                 | RTCXT1 Input leakage current           | $V_{\text{SS}} \leq V_{\text{IN}} \leq V_{33}$ |                     |     | $\pm 1$             | $\mu\text{A}$ |

**Notes:**

1. Data based on design simulation and/or technology characteristics, not tested in production.

### OSC32K crystal / ceramic resonator oscillator

The STR7 RTC clock can be supplied with a 32 kHz Crystal/Ceramic resonator oscillators. All the information given in this paragraph are based on characterization results with specified typical external components. In the application, the resonator and the load capacitors have to be placed as close as possible to the oscillator pins in order to minimize output distortion and start-up stabilization time. Refer to the crystal resonator manufacturer for more details (frequency, package, accuracy...).

**Table 18. 32K oscillator characteristics ( $f_{OSC32K} = 32.768 \text{ kHz}$ )**

| Symbol                           | Parameter                                                                                               | Conditions                                    | Typ  | Unit      |
|----------------------------------|---------------------------------------------------------------------------------------------------------|-----------------------------------------------|------|-----------|
| $R_F$                            | Feedback resistor                                                                                       |                                               | 2.7  | $M\Omega$ |
| $C_{L1}$<br>$C_{L2}$             | Recommended load capacitance versus equivalent serial resistance of the crystal ( $R_S$ ) <sup>1)</sup> | $R_S = 40K \Omega$                            | 12.5 | pF        |
| $i_2$                            | RTCXT2 driving current                                                                                  | $V_{33} = 3.3 \text{ V}$<br>$V_{IN} = V_{SS}$ | 3.2  | $\mu A$   |
| $g_m$                            | Oscillator Transconductance                                                                             |                                               | 8    | $\mu A/V$ |
| $t_{SU(OSC32KHZ)}$ <sup>2)</sup> | Startup time                                                                                            | $V_{33}$ is stabilized                        | 5    | s         |

**Notes:**

1. The oscillator selection can be optimized in terms of supply current using an high quality resonator with small  $R_S$  value for example MSIV-TIN32.768kHz. Refer to crystal manufacturer for more details
2.  $t_{SU(OSC32KHZ)}$  is the start-up time measured from the moment it is enabled (by software) to a stabilized 32 kHz oscillation is reached. This value is measured for a standard crystal resonator and it can vary significantly with the crystal manufacturer

**Figure 15. Typical application with a 32 kHz crystal**

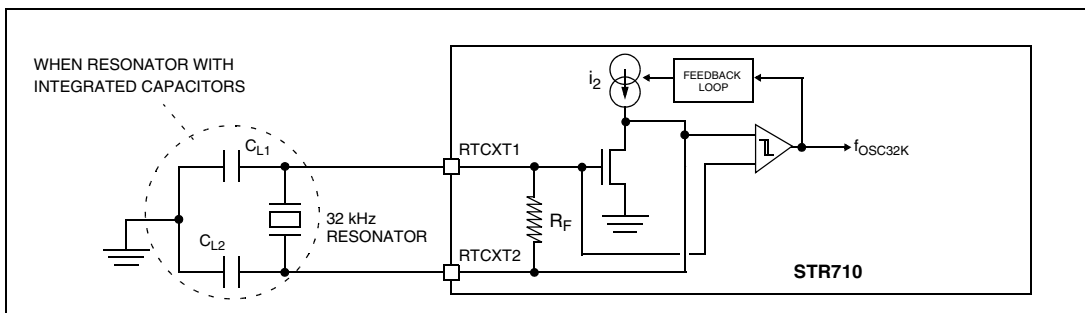
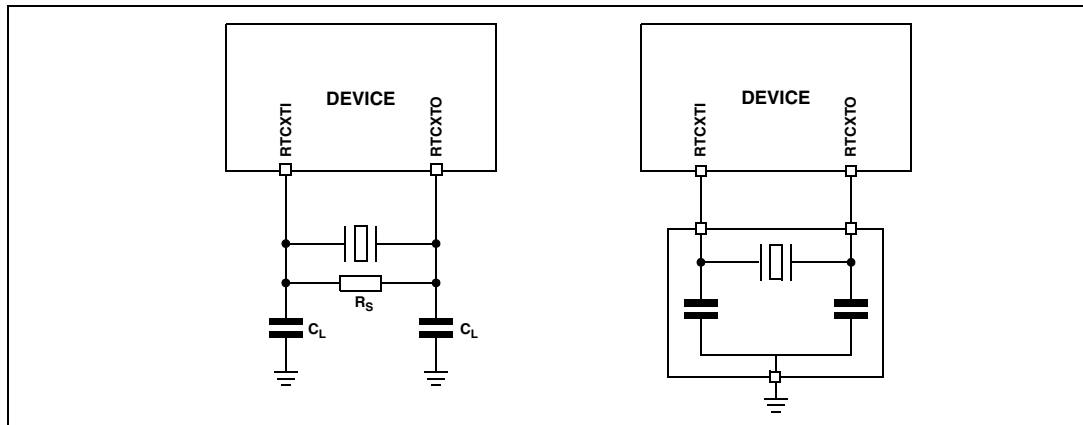


Figure 16. RTC crystal oscillator and resonator

**PLL electrical characteristics**

$V_{33} = 3.0$  to  $3.6V$ ,  $V_{33IOPLL} = 3.0$  to  $3.6V$ ,  $T_A = -40 / 85\text{ }^{\circ}\text{C}$  unless otherwise specified.

**Table 19. PLL1 characteristics**

| Symbol        | Parameter                   | Test conditions                                                         | Value |     |      | Unit          |
|---------------|-----------------------------|-------------------------------------------------------------------------|-------|-----|------|---------------|
|               |                             |                                                                         | Min   | Typ | Max  |               |
| $f_{PLLCLK1}$ | PLL multiplier output clock |                                                                         |       |     | 165  | MHz           |
| $f_{PLL1}$    | PLL input clock             | FREF_RANGE = 0                                                          | 1.5   |     | 3.0  | MHz           |
|               |                             | FREF_RANGE = 1<br>MX[1:0]='00' or '01'                                  | 3.0   |     | 8.25 | MHz           |
|               |                             | FREF_RANGE = 1<br>MX[1:0]='10' or '11'                                  | 3.0   |     | 6    | MHz           |
|               | PLL input clock duty cycle  |                                                                         | 25    |     | 75   | %             |
| $f_{FREE1}$   | PLL free running frequency  | FREF_RANGE = 0<br>MX[1:0]='01' or '11'                                  |       | 125 |      | kHz           |
|               |                             | FREF_RANGE = 0<br>MX[1:0]='00' or '10'                                  |       | 250 |      | kHz           |
|               |                             | FREF_RANGE = 1<br>MX[1:0]='01' or '11'                                  |       | 250 |      | kHz           |
|               |                             | FREF_RANGE = 1<br>MX[1:0]='00' or '10'                                  |       | 500 |      | kHz           |
| $t_{LOCK1}$   | PLL lock time               | FREF_RANGE = 0<br>Stable Input Clock<br>Stable $V_{33IOPLL}$ , $V_{18}$ |       |     | 300  | $\mu\text{s}$ |
|               |                             | FREF_RANGE = 1<br>Stable Input Clock<br>Stable $V_{33IOPLL}$ , $V_{18}$ |       |     | 600  | $\mu\text{s}$ |

**Table 19. PLL1 characteristics (continued)**

| Symbol               | Parameter                 | Test conditions                                                                                   | Value |     |     | Unit |
|----------------------|---------------------------|---------------------------------------------------------------------------------------------------|-------|-----|-----|------|
|                      |                           |                                                                                                   | Min   | Typ | Max |      |
| $\Delta t_{JITTER1}$ | PLL jitter (peak to peak) | $t_{PLL} = 4$ MHz,<br>MX[1:0]='11'<br>Global Output division<br>= 32<br>(Output Clock = 2<br>MHz) |       | 0.7 | 2   | ns   |

**Table 20. PLL2 characteristics**

| Symbol               | Parameter                   | Test conditions                                                                          | Value |     |     | Unit |
|----------------------|-----------------------------|------------------------------------------------------------------------------------------|-------|-----|-----|------|
|                      |                             |                                                                                          | Min   | Typ | Max |      |
| $f_{PLLCLK2}$        | PLL multiplier output clock |                                                                                          |       |     | 140 | MHz  |
| $f_{PLL2}$           | PLL input clock             | FREF_RANGE = 0                                                                           | 1.5   |     | 3.0 | MHz  |
|                      |                             | FREF_RANGE = 1                                                                           | 3.0   |     | 5   | MHz  |
| $t_{LOCK2}$          | PLL lock time               | FREF_RANGE = 0<br>Stable Input Clock<br>Stable V <sub>33IOPLL</sub> , V <sub>18</sub>    |       |     | 300 | μs   |
|                      |                             | FREF_RANGE = 1<br>Stable Input Clock<br>Stable V <sub>33IOPLL</sub> , V <sub>18</sub>    |       |     | 600 | μs   |
| $\Delta t_{JITTER2}$ | PLL jitter (peak to peak)   | $t_{PLL} = 4$ MHz, MX[1:0]='11'<br>Global Output division = 32<br>(Output Clock = 2 MHz) |       | 0.7 | 2   | ns   |

**Table 21. Low-power mode wakeup timing**

| Symbol       | Parameter                | Typ                                               | Unit              |
|--------------|--------------------------|---------------------------------------------------|-------------------|
| $t_{WULPWF}$ | Wakeup from LPWFI mode   | 26 <sup>(1)</sup>                                 | μs                |
| $t_{WUSTOP}$ | Wakeup from STOP mode    | 2048                                              | CLK Cycles<br>(2) |
| $t_{WUSTBY}$ | Wakeup from STANDBY mode | 2048 CLK Cycles<br>+ 8 CLK2 Cycles <sup>(3)</sup> | Cycles            |

1. Clock selected is CK2\_16, Main VReg OFF and Flash in power-down

2. The CLK clock is derived from the external oscillator.

3. Refer to Figure 7. Reset General Timing in the STR71xF Reference Manual (UM0084)

### 4.3.3 Memory characteristics

#### Flash memory

$V_{33} = 3.0$  to  $3.6V$ ,  $T_A = -40$  to  $85\text{ }^{\circ}\text{C}$  unless otherwise specified.

**Table 22. Flash memory characteristics**

| Symbol         | Parameter                          | Test conditions                                        | Value |            |                   | Unit          |
|----------------|------------------------------------|--------------------------------------------------------|-------|------------|-------------------|---------------|
|                |                                    |                                                        | Min.  | Typ        | Max <sup>1)</sup> |               |
| $t_{PW}$       | Word Program                       |                                                        |       | 40         |                   | $\mu\text{s}$ |
| $t_{PDW}$      | Double Word Program                |                                                        |       | 60         |                   | $\mu\text{s}$ |
| $t_{PB0}$      | Bank 0 Program (256K)              | Double Word Program                                    |       | 1.6        | 2.1               | s             |
| $t_{PB1}$      | Bank 1 Program (16K)               | Double Word Program                                    |       | 130        | 170               | ms            |
| $t_{ES}$       | Sector Erase (64K)                 | Not preprogrammed<br>Preprogrammed                     |       | 2.3<br>1.9 | 4.0<br>3.3        | s             |
| $t_{ES}$       | Sector Erase (8K)                  | Not preprogrammed<br>Preprogrammed                     |       | 0.7<br>0.6 | 1.1<br>1.0        | s             |
| $t_{ES}$       | Bank 0 Erase (256K)                | Not preprogrammed<br>Preprogrammed                     |       | 8.0<br>6.6 | 13.7<br>11.2      | s             |
| $t_{ES}$       | Bank 1 Erase (16K)                 | Not preprogrammed<br>Preprogrammed                     |       | 0.9<br>0.8 | 1.5<br>1.3        | s             |
| $t_{RPD}^{2)}$ | Recovery when disabled             |                                                        |       |            | 20                | $\mu\text{s}$ |
| $t_{PSL}^{2)}$ | Program Suspend Latency            |                                                        |       |            | 10                | $\mu\text{s}$ |
| $t_{ESL}^{2)}$ | Erase Suspend Latency              |                                                        |       |            | 300               | $\mu\text{s}$ |
| $N_{END\_B0}$  | Endurance (Bank 0 sectors)         |                                                        | 10    |            |                   | kcycles       |
| $N_{END\_B1}$  | Endurance (Bank 1 sectors)         |                                                        | 100   |            |                   | kcycles       |
| $t_{RET}$      | Data Retention (Bank 0 and Bank 1) | $T_A=85^{\circ}$                                       | 20    |            |                   | Years         |
| $t_{ESR}$      | Erase Suspend Rate                 | Min time from Erase<br>Resume to next Erase<br>Suspend | 20    |            |                   | ms            |

**Notes:**

1.  $T_A=45^{\circ}\text{C}$  after 0 cycles. Guaranteed by characterization, not tested in production.
2. Guaranteed by design, not tested in production

#### 4.3.4 EMC characteristics

Susceptibility tests are performed on a sample basis during product characterization.

##### Functional EMS (electro magnetic susceptibility)

Based on a simple running application on the product (toggling 2 LEDs through I/O ports), the product is stressed by two electro magnetic events until a failure occurs (indicated by the LEDs).

- **ESD:** Electro-Static Discharge (positive and negative) is applied on all pins of the device until a functional disturbance occurs. This test conforms with the IEC 1000-4-2 standard.
- **FTB:** A Burst of Fast Transient voltage (positive and negative) is applied to  $V_{DD}$  and  $V_{SS}$  through a 100pF capacitor, until a functional disturbance occurs. This test conforms with the IEC 1000-4-4 standard.

A device reset allows normal operations to be resumed. The test results are given in the table below based on the EMS levels and classes defined in application note AN1709.

##### Designing hardened software to avoid noise problems

EMC characterization and optimization are performed at component level with a typical application environment and simplified MCU software. It should be noted that good EMC performance is highly dependent on the user application and the software in particular.

Therefore it is recommended that the user applies EMC software optimization and prequalification tests in relation with the EMC level requested for his application.

##### Software recommendations:

The software flowchart must include the management of runaway conditions such as:

- Corrupted program counter
- Unexpected reset
- Critical Data corruption (control registers...)

##### Prequalification trials:

Most of the common failures (unexpected reset and program counter corruption) can be reproduced by manually forcing a low state on the RESET pin or the Oscillator pins for 1 second.

To complete these trials, ESD stress can be applied directly on the device, over the range of specification values. When unexpected behavior is detected, the software can be hardened to prevent unrecoverable errors occurring (see application note AN1015).

In the case of an ARM7 CPU, in order to write robust code that can withstand all kinds of stress, such as very strong electromagnetic disturbance, it is mandatory that the Data Abort, Prefetch Abort and Undefined Instruction exceptions are managed by the application software. This will prevent the code going into an undefined state or performing any unexpected operation.



Table 23. EMS data

| Symbol     | Parameter                                                                                                                        | Conditions                                                                                          | Level/Class |
|------------|----------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------|-------------|
| $V_{FESD}$ | Voltage limits to be applied on any I/O pin to induce a functional disturbance                                                   | $V_{33}=3.3\text{ V}$ , $T_A=+25^\circ\text{C}$ , $f_{MCLK}=32\text{ MHz}$ conforms to IEC 1000-4-2 | 2B          |
| $V_{EFTB}$ | Fast transient voltage burst limits to be applied through 100pF on $V_{DD}$ and $V_{SS}$ pins to induce a functional disturbance | $V_{33}=3.3\text{ V}$ , $T_A=+25^\circ\text{C}$ , $f_{MCLK}=32\text{ MHz}$ conforms to IEC 1000-4-4 | 4A          |

**Electro magnetic interference (EMI)**

Based on a simple application running on the product (toggling 2 LEDs through the I/O ports), the product is monitored in terms of emission. This emission test is in line with the norm SAE J 1752/3 which specifies the board and the loading of each pin.

Table 24. EMI data

| Symbol    | Parameter  | Conditions                                                                                  | Monitored frequency band | Max vs. $[f_{OSC4M}/f_{HCLK}]$ |          | Unit |
|-----------|------------|---------------------------------------------------------------------------------------------|--------------------------|--------------------------------|----------|------|
|           |            |                                                                                             |                          | 16/ 48 MHz                     | 16/8 MHz |      |
| $S_{EMI}$ | Peak level | $V_{33}=3.3\text{ V}$ , $T_A=+25^\circ\text{C}$ , LQFP64 package conforming to SAE J 1752/3 | 0.1 MHz to 30 MHz        | 17                             | 19       | dBμV |
|           |            |                                                                                             | 30 MHz to 130 MHz        | 17                             | 16       |      |
|           |            |                                                                                             | 130 MHz to 1 GHz         | 11                             | 11       |      |
|           |            |                                                                                             | SAE EMI Level            | 4                              | 3        | -    |

**Notes:**

1. Not tested in production.
2. BGA and LQFP devices have similar EMI characteristics.

**Absolute maximum ratings (electrical sensitivity)**

Based on three different tests (ESD, LU and DLU) using specific measurement methods, the product is stressed in order to determine its performance in terms of electrical sensitivity. For more details, refer to the application note AN1181.

**Electro-static discharge (ESD)**

Electro-Static Discharges (a positive then a negative pulse separated by 1 second) are applied to the pins of each sample according to each pin combination. The sample size depends on the number of supply pins in the device (3 parts\*(n+1) supply pin). Two models can be simulated: Human Body Model and Machine Model. This test conforms to the JESD22-A114A/A115A standard.

**Table 25. ESD absolute maximum ratings**

| Symbol         | Ratings                                                | Conditions                | Maximum value <sup>1)</sup>       | Unit |
|----------------|--------------------------------------------------------|---------------------------|-----------------------------------|------|
| $V_{ESD(HBM)}$ | Electro-static discharge voltage (Human Body Model)    | $T_A=+25^{\circ}\text{C}$ | 2000                              | V    |
| $V_{ESD(MM)}$  | Electro-static discharge voltage (Machine Model)       |                           | 200                               |      |
| $V_{ESD(CDM)}$ | Electro-static discharge voltage (Charge Device Model) |                           | 750 on corner pins, 500 on others |      |

**Notes:**

1. Data based on characterization results, not tested in production.

**Static and dynamic latch-up**

- **LU:** 3 complementary static tests are required on 10 parts to assess the latch-up performance. A supply overvoltage (applied to each power supply pin) and a current injection (applied to each input, output and configurable I/O pin) are performed on each sample. This test conforms to the EIA/JESD 78 IC latch-up standard. For more details, refer to the application note AN1181.
- **DLU:** Electro-Static Discharges (one positive then one negative test) are applied to each pin of 3 samples when the micro is running to assess the latch-up performance in dynamic mode. Power supplies are set to the typical values, the oscillator is connected as near as possible to the pins of the micro and the component is put in reset mode. This test conforms to the IEC1000-4-2 and SAEJ1752/3 standards. For more details, refer to the application note AN1181.

**Electrical sensitivities****Table 26. Static and dynamic latch-up**

| Symbol | Parameter              | Conditions                                                                                              | Class <sup>(1)</sup> |
|--------|------------------------|---------------------------------------------------------------------------------------------------------|----------------------|
| LU     | Static latch-up class  | $T_A=+25^{\circ}\text{C}$                                                                               | A                    |
|        |                        | $T_A=+85^{\circ}\text{C}$                                                                               | A                    |
|        |                        | $T_A=+105^{\circ}\text{C}$                                                                              | A                    |
| DLU    | Dynamic latch-up class | $V_{DD}=3.3\text{ V}$ , $f_{OSC4M}=4\text{ MHz}$ , $f_{MCLK}=32\text{ MHz}$ , $T_A=+25^{\circ}\text{C}$ | A                    |

1. Class description: A Class is an STMicroelectronics internal specification. All its limits are higher than the JEDEC specifications, that means when a device belongs to Class A it exceeds the JEDEC standard. B Class strictly covers all the JEDEC criteria (international standard).

### 4.3.5 I/O port pin characteristics

#### General characteristics

Subject to general operating conditions for  $V_{33}$  and  $T_A$  unless otherwise specified. All unused pins must be kept at a fixed voltage: using the output mode of the I/O for example or an external pull-up or pull-down resistor.

**Table 27. I/O static characteristics**

| Symbol                                 | Parameter                                                | Conditions                       | Min         | Typ  | Max         | Unit       |
|----------------------------------------|----------------------------------------------------------|----------------------------------|-------------|------|-------------|------------|
| $V_{IL}$                               | Input low level voltage <sup>1)</sup>                    | CMOS ports                       |             |      | $0.3V_{33}$ | V          |
| $V_{IH}$                               | Input high level voltage <sup>1)</sup>                   |                                  | $0.7V_{33}$ |      |             |            |
| $V_{hys}$                              | Schmitt trigger voltage hysteresis <sup>2)</sup>         |                                  |             | 0.8  |             | V          |
| $V_{IL}$                               | Input low level voltage <sup>1)</sup>                    | P0.15 WAKEUP                     |             | 0.9  | 0.8         | V          |
| $V_{IH}$                               | Input high level voltage <sup>1)</sup>                   |                                  | 2           | 1.35 |             |            |
| $V_{hys}$                              | Schmitt trigger voltage hysteresis <sup>2)</sup>         |                                  |             | 0.4  |             | V          |
| $V_{IL}$                               | Input low level voltage <sup>1)</sup>                    | TTL ports                        |             |      | 0.8         | V          |
| $V_{IH}$                               | Input high level voltage <sup>1)</sup>                   |                                  | 2.0         |      |             |            |
| $I_{INJ(PIN)}$                         | Injected Current on any I/O pin                          |                                  |             |      | $\pm 4$     | mA         |
| $\Sigma I_{INJ(PIN)}$<br><sup>3)</sup> | Total injected current (sum of all I/O and control pins) |                                  |             |      | $\pm 25$    |            |
| $I_{lkg}$                              | Input leakage current <sup>4)</sup>                      | $V_{SS} \leq V_{IN} \leq V_{33}$ |             |      | $\pm 1$     | $\mu A$    |
| $R_{PU}$                               | Weak pull-up equivalent resistor <sup>5)</sup>           | $V_{IN}=V_{SS}$                  | 110         | 150  | 700         | k $\Omega$ |
| $R_{PD}$                               | Weak pull-down equivalent resistor <sup>5)</sup>         | $V_{IN}=V_{33}$                  | 110         | 150  | 700         | k $\Omega$ |
| $C_{IO}$                               | I/O pin capacitance                                      |                                  |             | 5    |             | pF         |

**Notes:**

1. Data based on characterization results, not tested in production.
2. Hysteresis voltage between Schmitt trigger switching levels. Based on characterization results, not tested.
3. When the current limitation is not possible, the  $V_{IN}$  absolute maximum rating must be respected, otherwise refer to  $I_{INJ(PIN)}$  specification. A positive injection is induced by  $V_{IN} > V_{33}$  while a negative injection is induced by  $V_{IN} < V_{SS}$ . Refer to [Section 4.2 on page 35](#) for more details.
4. Leakage could be higher than max. if negative current is injected on adjacent pins.
5. The  $R_{PU}$  pull-up and  $R_{PD}$  pull-down equivalent resistor are based on a resistive transistor (corresponding  $I_{PU}$  and  $I_{PD}$  current characteristics described in [Figure 18](#) to [Figure 19](#)).

Figure 17.  $R_{PU}$  vs.  $V_{33}$  with  $V_{IN}=V_{SS}$

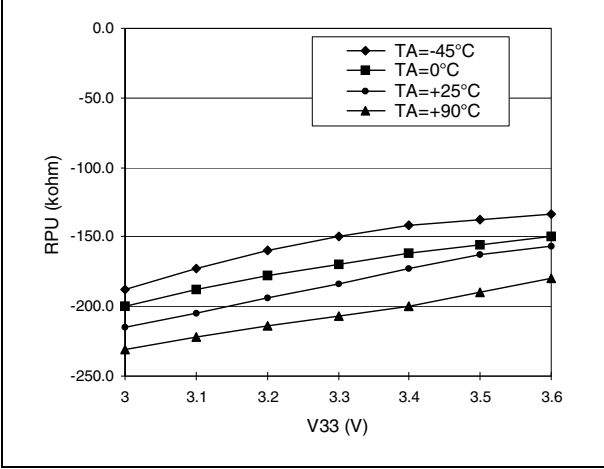


Figure 18.  $I_{PU}$  vs.  $V_{33}$  with  $V_{IN}=V_{SS}$

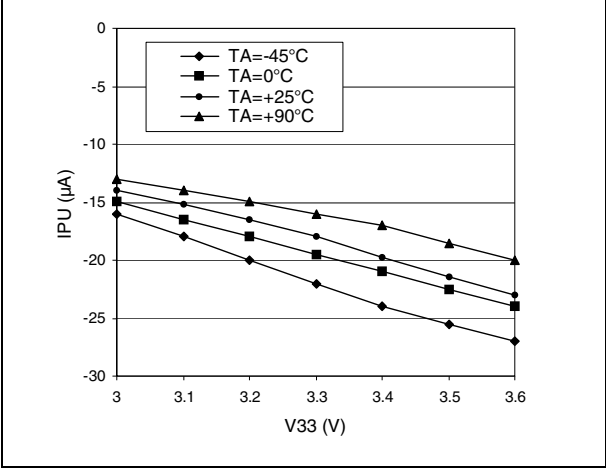


Figure 19.  $R_{PD}$  vs.  $V_{33}$  with  $V_{IN}=V_{33}$

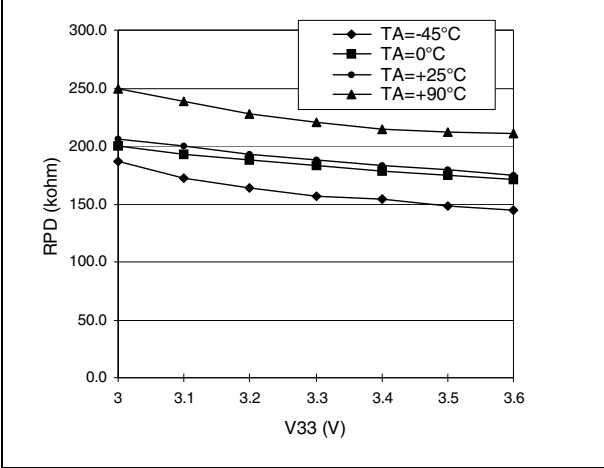
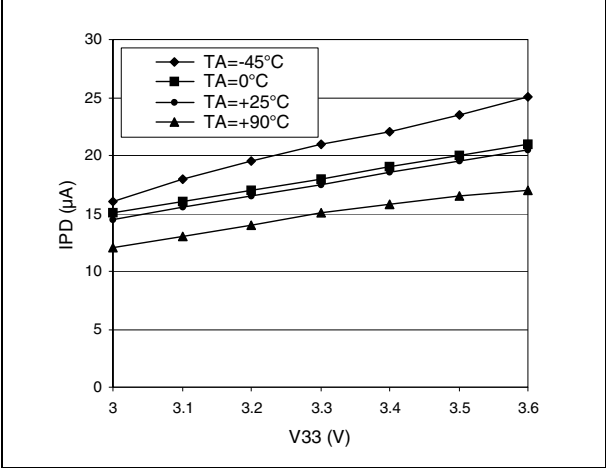


Figure 20.  $I_{PD}$  vs.  $V_{33}$  with  $V_{IN}=V_{33}$



## Output driving current

Subject to general operating conditions for  $V_{33}$  and  $T_A$  unless otherwise specified.

**Table 28. Output driving current**

| I/O type     | Symbol        | Parameter                                                                     | Conditions    | Min          | Max | Unit |
|--------------|---------------|-------------------------------------------------------------------------------|---------------|--------------|-----|------|
| Standard     | $V_{OL}^{1)}$ | Output low level voltage for an I/O pin when 8 pins are sunk at same time     | $I_{IO}=+4mA$ |              | 0.4 | V    |
|              | $V_{OH}^{2)}$ | Output high level voltage for an I/O pin when 4 pins are sourced at same time | $I_{IO}=-4mA$ | $V_{33}-0.8$ |     |      |
| High Current | $V_{OL}^{1)}$ | Output low level voltage for an I/O pin when 8 pins are sunk at same time     | $I_{IO}=+8mA$ |              | 0.4 |      |
|              | $V_{OH}^{2)}$ | Output high level voltage for an I/O pin when 4 pins are sourced at same time | $I_{IO}=-8mA$ | $V_{33}-0.8$ |     |      |

### Notes:

1. The  $I_{IO}$  current sunk must always respect the absolute maximum rating specified in [Table 9](#) and the sum of  $I_{IO}$  (I/O ports and control pins) must not exceed  $I_{VSS}$ .
2. The  $I_{IO}$  current sourced must always respect the absolute maximum rating specified in [Table 9](#) and the sum of  $I_{IO}$  (I/O ports and control pins) must not exceed  $I_{V33}$ .

**Figure 21. Typical  $V_{OL}$  and  $V_{OH}$  at  $V_{33}=3.3V$  (high current ports)**

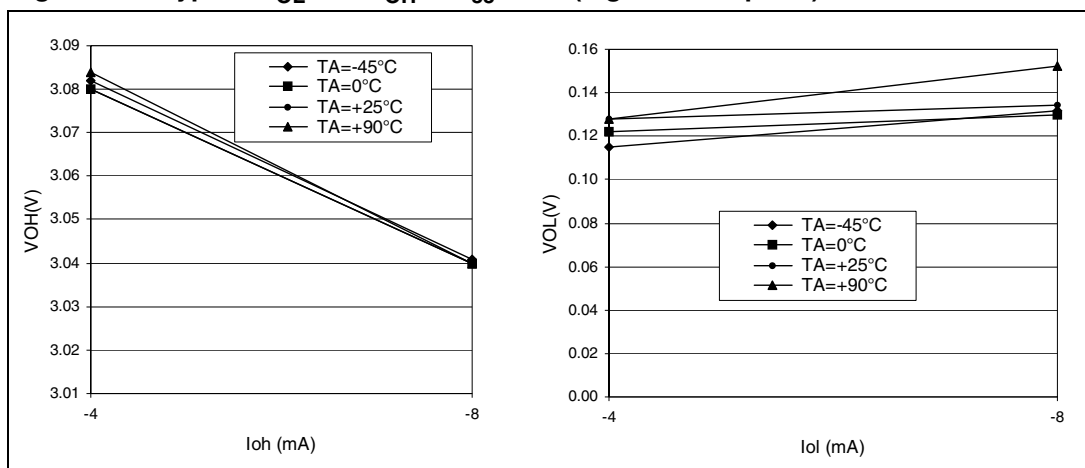


Figure 22. Typical  $V_{OL}$  vs.  $V_{33}$

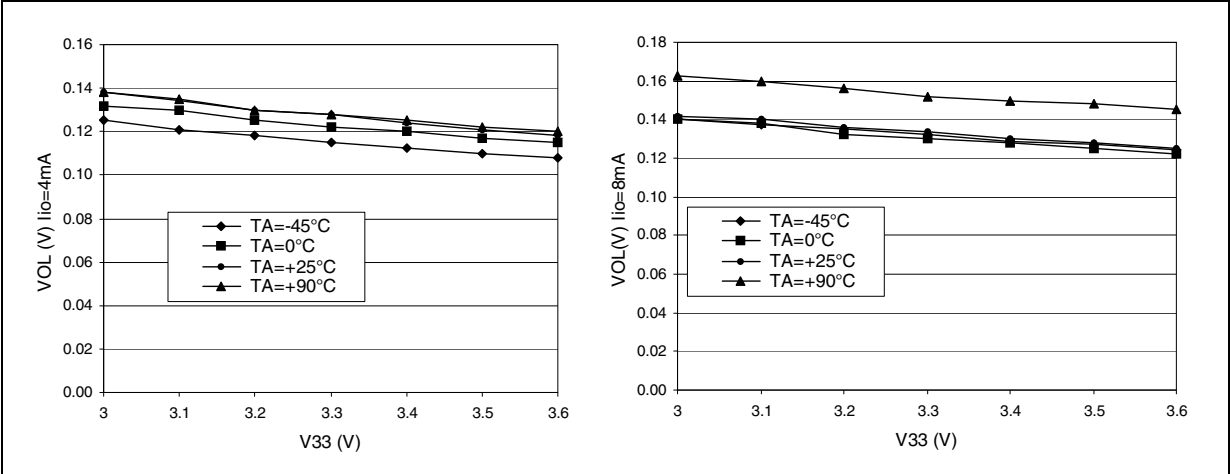
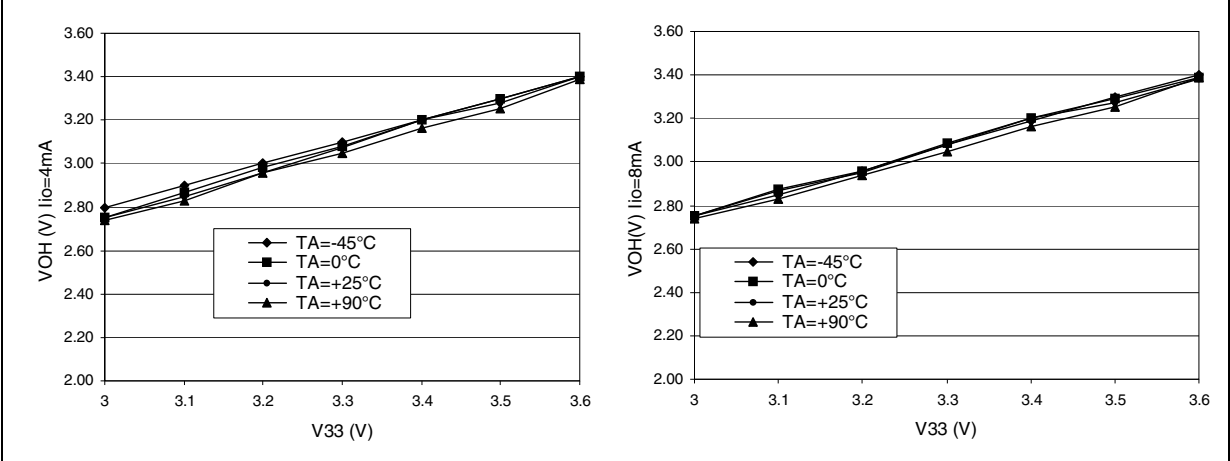


Figure 23. Typical  $V_{OH}$  vs.  $V_{33}$



**RSTIN pin**

The  $\overline{\text{RSTIN}}$  pin input driver is CMOS. A permanent pull-up is present which is the same as  $R_{\text{PU}}$  (see [Table 27 on page 51](#))

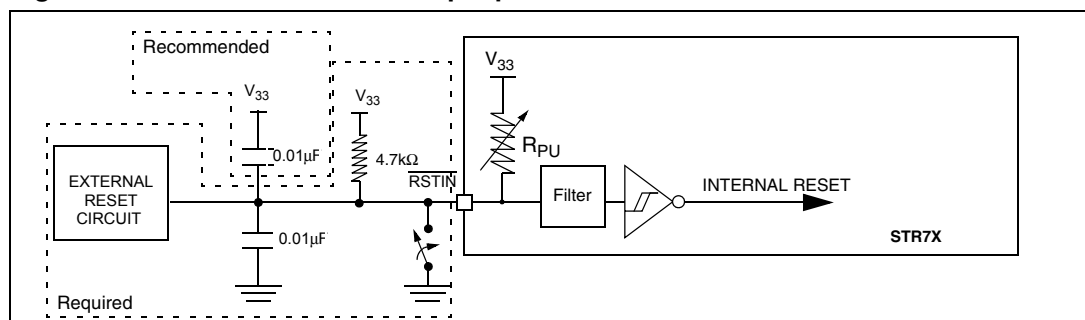
Subject to general operating conditions for  $V_{33}$  and  $T_A$  unless otherwise specified.

**Table 29.  $\overline{\text{RESET}}$  pin characteristics**

| Symbol                         | Parameter                                                        | Conditions | Min | Typ <sup>1)</sup> | Max | Unit          |
|--------------------------------|------------------------------------------------------------------|------------|-----|-------------------|-----|---------------|
| $V_{\text{IL}}(\text{RSTINn})$ | $\overline{\text{RSTIN}}$ Input low level voltage <sup>1)</sup>  |            |     |                   | 0.8 | V             |
| $V_{\text{IH}}(\text{RSTINn})$ | $\overline{\text{RSTIN}}$ Input high level voltage <sup>1)</sup> |            | 2   |                   |     |               |
| $V_{\text{F}}(\text{RSTINn})$  | $\overline{\text{RSTIN}}$ Input filtered pulse <sup>2)</sup>     |            |     |                   | 500 | ns            |
| $V_{\text{NF}}(\text{RSTINn})$ | $\overline{\text{RSTIN}}$ Input not filtered pulse <sup>2)</sup> |            | 1.2 |                   |     | $\mu\text{s}$ |

**Notes:**

1. Data based on characterization results, not tested in production.
- 2) Data guaranteed by design, not tested in production.

**Figure 24. Recommended  $\overline{\text{RSTIN}}$  pin protection. <sup>1)</sup>****Notes:**

1. The  $R_{\text{PU}}$  pull-up equivalent resistor is based on a resistive transistor (corresponding  $I_{\text{PU}}$  current characteristics described in [Figure 18](#)).
2. The reset network protects the device against parasitic resets.
3. The user must ensure that the level on the  $\overline{\text{RSTIN}}$  pin can go below the  $V_{\text{IL}}(\text{RSTINn})$  max. level specified in [Table 29](#). Otherwise the reset will not be taken into account internally.

### 4.3.6 TIM timer characteristics

Subject to general operating conditions for  $V_{33}$ ,  $f_{MCLK}$ , and  $T_A$  unless otherwise specified.

Refer to [Section 4.3.5: I/O port pin characteristics on page 51](#) for more details on the input/output alternate function characteristics (output compare, input capture, external clock, PWM output...).

**Table 30. TIM characteristics**

| Symbol           | Parameter                                                   | Conditions                               | Min   | Typ | Max             | Unit          |
|------------------|-------------------------------------------------------------|------------------------------------------|-------|-----|-----------------|---------------|
| $t_{w(ICAP)in}$  | Input capture pulse time                                    |                                          | 2     |     |                 | $t_{CK\_TIM}$ |
| $t_{res(TIM)}$   | Timer resolution time                                       |                                          | 1     |     |                 | $t_{PCLK2}$   |
|                  |                                                             | $f_{PCLK2} = 30\text{ MHz}$              | 33.3  |     |                 | ns            |
| $f_{EXT}$        | Timer external clock frequency                              | $f_{CK\_TIM(MAX)} = f_{MCLK}$            | 0     |     | $f_{CK\_TIM}/4$ | MHz           |
|                  |                                                             | $f_{CK\_TIM} = f_{MCLK} = 60\text{ MHz}$ | 0     |     | 15              | MHz           |
| $Res_{TIM}$      | Timer resolution                                            |                                          |       |     | 16              | bit           |
| $t_{COUNTER}$    | 16-bit Counter clock period when internal clock is selected |                                          | 1     |     | 65536           | $t_{PCLK2}$   |
|                  |                                                             | $f_{PCLK2} = 30\text{ MHz}$              | 0.033 |     | 2184            | $\mu s$       |
| $T_{MAX\_COUNT}$ | Maximum Possible Count                                      |                                          |       |     | 65536x<br>65536 | $t_{PCLK}$    |
|                  |                                                             | $f_{PCLK2} = 30\text{ MHz}$              |       |     | 143.1           | s             |

### 4.3.7 EMI - external memory interface

Subject to general operating conditions for  $V_{DD}$ ,  $f_{HCLK}$ , and  $T_A$  unless otherwise specified.

The tables below use a variable which is derived from the EMI\_BCONn registers (described in the STR71x Reference Manual) and represents the special characteristics of the programmed memory cycle.

**Table 31. EMI general characteristics**

| Symbol     | Parameter                     | Value                               |
|------------|-------------------------------|-------------------------------------|
| $t_{MCLK}$ | CPU clock period              | $1 / f_{MCLK}$                      |
| $t_C$      | Memory cycle time wait states | $t_{MCLK} \times (1 + [C\_LENGTH])$ |



**Table 32. EMI read operation**

| Symbol    | Parameter                    | Test Conditions                                        | Value             |                      |                   | Unit |
|-----------|------------------------------|--------------------------------------------------------|-------------------|----------------------|-------------------|------|
|           |                              |                                                        | Min <sup>1)</sup> | Typ                  | Max <sup>1)</sup> |      |
| $t_{RCR}$ | Read to CSn Removal Time     | MCLK=50 MHz<br>4 wait states<br>50 pf load on all pins | 19                | $t_{MCLK}$           | 21                | ns   |
| $t_{RP}$  | Read Pulse Time              |                                                        | 98                | $t_C$                | 100               | ns   |
| $t_{RDS}$ | Read Data Setup Time         |                                                        | 22                |                      |                   | ns   |
| $t_{RDH}$ | Read Data Hold Time          |                                                        | 0                 |                      |                   | ns   |
| $t_{RAS}$ | Read Address Setup Time      |                                                        | 27                | $1.5 \cdot t_{MCLK}$ | 33                | ns   |
| $t_{RAH}$ | Read Address Hold Time       |                                                        | 0.65              |                      | 2                 | ns   |
| $t_{RAT}$ | Read Address Turnaround Time |                                                        | 1.9               |                      | 3.25              | ns   |
| $t_{RRT}$ | RDn Turnaround Time          |                                                        | 20                | $t_{MCLK}$           | 21                | ns   |

See [Figure 25](#), [Figure 26](#), [Figure 27](#) and [Figure 28](#) for related timing diagrams.

1. Data based on characterisation results, not tested in production.

**Table 33. EMI write operation**

| Symbol     | Parameter                     | Test conditions                                        | Value             |                      |                   | Unit |
|------------|-------------------------------|--------------------------------------------------------|-------------------|----------------------|-------------------|------|
|            |                               |                                                        | Min <sup>1)</sup> | Typ                  | Max <sup>1)</sup> |      |
| $t_{WCR}$  | WEn to CSn Removal Time       | MCLK=50 MHz<br>3 wait states<br>50 pf load on all pins | 20                | $t_{MCLK}$           | 22.5              | ns   |
| $t_{WP}$   | Write Pulse Time              |                                                        | 77.5              | $t_C$                | 80                | ns   |
| $t_{WDS1}$ | Write Data Setup Time 1       |                                                        | 97                | $t_C + t_{MCLK}$     | 100               | ns   |
| $t_{WDS2}$ | Write Data Setup Time 2       |                                                        | 77                | $t_C$                | 80                | ns   |
| $t_{WDH}$  | Write Data Hold Time          |                                                        | 20                | $t_{MCLK}$           | 23                | ns   |
| $t_{WAS}$  | Write Address Setup Time      |                                                        | 27                | $1.5 \cdot t_{MCLK}$ | 33                | ns   |
| $t_{WAH}$  | Write Address Hold Time       |                                                        | 0.6               |                      | 3                 | ns   |
| $t_{WAT}$  | Write Address Turnaround Time |                                                        | 1.75              |                      | 4.1               | ns   |
| $t_{WWT}$  | WEn Turnaround Time           |                                                        | 20                | $t_{MCLK}$           | 23                | ns   |

See [Figure 29](#), [Figure 30](#), [Figure 31](#) and [Figure 32](#) for related timing diagrams.

1. Data based on characterisation results, not tested in production.

Figure 25. Read cycle timing: 16-bit read on 16-bit memory

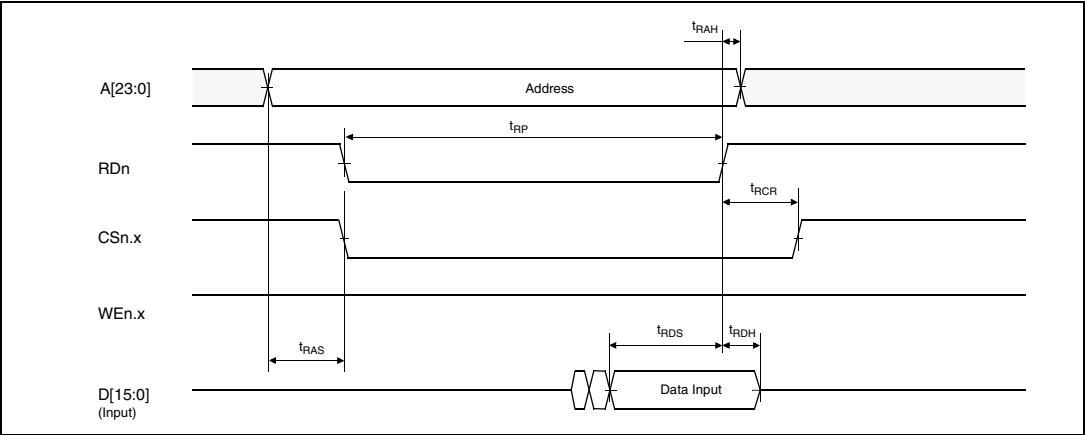
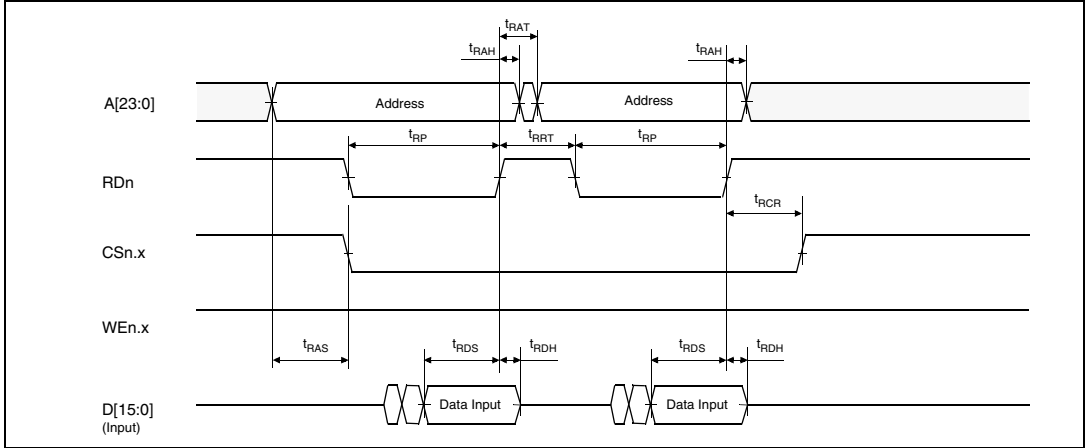


Figure 26. Read cycle timing: 32-bit read on 16-bit memory



See [Table 32](#) for read timing data.

Figure 27. Read cycle timing: 16-bit read on 8-bit memory

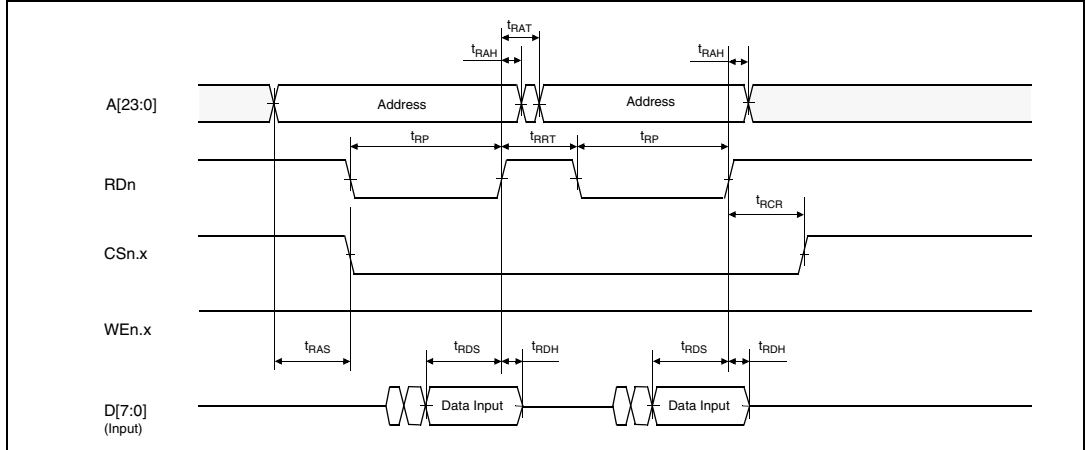
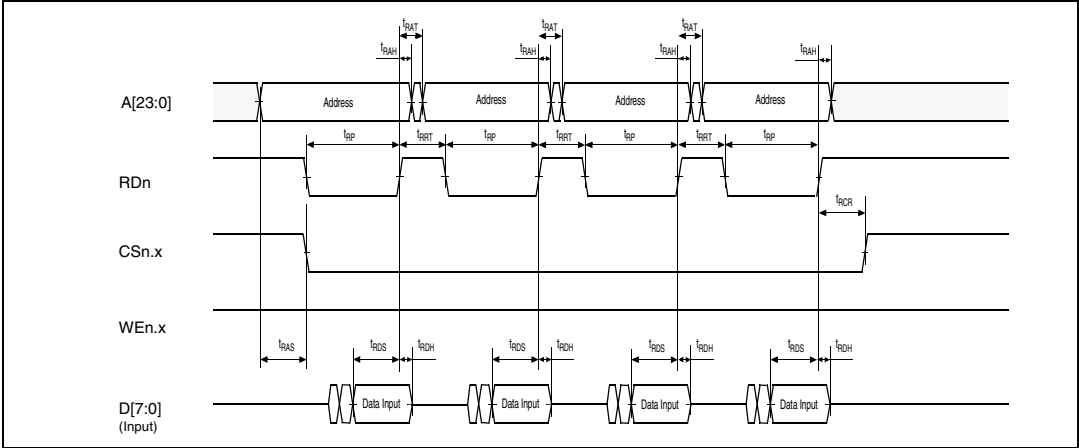


Figure 28. Read cycle timing: 32-bit read on 8-bit memory



See [Table 32](#) for read timing data.

Figure 29. Write cycle timing: 16-bit write on 16-bit memory

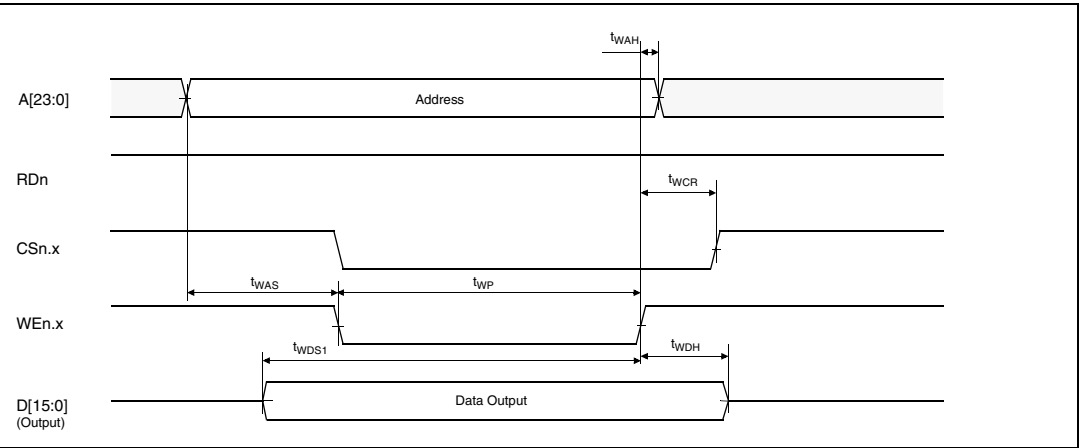
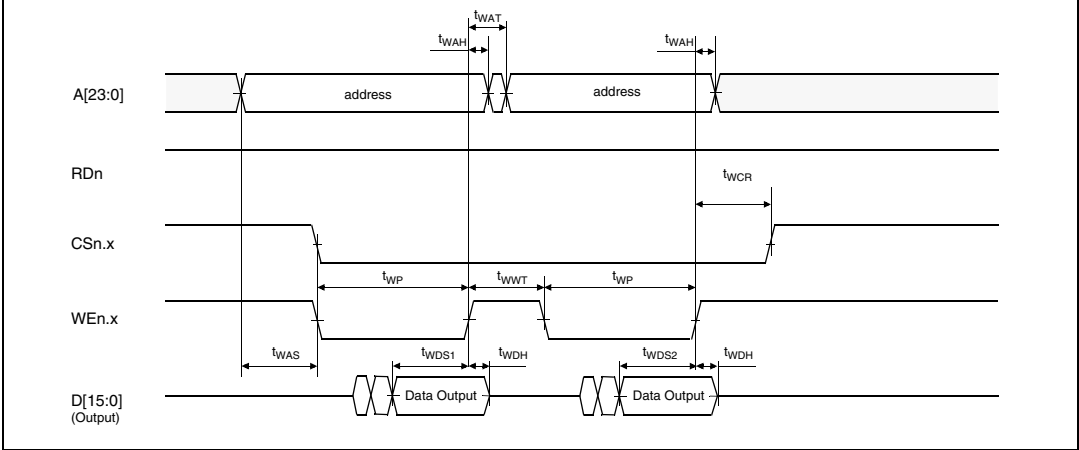


Figure 30. Write cycle timing: 32-bit write on 16-bit memory



See [Table 44](#) for write timing data.

Figure 31. Write cycle timing: 16-bit write on 8-bit memory

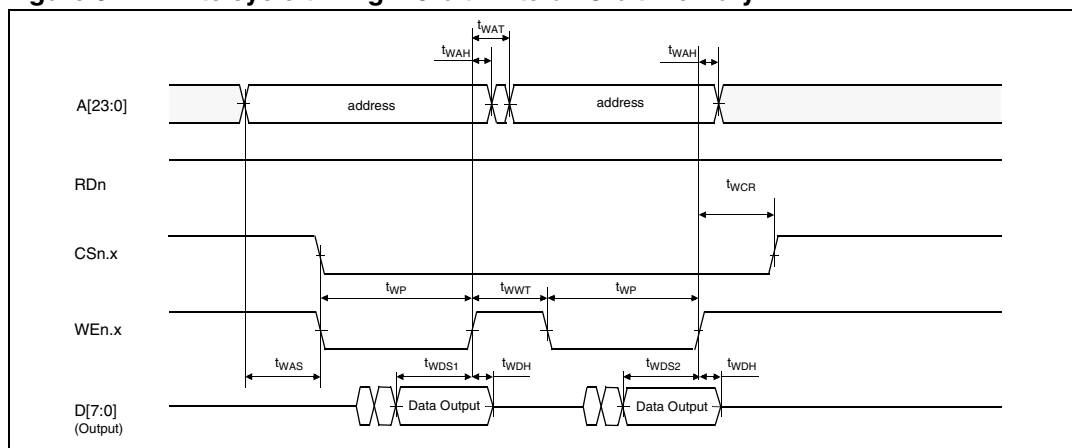
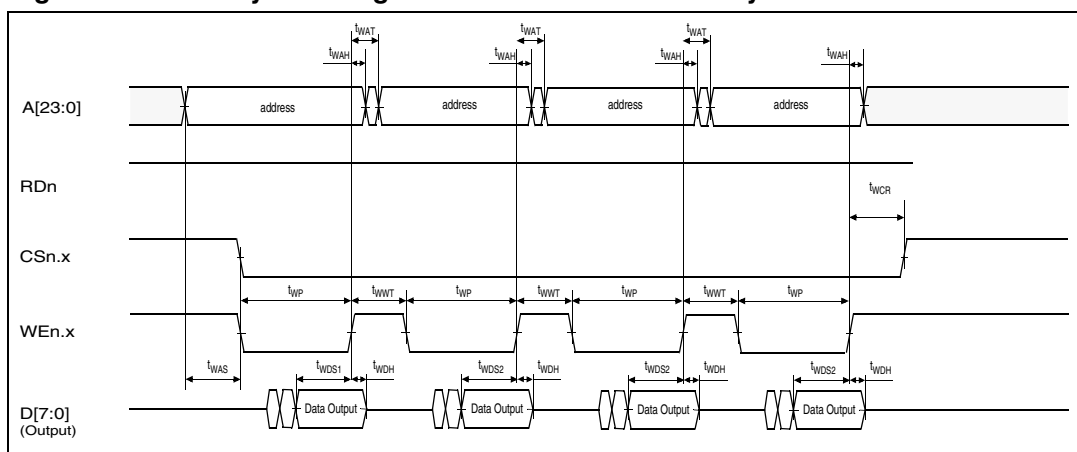


Figure 32. Write cycle timing: 32-bit write on 8-bit memory



See [Table 33](#) for write timing data.

#### 4.3.8 I<sup>2</sup>C - inter IC control interface

Subject to general operating conditions for  $V_{33}$ ,  $f_{PCLK1}$ , and  $T_A$  unless otherwise specified.

The STR7 I<sup>2</sup>C interface meets the requirements of the Standard I<sup>2</sup>C communications protocol described in the following table with the restriction mentioned below:

**Note:** **Restriction:** The I/O pins which SDA and SCL are mapped to are not “True” Open-Drain: when configured as open-drain, the PMOS connected between the I/O pin and  $V_{33}$  is disabled, but it is still present. Also, there is a protection diode between the I/O pin and  $V_{33}$ . Consequently, when using this I<sup>2</sup>C in a multi-master network, it is not possible to power off the STR7X while some another I<sup>2</sup>C master node remains powered on: otherwise, the STR7X will be powered by the protection diode.

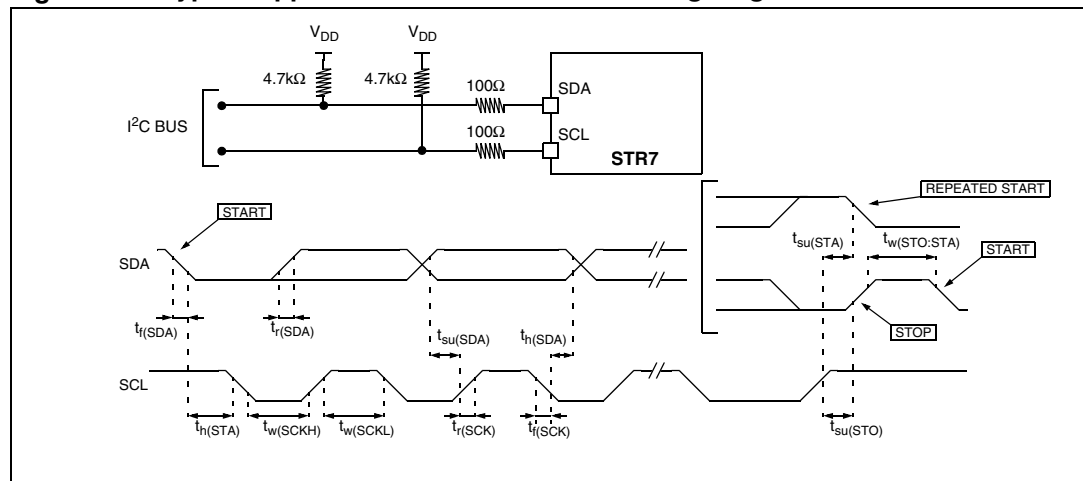
Refer to I/O port characteristics for more details on the input/output alternate function characteristics (SDA and SCL).

Table 34. I2C characteristics

| Symbol                                       | Parameter                               | Standard mode I <sup>2</sup> C |                   | Fast mode I <sup>2</sup> C <sup>5)</sup> |                   | Unit |
|----------------------------------------------|-----------------------------------------|--------------------------------|-------------------|------------------------------------------|-------------------|------|
|                                              |                                         | Min <sup>1)</sup>              | Max <sup>1)</sup> | Min <sup>1)</sup>                        | Max <sup>1)</sup> |      |
| t <sub>w</sub> (SCLL)                        | SCL clock low time                      | 4.7                            |                   | 1.3                                      |                   | μs   |
| t <sub>w</sub> (SCLH)                        | SCL clock high time                     | 4.0                            |                   | 0.6                                      |                   |      |
| t <sub>su</sub> (SDA)                        | SDA setup time                          | 250                            |                   | 100                                      |                   | ns   |
| t <sub>h</sub> (SDA)                         | SDA data hold time                      | 0 <sup>3)</sup>                |                   | 0 <sup>2)</sup>                          | 900 <sup>3)</sup> |      |
| t <sub>r</sub> (SDA)<br>t <sub>r</sub> (SCL) | SDA and SCL rise time                   |                                | 1000              | 20+0.1C <sub>b</sub>                     | 300               |      |
| t <sub>f</sub> (SDA)<br>t <sub>f</sub> (SCL) | SDA and SCL fall time                   |                                | 300               | 20+0.1C <sub>b</sub>                     | 300               |      |
| t <sub>h</sub> (STA)                         | START condition hold time               | 4.0                            |                   | 0.6                                      |                   | μs   |
| t <sub>su</sub> (STA)                        | Repeated START condition setup time     | 4.7                            |                   | 0.6                                      |                   |      |
| t <sub>su</sub> (STO)                        | STOP condition setup time               | 4.0                            |                   | 0.6                                      |                   | μs   |
| t <sub>w</sub> (STO:STA)                     | STOP to START condition time (bus free) | 4.7                            |                   | 1.3                                      |                   | μs   |
| C <sub>b</sub>                               | Capacitive load for each bus line       |                                | 400               |                                          | 400               | pF   |

**Notes:**

1. Data based on standard I<sup>2</sup>C protocol requirement, not tested in production.
2. The device must internally provide a hold time of at least 300 ns for the SDA signal in order to bridge the undefined region of the falling edge of SCL.
3. The maximum hold time t<sub>h</sub>(SDA) is not applicable.
4. Measurement points are done at CMOS levels: 0.3xV<sub>DD</sub> and 0.7xV<sub>DD</sub>.
5. f<sub>CLK1</sub>, must be at least 8 MHz to achieve max fast I<sup>2</sup>C speed (400 kHz).
6. The following table gives the values to be written in the I2CCCR register to obtain the required I<sup>2</sup>C SCL line frequency.

**Figure 33. Typical application with I<sup>2</sup>C bus and timing diagram****Table 35. SCL Frequency Table ( $f_{PCLK1}=8\text{ MHz}$ ,  $V_{33} = 3.3\text{ V}$ )**

| $f_{SCL}$<br>(kHz) | I2CCCR Value     |
|--------------------|------------------|
|                    | $R_p=4.7k\Omega$ |
| 400                | 83               |
| 300                | 85h              |
| 200                | 8Ah              |
| 100                | 24h              |
| 50                 | 4Ch              |
| 20                 | C4h              |

**Legend:** $R_p$  = External pull-up resistance $f_{SCL}$  = I<sup>2</sup>C speed

NA = Not achievable

*Note: For speeds around 200 kHz, achieved speed can have  $\pm 5\%$  tolerance**For other speed ranges, achieved speed can have  $\pm 2\%$  tolerance**The above variations depend on the accuracy of the external components used.*

### 4.3.9 BSPI - buffered serial peripheral interface

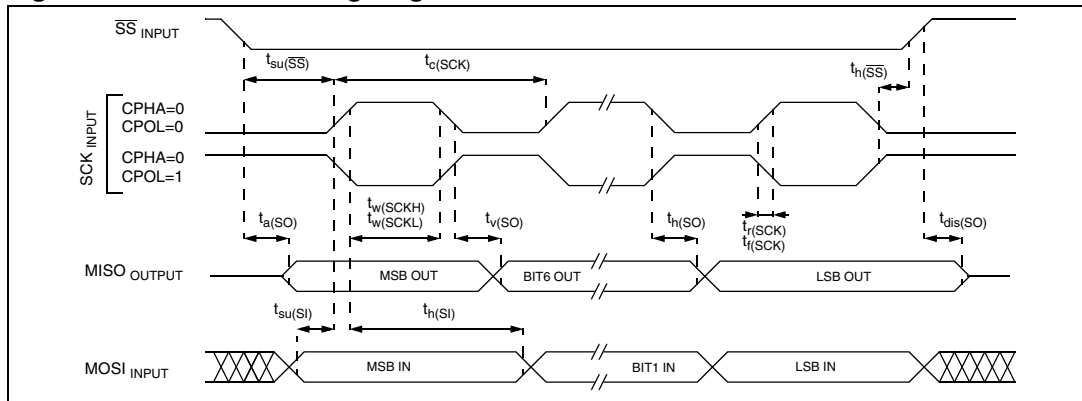
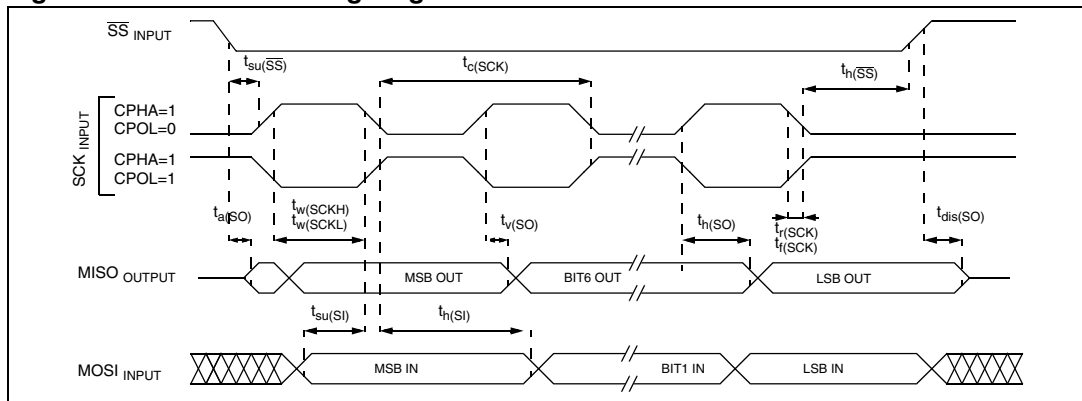
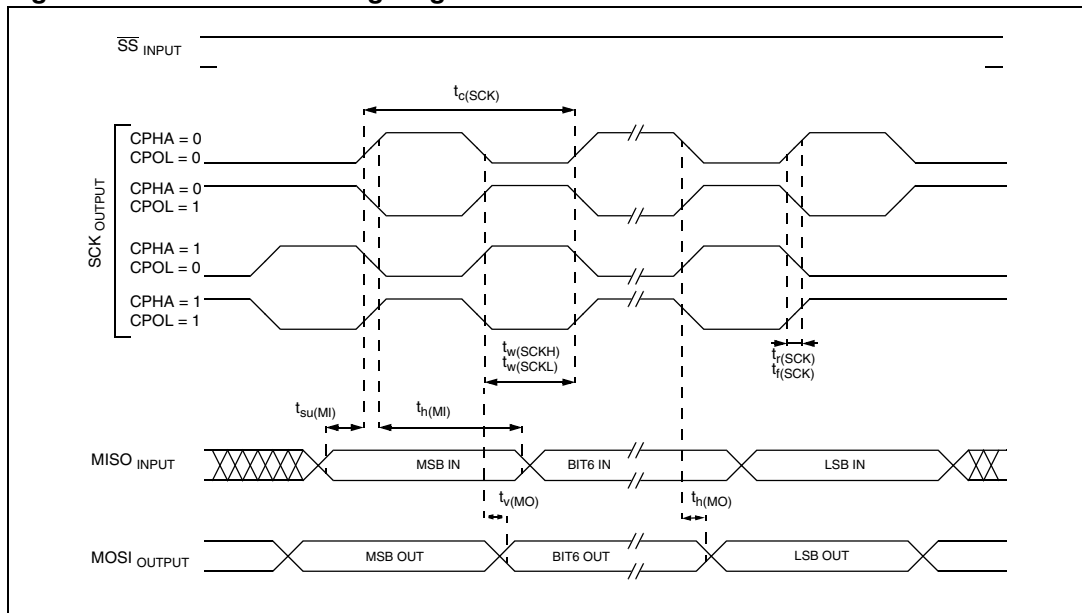
Subject to general operating conditions for  $V_{DD}$ ,  $T_A$  and  $f_{PCLK1}$ , unless otherwise specified.

Refer to [I/O port pin characteristics on page 51](#) for more details on the input/output alternate function characteristics ( $\overline{SS}$ , SCK, MOSI, MISO).

**Table 36. BSPI characteristics**

| Symbol                                   | Parameter                    | Conditions                                            | Min                                          | Max                         | Unit |
|------------------------------------------|------------------------------|-------------------------------------------------------|----------------------------------------------|-----------------------------|------|
| $f_{SCK}$<br>$1/t_c(SCK)$                | SPI clock frequency          | Master                                                | $f_{PCLK1}/254$                              | $f_{PCLK1}/6$<br>5.5        | MHz  |
|                                          |                              | Slave                                                 | 0                                            | $f_{PCLK1}/8$<br>3.3        |      |
| $t_r(SCK)$<br>$t_f(SCK)$                 | SPI clock rise and fall time | capacitive charge<br>$C=50$ pF                        |                                              | 14                          | ns   |
| $t_{su}(\overline{SS})^{(1)}$            | $\overline{SS}$ setup time   | Slave                                                 | 0                                            |                             |      |
| $t_h(\overline{SS})^{(1)}$               | $\overline{SS}$ hold time    | Slave                                                 | 0                                            |                             |      |
| $t_w(SCKH)^{(1)}$<br>$t_w(SCKL)^{(1)}$   | SCK high and low time        | Master $f_{PCLK1}=33$ MHz,<br>presc = 6               | 73                                           |                             |      |
| $t_{su(MI)}^{(1)}$<br>$t_{su(SI)}^{(1)}$ | Data input setup time        | Master<br>Slave                                       | 7<br>0                                       |                             |      |
| $t_h(MI)^{(1)(2)}$<br>$t_h(SI)^{(1)(2)}$ | Data input hold time         | Master<br>Slave                                       | $1 \times t_{PCLK1}$<br>$2 \times t_{PCLK1}$ |                             |      |
| $t_h(MI)^{(1)}$<br>$t_h(SI)^{(1)}$       | Data input hold time         | Master $f_{PCLK1}=33$ MHz<br>Slave $f_{PCLK1}=33$ MHz | 30<br>60                                     |                             |      |
| $t_{a(SO)}^{(1)(3)}$                     | Data output access time      | Slave                                                 | 0                                            | $1.5 \times t_{PCLK1} + 42$ |      |
|                                          |                              | Slave $f_{PCLK1}=33$ MHz                              | 0                                            | 87                          |      |
| $t_{dis(SO)}^{(1)(4)}$                   | Data output disable time     | Slave                                                 | 0                                            | 42                          |      |
| $t_{v(SO)}^{(1)(2)}$                     | Data output valid time       | Slave (after enable edge)                             |                                              | $3 \times t_{PCLK1} + 45$   |      |
|                                          |                              | $f_{PCLK1}=33$ MHz                                    |                                              | 135                         |      |
| $t_h(SO)^{(1)}$                          | Data output hold time        | Slave (after enable edge)                             | 0                                            |                             |      |
| $t_{v(MO)}^{(1)(2)}$                     | Data output valid time       | Master (after enable edge)                            |                                              | $2 \times t_{PCLK1} + 12$   |      |
|                                          |                              | $f_{PCLK1}=33$ MHz                                    |                                              | 72                          |      |
| $t_h(MO)^{(1)}$                          | Data output hold time        | Master (after enable edge)                            | 0                                            |                             |      |

1. Data based on design simulation and/or characterisation results, not tested in production.
2. Depends on  $f_{PCLK1}$ . For example, if  $f_{PCLK1}=8$  MHz, then  $t_{PCLK1} = 1/f_{PCLK1} = 125$  ns and  $t_{v(MO)} = 255$  ns.
3. Min. time is the minimum time to drive the output and the max. time is the maximum time to validate the data.
4. Min time is the minimum time to invalidate the output and the max time is the maximum time to put the data in Hi-Z.

**Figure 34. SPI slave timing diagram with CPHA=0<sup>1)</sup>****Figure 35. SPI slave timing diagram with CPHA=1<sup>1)</sup>****Figure 36. SPI master timing diagram<sup>1)</sup>**

1. Measurement points are done at CMOS levels:  $0.3 \times V_{33}$  and  $0.7 \times V_{33}$



### 4.3.10 USB characteristics

The USB interface is USB-IF certified (Full Speed).

**Table 37. USB startup time**

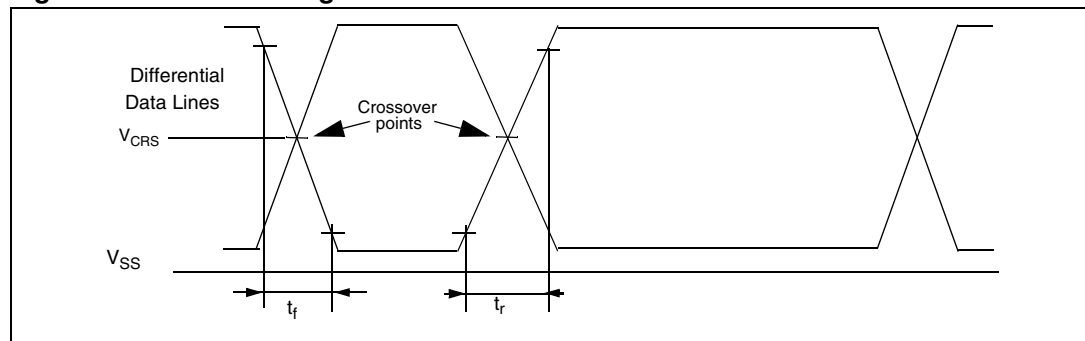
| Symbol               | Parameter                    | Conditions | Max | Unit          |
|----------------------|------------------------------|------------|-----|---------------|
| $t_{\text{STARTUP}}$ | USB transceiver startup time |            | 1   | $\mu\text{s}$ |

**Table 38. USB DC characteristics**

| Symbol          | Parameter                       | Conditions                                                | Min. <sup>(1)(2)</sup> | Max. <sup>(1)(2)</sup> | Unit |
|-----------------|---------------------------------|-----------------------------------------------------------|------------------------|------------------------|------|
| Input Levels    |                                 |                                                           |                        |                        |      |
| V <sub>DI</sub> | Differential Input Sensitivity  | I(DP, DM)                                                 | 0.2                    |                        | V    |
| V <sub>CM</sub> | Differential Common Mode Range  | Includes V <sub>DI</sub> range                            | 0.8                    | 2.5                    |      |
| V <sub>SE</sub> | Single Ended Receiver Threshold |                                                           | 1.3                    | 2.0                    |      |
| Output Levels   |                                 |                                                           |                        |                        |      |
| V <sub>OL</sub> | Static Output Level Low         | R <sub>L</sub> of 1.5 kΩ to 3.6V <sup>(3)</sup>           |                        | 0.3                    | V    |
| V <sub>OH</sub> | Static Output Level High        | R <sub>L</sub> of 15 kΩ to V <sub>SS</sub> <sup>(3)</sup> | 2.8                    | 3.6                    |      |

1. All the voltages are measured from the local ground potential.
2. It is important to be aware that the DP/DM pins are not 5 V tolerant. As a consequence, in case of a shortcut with Vbus (typ: 5.0V), the protection diodes of the DP/DM pins will be direct biased. This will not damage the device if not more than 50 mA is sunk for longer than 24 hours but the reliability may be affected.
3.  $R_L$  is the load connected on the USB drivers

**Figure 37. USB: data signal rise and fall time**



**Table 39. USB: Full speed driver electrical characteristics**

| Symbol           | Parameter                       | Conditions  | Min | Max | Unit |
|------------------|---------------------------------|-------------|-----|-----|------|
| $t_r$            | Rise time <sup>(1)</sup>        | $C_L=50$ pF | 4   | 20  | ns   |
| $t_f$            | Fall Time <sup>(1)</sup>        | $C_L=50$ pF | 4   | 20  | ns   |
| $t_{\text{rfm}}$ | Rise/ Fall Time matching        | $t_r/t_f$   | 90  | 110 | %    |
| $V_{\text{CRS}}$ | Output signal Crossover Voltage |             | 1.3 | 2.0 | V    |

1. Measured from 10% to 90% of the data signal. For more detailed information, please refer to USB Specification - Chapter 7 (version 2.0).

### 4.3.11 ADC characteristics

Subject to general operating conditions for  $AV_{DD}$ ,  $f_{PCLK2}$ , and  $T_A$  unless otherwise specified.

**Table 40. ADC characteristics**

| Symbol     | Parameter                                       | Conditions                                                       | Min                         | Typ <sup>1)</sup> | Max | Unit      |
|------------|-------------------------------------------------|------------------------------------------------------------------|-----------------------------|-------------------|-----|-----------|
| $f_{MOD}$  | Modulator Oversampling frequency                |                                                                  |                             |                   | 2.1 | MHz       |
| $V_{AIN}$  | Conversion voltage range <sup>2)3)</sup>        |                                                                  | 0                           |                   | 2.5 | V         |
| $I_{lkg}$  | Negative input leakage current on analog pins   | $V_{IN} < V_{SS}$ , $ I_{IN}  < 400\mu A$ on adjacent analog pin |                             | 5                 | 6   | $\mu A$   |
| PBR        | Passband Ripple                                 |                                                                  |                             |                   | 0.1 | dB        |
| SINAD      | S/N and Distortion                              |                                                                  | 56                          | 63                |     | dB        |
| THD        | Total Harmonic Distortion                       |                                                                  | 60                          | 74                |     | dB        |
| $Z_{IN}$   | Input Impedance                                 | $f_{MOD} = 2\text{ MHz}$                                         | 1                           |                   |     | $M\Omega$ |
| $C_{ADC}$  | Internal sample and hold capacitor              |                                                                  |                             |                   | 3.2 | pF        |
| $t_{CONV}$ | Total Conversion time (including sampling time) |                                                                  | 2048/<br>$f_{MOD}$<br>(max) |                   |     |           |
| $I_{ADC}$  | Normal mode                                     | $T_A = 27\text{ }^{\circ}C$                                      |                             | 2.5               | 3.0 | mA        |
|            | Standby mode                                    | $T_A = 27\text{ }^{\circ}C$                                      |                             |                   | 1   | $\mu A$   |

**Notes:**

1. Unless otherwise specified, typical data are based on  $T_A = 25^{\circ}C$  and  $AV_{DD} - AV_{SS} = 3.3V$ . They are given only as design guidelines and are not tested.
2. Any added external serial resistor will downgrade the ADC accuracy (especially for resistance greater than  $10k\Omega$ ). Data based on characterization results, not tested in production.
3. Calibration is needed once after each power-up.

Table 41. ADC accuracy with  $f_{PCLK2} = 20\text{ MHz}$ ,  $f_{ADC} = 10\text{ MHz}$ ,  $AV_{DD} = 3.3\text{ V}$ 

| Symbol         | Parameter                                             | Conditions                                                                                                                             | Min  | Typ  | Max  | Unit         |
|----------------|-------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------|------|------|------|--------------|
| ADC_DATA(0V)   | Converted code when $A_{IN} = 0V$ <sup>1)</sup>       |                                                                                                                                        | 2370 |      | 2565 | Decimal code |
| ADC_DATA(2.5V) | Converted code when $A_{IN} = 2.5V$ <sup>1)</sup>     |                                                                                                                                        | 1480 |      | 1680 |              |
| VCM            | Center voltage of Sigma-Delta Modulator <sup>1)</sup> |                                                                                                                                        | 1.23 | 1.25 | 1.30 | V            |
| TUE            | Total unadjusted error                                | In this type of ADC, calibration is necessary to correct gain error and offset errors. Once calibrated, the TUE is limited to the ILE. |      |      |      |              |
| $ E_D $        | Differential linearity error <sup>1)</sup>            |                                                                                                                                        |      | 1.96 | 2.19 | LSB          |
| $ E_L $        | Integral linearity error <sup>1)</sup>                |                                                                                                                                        |      | 2.36 | 3.95 |              |

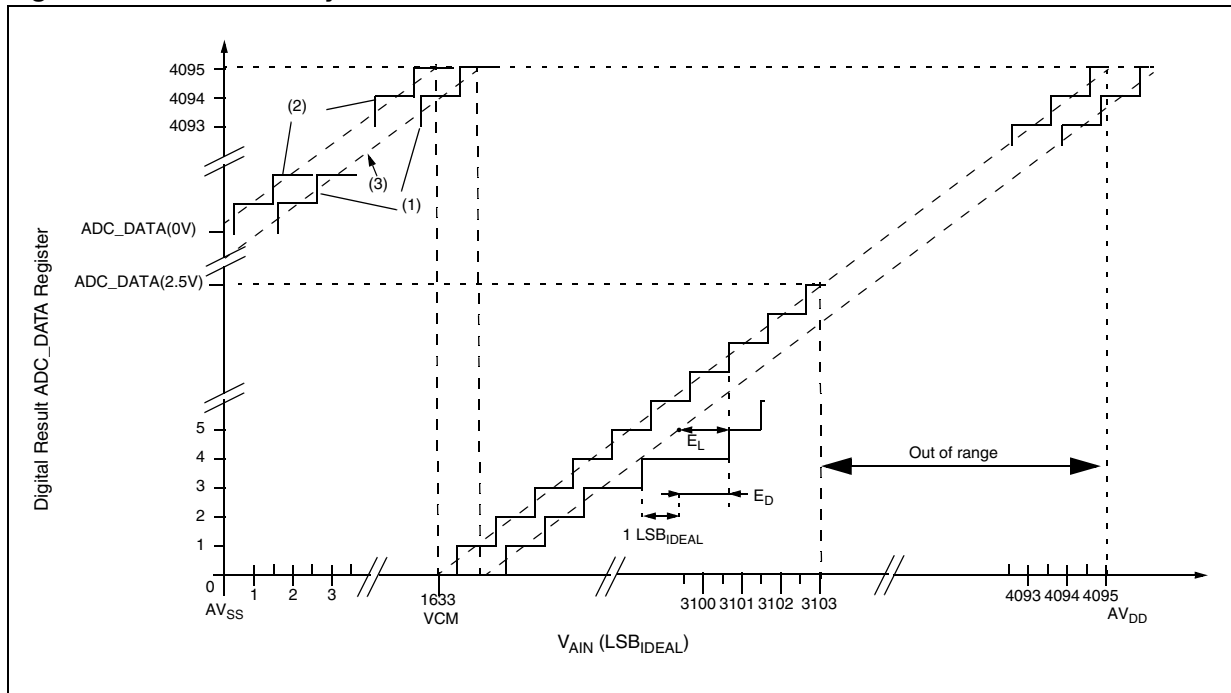
Data are based on characterisation and are not tested in production.

#### ADC Accuracy vs. Negative Injection Current

Injecting negative current on any of the standard (non-robust) analog input pins should be avoided as this significantly reduces the accuracy of the conversion being performed on another analog input. It is recommended to add a Schottky diode (pin to ground) to standard analog pins which may potentially inject negative current. The effect of negative injection current on robust pins is specified in [Section 4.3.5](#).

Any positive injection current within the limits specified for  $I_{INJ(PIN)}$  and  $\Sigma I_{INJ(PIN)}$  in [Section 4.3.5](#) does not affect the ADC accuracy.

Figure 38. ADC accuracy characteristics



1. Example of an actual transfer curve
2. The ideal transfer curve
3. End point correlation line

#### Legend for *Figure 38*

**ED**=Differential Linearity Error: maximum deviation between actual steps and the ideal one.  
**EL**=Integral Linearity Error: maximum deviation between any actual transition and the end point correlation line.

#### Equation 1

$$1\text{LSB}_{\text{IDEAL}} = \frac{\text{AVDD} - \text{AVSS}}{4095}$$

### Analog power supply and reference pins

The  $AV_{DD}$  and  $AV_{SS}$  pins are the analog power supply of the A/D converter cell. They act as the high and low reference voltages for the conversion.

Separation of the digital and analog power pins allow board designers to improve A/D performance. Conversion accuracy can be impacted by voltage drops and noise in the event of heavily loaded or badly decoupled power supply lines (see: [General PCB design guidelines](#)).

### General PCB design guidelines

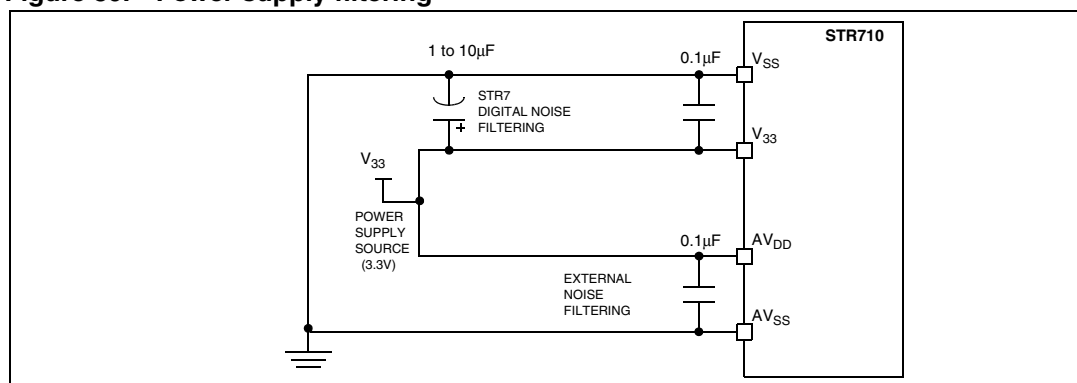
To obtain best results, some general design and layout rules should be followed when designing the application PCB to shield the noise-sensitive, analog physical interface from noise-generating CMOS logic signals.

- Use separate digital and analog planes. The analog ground plane should be connected to the digital ground plane via a single point on the PCB.
- Filter power to the analog power planes. It is recommended to connect capacitors, with good high frequency characteristics, between the power and ground lines, placing 0.1  $\mu\text{F}$  and optionally, if needed 10 pF capacitors as close as possible to the STR7 power supply pins and a 1 to 10  $\mu\text{F}$  capacitor close to the power source (see [Figure 39](#)).
- The analog and digital power supplies should be connected in a star network. Do not use a resistor, as  $AV_{DD}$  is used as a reference voltage by the A/D converter and any resistance would cause a voltage drop and a loss of accuracy.
- Properly place components and route the signal traces on the PCB to shield the analog inputs. Analog signals paths should run over the analog ground plane and be as short as possible. Isolate analog signals from digital signals that may switch while the analog inputs are being sampled by the A/D converter. Do not toggle digital outputs near the A/D input being converted.

### Software filtering of spurious conversion results

For EMC performance reasons, it is recommended to filter A/D conversion outliers using software filtering techniques.

**Figure 39. Power supply filtering**



5 Package characteristics

5.1 Package mechanical data

Figure 40. 64-Pin low profile quad flat package (10x10)

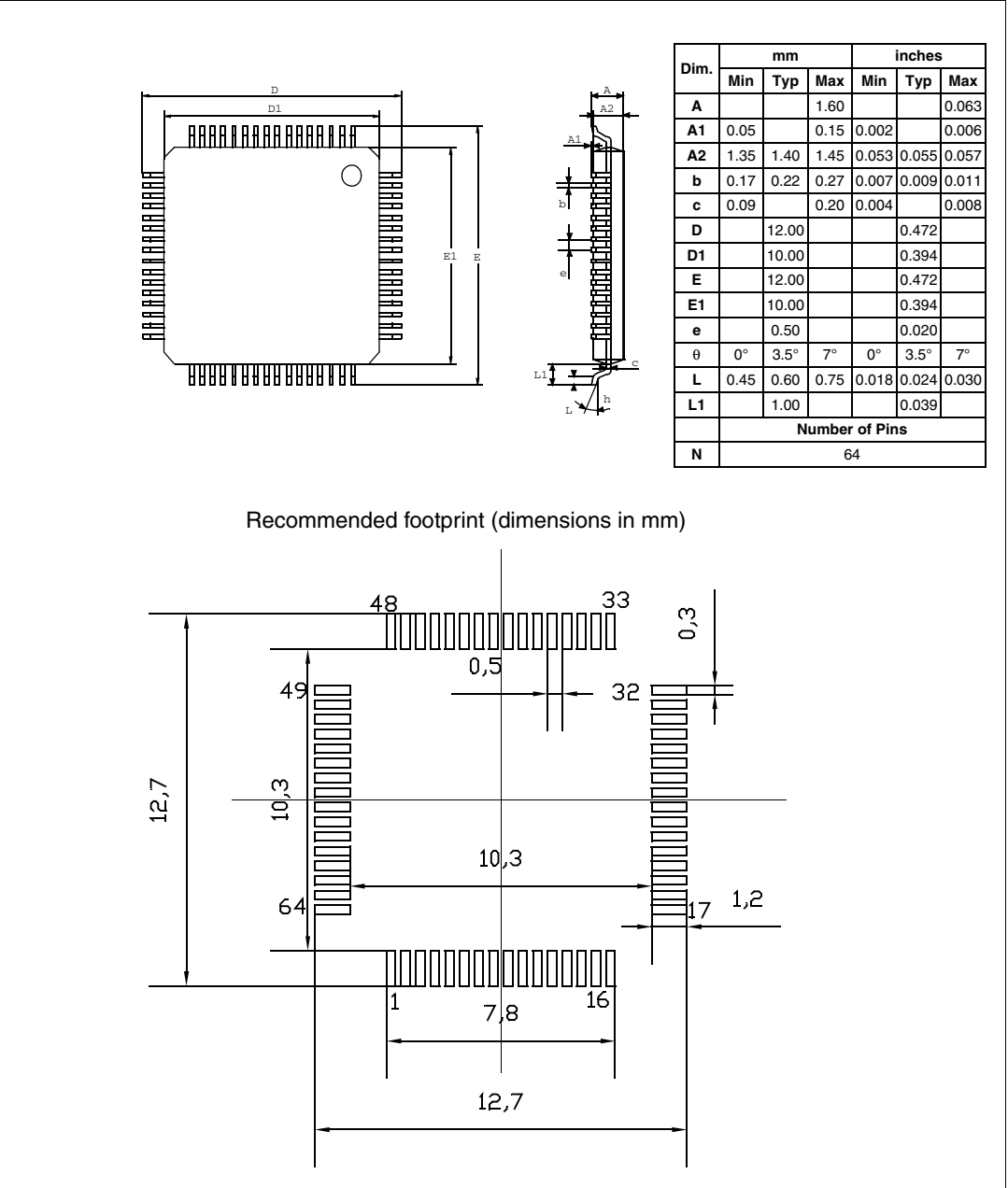


Figure 41. 144-Pin low profile quad flat package

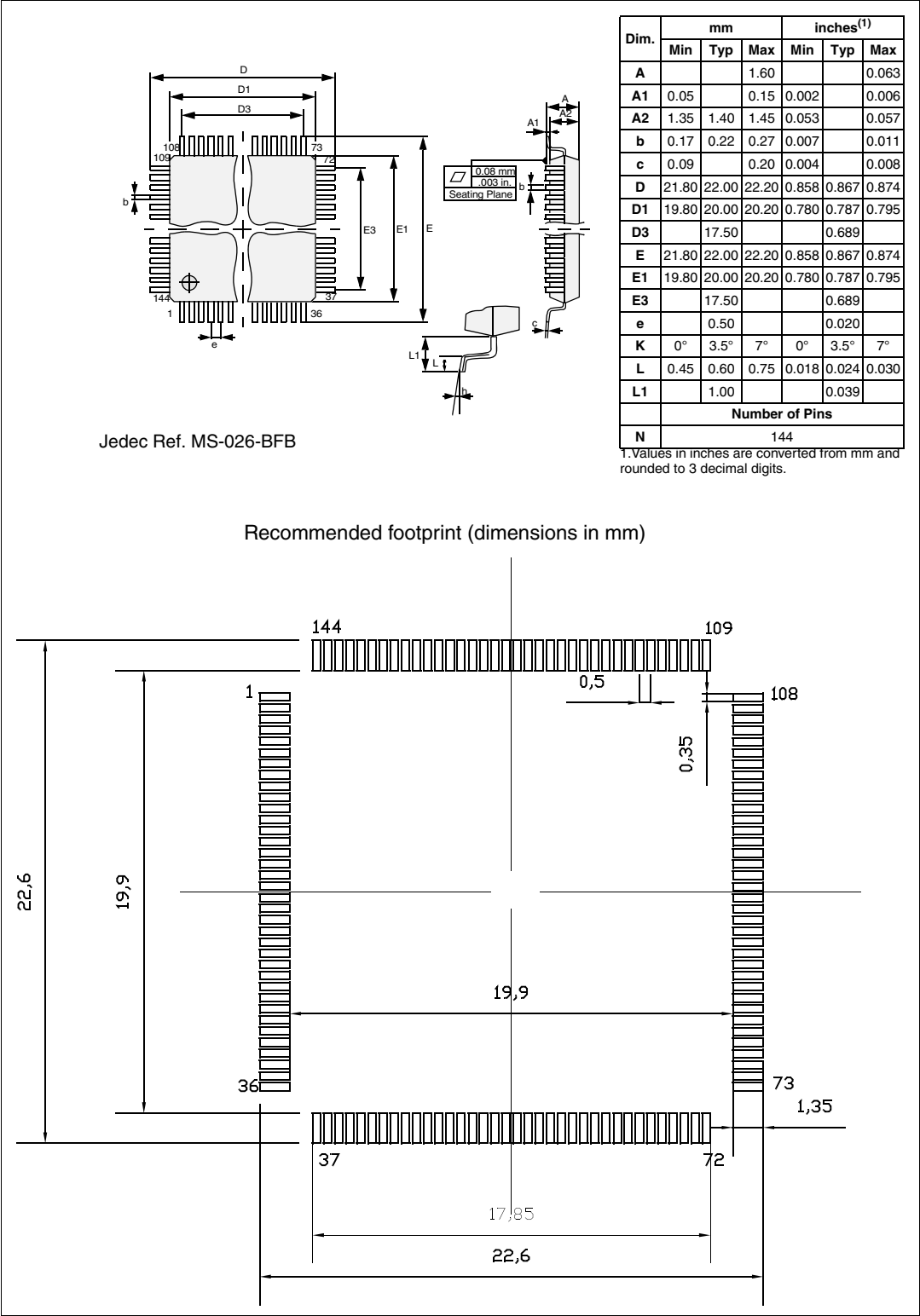


Figure 42. 64-Low profile fine pitch ball grid array package

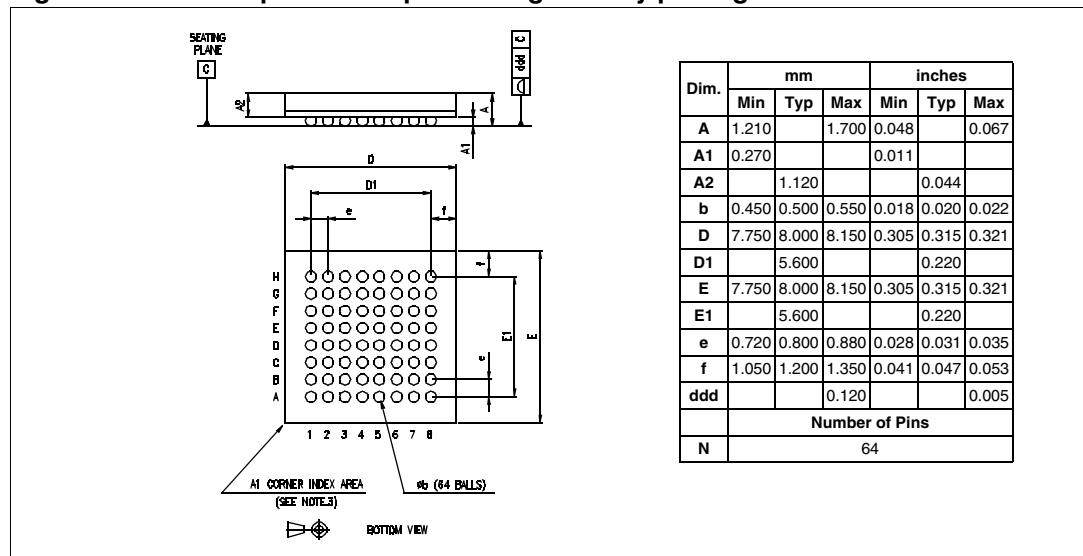


Figure 43. 144-low profile fine pitch ball grid array package

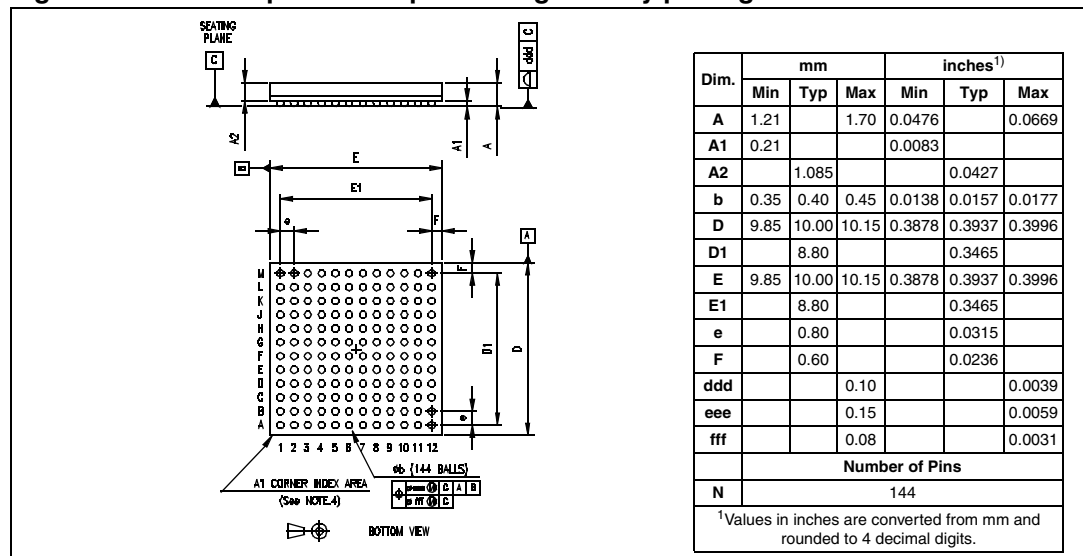
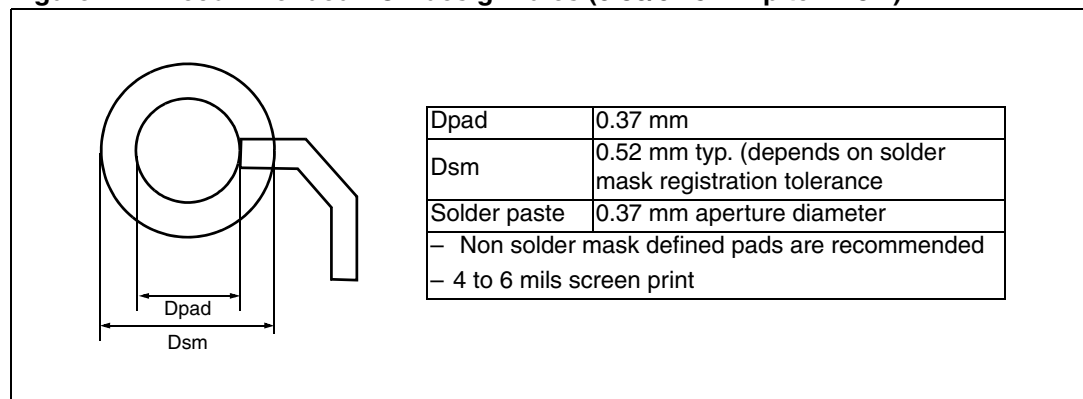


Figure 44. Recommended PCB design rules (0.80/0.75mm pitch BGA)





## 5.2 Thermal characteristics

The average chip-junction temperature,  $T_J$ , in degrees Celsius, may be calculated using the following equation:

$$T_J = T_A + (P_D \times \Theta_{JA}) \quad (1)$$

Where:

- $T_A$  is the Ambient Temperature in °C,
- $\Theta_{JA}$  is the Package Junction-to-Ambient Thermal Resistance, in °C/W,
- $P_D$  is the sum of  $P_{INT}$  and  $P_{I/O}$  ( $P_D = P_{INT} + P_{I/O}$ ),
- $P_{INT}$  is the product of  $I_{DD}$  and  $V_{DD}$ , expressed in Watts. This is the Chip Internal Power.

$P_{I/O}$  represents the Power Dissipation on Input and Output Pins;

Most of the time for the application  $P_{I/O} < P_{INT}$  and can be neglected. On the other hand,  $P_{I/O}$  may be significant if the device is configured to drive continuously external modules and/or memories.

An approximate relationship between  $P_D$  and  $T_J$  (if  $P_{I/O}$  is neglected) is given by:

$$P_D = K / (T_J + 273^\circ\text{C}) \quad (2)$$

Therefore (solving equations 1 and 2):

$$K = P_D \times (T_A + 273^\circ\text{C}) + \Theta_{JA} \times P_D^2 \quad (3)$$

where:

K is a constant for the particular part, which may be determined from equation (3) by measuring  $P_D$  (at equilibrium) for a known  $T_A$ . Using this value of K, the values of  $P_D$  and  $T_J$  may be obtained by solving equations (1) and (2) iteratively for any value of  $T_A$ .

**Table 42. Thermal characteristics**

| Symbol        | Parameter                                                                   | Value | Unit |
|---------------|-----------------------------------------------------------------------------|-------|------|
| $\Theta_{JA}$ | Thermal Resistance Junction-Ambient<br>LQFP 144 - 20 x 20 mm / 0.5 mm pitch | 42    | °C/W |
| $\Theta_{JA}$ | Thermal Resistance Junction-Ambient<br>LQFP 64 - 10 x 10 mm / 0.5 mm pitch  | 45    | °C/W |
| $\Theta_{JA}$ | Thermal Resistance Junction-Ambient<br>LFBGA 64 - 8 x 8 x 1.7mm             | 58    | °C/W |
| $\Theta_{JA}$ | Thermal Resistance Junction-Ambient<br>LFBGA 144 - 10 x 10 x 1.7mm          | 50    | °C/W |

## 6 Product history

There are three versions of the STR710F series products. All versions are functionally identical and differ only with the points listed below.

Version "A" was the first version produced and delivered. Version "Z" was the second in production replacing version "A". Version "Z" has lower power consumption in STOP mode.

Version "X" is the latest introduced.

### Marking

The difference between versions is visible on the marking of the product as shown in the four examples in [Figure 45](#) through [Figure 48](#).

Figure 45. LQFP144 STR710 version "A"



Figure 46. LQFP64 STR712 version "Z"



Figure 47. BGA144 STR710 version “Z”

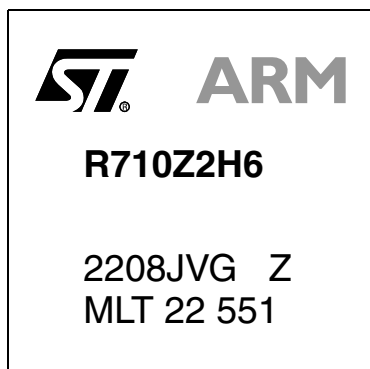


Figure 48. BGA64 STR711 version “X”

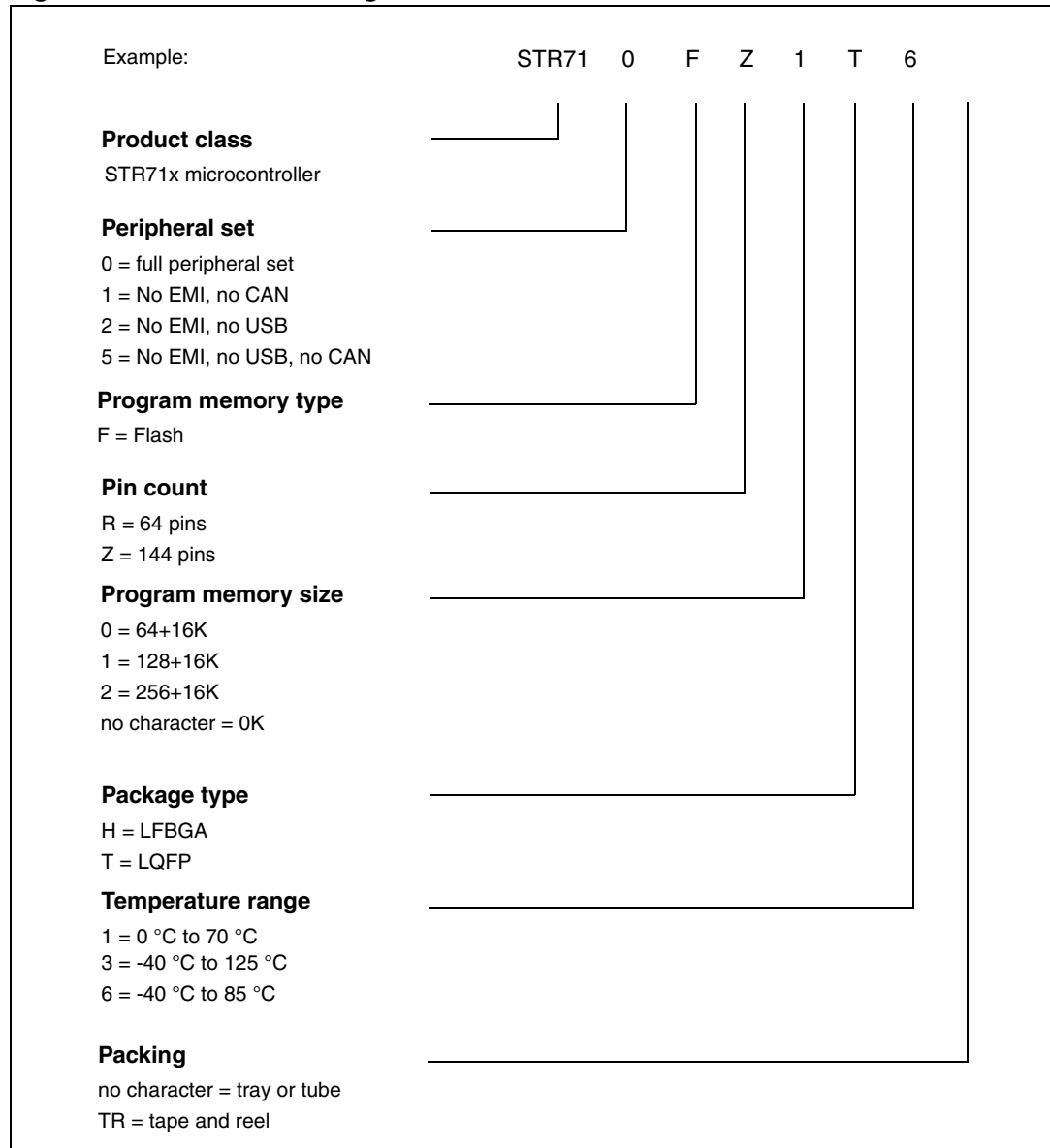


Table 43. A, Z and X version differences

| Feature                                                                                          | A version                                                                                                   | Z version                                                                  | X version                                                                                                                                                                                                                                                                                                       |
|--------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ARM7TDMI core device Identification (ID) code register (see ARM7TDMI Technical Reference Manual) | Version bits [31:28] = 0001                                                                                 | Version bits [31:28] = 0010                                                | Version bits [31:28] = 0010                                                                                                                                                                                                                                                                                     |
| Low power mode consumption in STOP mode at 25 °C                                                 | Not guaranteed<br>Typical 49 µA                                                                             | 50 µA maximum at 25°C.<br>Less than 30 µA at 25 °C for 99.730020% of parts | Same as Z.                                                                                                                                                                                                                                                                                                      |
| SC.DATA pin                                                                                      | Not TRUE open drain<br>When addressing 5V cards, the SCDATA Line must be connected to an open drain buffer. |                                                                            | Pin P0.10/U1.RX/U1.TX/SC. DATA has been modified to offer TRUE OPEN DRAIN functionality when in Smartcard mode. When addressing 5V cards, the SCDATA line can now be connected directly to the card I/O. This modification is backward compatible with previous designs, and no board modification is required. |

## 7 Ordering information

Figure 49. STR71xF ordering information scheme



- For a list of available options (e.g. memory size, package) and orderable part numbers or for further information on any aspect of this device, please go to [www.st.com](http://www.st.com) or contact the ST Sales Office nearest to you.

## 8 Known limitations

### Description

If an IRQ or FIQ interrupt is pending and the Interrupt vector register (EIC\_IVR) is not yet read, the HALT bit in the RCCU\_SMR register can not be written. Therefore a software reset can not be generated.

### Workaround

To generate a software reset when an IRQ or FIQ line is pending, either:

- reset the EIC peripheral by setting bit 14 in the APB2\_SWRES register, or
- read the EIC\_IVR register prior to generating a software reset.

## 9 Revision history

**Table 44. Document revision history**

| Date        | Revision | Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 17-Mar-2004 | 1        | First Release                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 05-Apr-2004 | 2        | Updated "Electrical parameters" on page 34                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 08-Apr-2004 | 2.1      | Corrected STR712F Pinout. Pins 43/42 swapped.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 15-Apr-2004 | 2.2      | PDF hyperlinks corrected.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 7-Jul-2004  | 3        | Corrected description of STDBY, V18, VSS18 V18BKP VSSBKP pins<br>Added IDDrn typical data<br>Updated BSPI max. baudrate.<br>Updated "EMI - external memory interface" on page 56                                                                                                                                                                                                                                                                                                                                                    |
| 29-Oct-2004 | 4        | Corrected Flash sector B1F0/F1 address in <a href="#">Figure 6: Memory map on page 31</a><br>Corrected <a href="#">Table 5 on page 25</a> LQFP64 TEST pin is 16 instead of 17. Added to TQFP64 column: pin 7 BOOTEN, pin 17 V <sub>33IO-PLL</sub><br>Changed description of JTCK from 'External pull-down required' to 'External pull-up or pull down required'.                                                                                                                                                                    |
| 25-Jan-2005 | 5        | Changed "Product Preview" to "Preliminary Data" on page 1 and 3<br>Renamed 'PU/PD' column to 'Reset state' in <a href="#">Table 5 on page 25</a><br>Added reference to STR7 Flash Programming Reference Manual                                                                                                                                                                                                                                                                                                                      |
| 19-Apr-2005 | 6        | Added STR715F devices and modified RAM size of STR71xF1 devices<br>Added BGA package in <a href="#">Section 5</a><br>Updated ordering information in <a href="#">Section 7</a> .<br>Added PLL duty cycle min and max. in <a href="#">PLL electrical characteristics on page 45</a>                                                                                                                                                                                                                                                  |
| 13-Oct-2005 | 7        | Updated feature description on page 1<br>Update overview <a href="#">Section 1.1</a><br>Added OD/PP to P0.12 in <a href="#">Table 5</a><br>Changed name of WFI mode to WAIT mode<br>Changed Memory Map <a href="#">Table 6</a> : Ext. Memory changed to 64 MB and flash register changed to 36 bytes.<br>Added Power Consumption <a href="#">Table 13</a><br>Modified BGA144 F3, F5, F12 and G12 in <a href="#">Table 3</a> and <a href="#">Table 4</a><br>Update EMI Timing <a href="#">Table 24</a> and <a href="#">Figure 29</a> |

Table 44. Document revision history (continued)

| Date        | Revision | Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|-------------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 22-May-2006 | 8        | <p>Added Flashless device.</p> <p>Changed reset state of pins P1.10 and P1.13 from pu to pd, P0.15 from pu to floating and removed x in interrupt column for P1.15 and P1.12 in <a href="#">Table 4</a> and <a href="#">Table 5</a></p> <p>Added notes under <a href="#">Table 4</a> on EMI pin reset state.</p> <p>Corrected inch value for d3 in <a href="#">Figure 40</a></p> <p>Added footprint diagrams in <a href="#">Figure 40</a> and <a href="#">Figure 43</a></p> <p>Updated <a href="#">Section 4: Electrical parameters</a></p> |
| 01-Aug-2006 | 9        | <p>Flash data retention changed to 20 years at 85° C.</p> <p>Changed note 8 on page 19</p> <p>Changed note 1 on page 45</p>                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 06-Nov-2006 | 10       | <p>Added STR715FR0T1 in <a href="#">Table 42: Order codes</a></p> <p>P0.12 corrected in <a href="#">Table 5 on page 25</a></p>                                                                                                                                                                                                                                                                                                                                                                                                              |
| 20-Mar-2007 | 11       | <p>Added characteristics of <i>BSPI - buffered serial peripheral interface on page 63</i></p> <p>Updated <a href="#">Table 21: Low-power mode wakeup timing on page 46</a></p>                                                                                                                                                                                                                                                                                                                                                              |
| 13-Feb-2008 | 12       | <p>Updated ordering information</p> <p>Updated USB characteristics</p> <p>Updated external clock characteristics</p>                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 03-Apr-2013 | 13       | <p>Updated title (to be in line with the “device summary” table)</p> <p>Updated ST Logo and Disclaimer</p> <p>Added <a href="#">Section 8: Known limitations</a></p>                                                                                                                                                                                                                                                                                                                                                                        |

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